#### **Errata**

Title & Document Type: 8954A Transceiver Interface Operating and Service

**Manual** 

Manual Part Number: 08954-90010

**Revision Date: February 1983** 

#### **About this Manual**

We've added this manual to the Agilent website in an effort to help you support your product. This manual provides the best information we could find. It may be incomplete or contain dated information, and the scan quality may not be ideal. If we find a better copy in the future, we will add it to the Agilent website.

#### **HP References in this Manual**

This manual may contain references to HP or Hewlett-Packard. Please note that Hewlett-Packard's former test and measurement, life sciences, and chemical analysis businesses are now part of Agilent Technologies. The HP XXXX referred to in this document is now the Agilent XXXX. For example, model number HP8648A is now model number Agilent 8648A. We have made no changes to this manual copy.

#### **Support for Your Product**

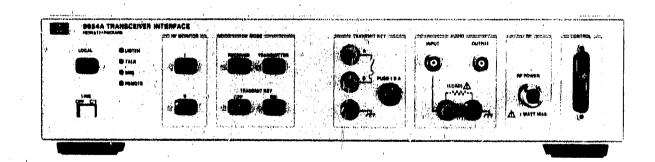
Agilent no longer sells or supports this product. You will find any other available product information on the Agilent Test & Measurement website:

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Search for the model number of this product, and the resulting product page will guide you to any available information. Our service centers may be able to perform calibration if no repair parts are needed, but no other support from Agilent is available.



# 8954A TRANSCEIVER INTERFACE





# 8954A TRANSCEIVER INTERFACE

# **SERIAL NUMBERS**

This manual applies directly to instruments with serial numbers prefixed 2243A.

For additional important information about serial numbers, see INSTRUMENTS COVERED BY THIS MANUAL in Section I.

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EAST 24001 MISSION AVENUE, TAF C-34, SPOKANE, WASHINGTON, U.S.A., 99220

Manual Part No. 08954-90010 Microfiche Part No. 08954-90011

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# SAFETY CONSIDERATIONS

#### **GENERAL**

This product and related documentation must be reviewed for familiarization with safety markings and instructions before operation.

This product is a Safety Class I instrument (provided with a protective earth terminal).

#### **BEFORE APPLYING POWER**

Verify that the product is set to match the available line voltage and the correct fuse is installed.

#### SAFETY EARTH GROUND

An uninterruptible safety earth ground must be provided from the main power source to the product input wiring terminals, power cord, or supplied power cord set.

#### **SAFETY SYMBOLS**



Instruction manual symbol: the product will be marked with this symbol when it is necessary for the user to refer to the instruction manual (refer to Table of Contents).



Indicates hazardous voltages



Indicates earth (ground) terminal

#### **WARNING**

The WARNING sign denotes a hazard. It calls attention to a procedure, practice, or the like, which, if not correctly performed or adhered to, could result in personal injury. Do not proceed beyond a WARNING sign until the indicated conditions are fully understood and met.

#### CAUTION

The CAUTION sign denotes a hazard. It calls attention to an operating procedure, practice, or the like, which, if not correctly per-

formed or adhered to, could result in damage to or destruction of part or all of the product. Do not proceed beyond a CAUTION sign until the indicated conditions are fully understood and met.

#### WARNING

Any interruption of the protective (grounding) conductor (inside or outside the instrument) or disconnecting the protective earth terminal will cause a potential shock hazard that could result in personal injury. (Grounding one conductor of a two conductor outlet is not sufficient protection).

Whenever it is likely that the protection has been impaired, the instrument must be made inoperative and be secured against any unintended operation.

If this instrument is to be energized via an autotransformer (for voltage reduction) make sure the common terminal is connected to the earth terminal of the power source.

Servicing instructions are for use by service-trained personnel only. To avoid dangerous electric shock, do not perform any servicing unless qualified to do so.

Adjustments described in the manual are performed with power supplied to the instrument while protective covers are removed. Energy available at many points may, if contacted, result in personal injury.

Capacitors inside the instrument may still be charged even if the instrument has been disconnected from its source of supply.

For continued protection against fire hazard, replace the line fuse(s) only with 250V fuse(s) of the same current rating and type (for example, normal blow, time delay, etc.). Do not use repaired fuses or short circuited fuseholders.

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General Information

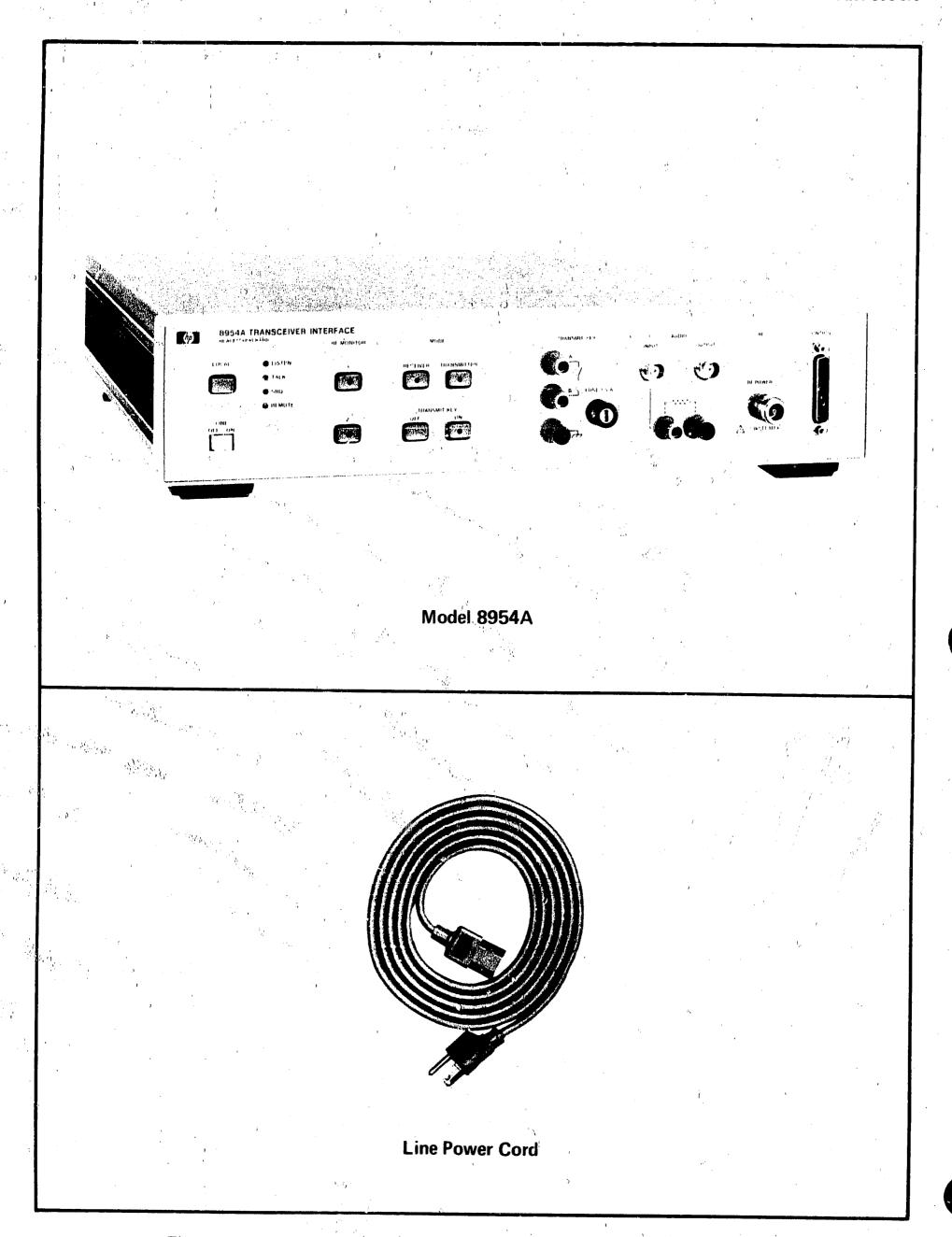


Figure 1-1. HP Model 8954A Transceiver Interface with Accessories Supplied

# SECTION I GENERAL INFORMATION

#### 1-1. INTRODUCTION

This Operating and Service Manual contains information required to install, operate, test, and service the Hewlett-Packard Model 8954A Transceiver Interface. Figure 1-1 shows the instrument and accessories supplied.

The information structure of this manual is as described below:

Section I, General Information: provides instrument description and specifications, explains accessories and options, and lists recommended test equipment.

Section II, Installation: provides information concerning initial inspection, preparation for use (including HP-IB address selection for remote operation), and storage and shipment.

Section III, Operation: provides information about panel features, including operators checks and operators maintenance information.

Section IV, Performance Tests: provides tests to check that the electrical performance of the instrument agrees with the published specifications.

**Section V, Adjustments:** normally provides the information required to properly adjust the instrument. This instrument, however, has no adjustments.

Section VI, Replaceable Parts: provides ordering information for all replaceable parts and assemblies.

Section VII, Manual Changes: provides manual change information necessary to document all serial prefixes listed on the Operating and Service Manual title page. In addition, this section also contains recommended modifications for earlier instrument configurations.

Section VIII, Service: provides the information required to repair the instrument.

Additional copies of the Operating and Service Manual can be ordered separately through your nearest Hewlett-Packard office. The part number is listed on

the title page of this manual. Refer to paragraph 1-7, "Options and Accessories", for additional ordering information.

Also on the title page of this manual, below the manual part number, is a microfiche part number. This number may be used to order  $100 \times 150$  mm ( $4 \times 6$ ) microfilm transparencies of the Operating and Service Manual. Each microfiche contains up to 96 photo-duplicates of the manual pages. The microfiche package also includes the latest Manual Changes supplement.

#### 1-2. SPECIFICATIONS

Instrument specifications are listed in Table 1-1. These are the performance standards, or limits, against which the instrument may be tested. Information listed under Supplemental Characteristics, Table 1-2, are not warranted specifications but are typical characteristics included as additional information for the user.

#### 1-3. SAFETY CONSIDERATIONS

This product is a Safety Class I instrument; that is, one provided with a protective earth terminal. The Transceiver Interface and all related documentation must be reviewed for familiarization with safety markings and instructions before operation. Refer to the Safety Considerations page found at the beginning of this manual for a summary of the safety information. Safety information pertinent to the task at hand; that is, installation, operation, performance testing, or service, is found throughout this manual.

# 1-4. INSTRUMENTS COVERED BY THIS MANUAL

This instrument has a two-part serial number in the form 0000A00000 which is stamped on the serial number plate attached to the rear of the instrument. The first four digits and the letter constitute the serial number prefix and the last five digits form the suffix. The prefix is the same for all identical instruments. It changes only when a change is made to the instrument. The suffix, however, is assigned sequentially and is different for each instrument. The contents of this manual apply directly to any instrument that has the same serial number prefix as listed under SERIAL NUMBERS on the title page.

An instrument manufactured after the printing of this manual may have a serial number prefix that is not listed on the title page. This unlisted serial number prefix indicates that the instrument is different from those documented in this manual. The manual for this newer instrument is accompanied by a yellow MANUAL CHANGES supplement. This supplement contains "change information" that explains how to adapt the manual to the newer instrument.

In addition to change information, the supplement may contain information for correcting errors in the manual. To keep this manual as current and as accurate as possible, Hewlett-Packard recommends that you periodically request the latest MANUAL CHANGES supplement. The supplement for this manual is identified with the manual print date and part number, both of which appear on the manual title page. Complimentary copies of the supplement are available from Hewlett-Packard.

For information concerning a serial number prefix that is not listed on the title page or in the MANUAL

CHANGES supplement, contact your nearest Hewlett-Packard office.

#### 1-5. GENERAL DESCRIPTION

The HP Model 8954A Transceiver Interface is a switching interface specifically designed for transceiver testing. The utility of the Transceiver Interface is optimized when incorporated in a test-set environment. A test set provides the Transceiver Interface with the capability of directing signals between the transceiver under test and the appropriate test equipment; thus allowing for comprehensive, transceiver characterization.

#### 1-6. TRANSCEIVER TESTING

The Transceiver Interface has two, independent, signal-path configurations for transceiver testing; one is the RECEIVER MODE (RCVR) and the other is the TRANSMITTER MODE (XMTR). Figure 1-2 shows the signal paths for these modes; selected by either the front-panel keyboard or the Hewlett-Packard Interface Bus (HP-IB).

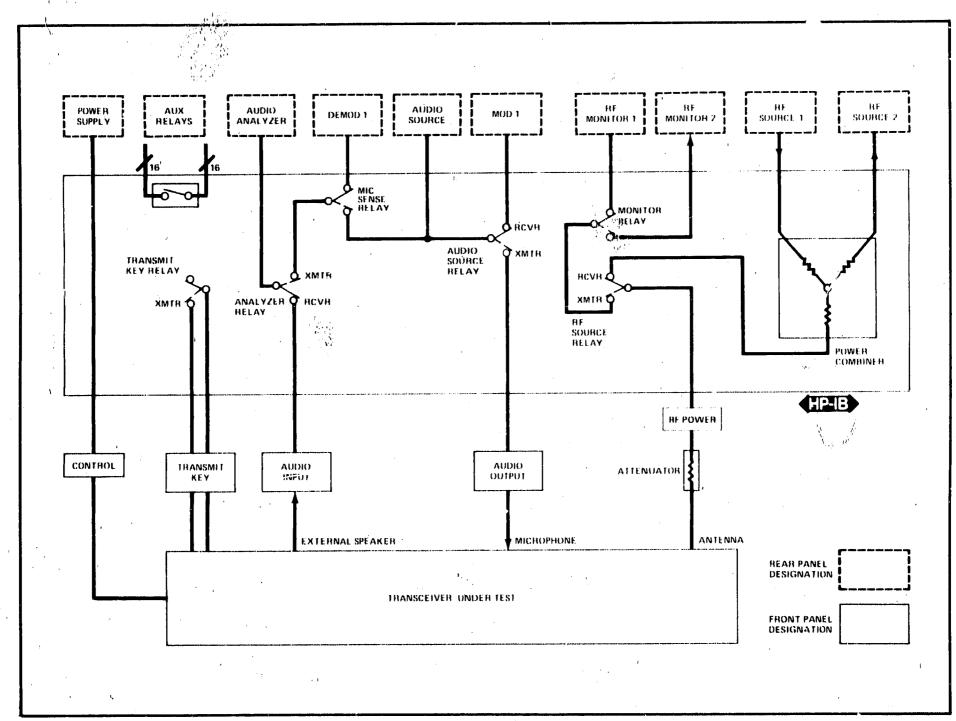


Figure 1-2. HP 8954A Transceiver Interface Test Configuration

## 1-7. OPTIONS AND ACCESSORIES

The following options and accessories are available and may have been ordered and received with the Transceiver Interface. If they were not received with the original shipment and are now desired, they may be ordered from your nearest Hewlett-Packard office using the part number included in the following paragraphs.

# 1-8. Operating and Service Manual (Option 910)

This option adds one extra Operating and Service manual with the HP 8954A Transceiver Interface.

#### 1-9. Mechanical Options

Front-Handle Kit Option 907. Ease of handling is increased with front-panel handles. Order HP part number 5061-0088.

Rack-Flange Kit Option 908. This kit contains all necessary hardware and installation instructions for mounting the Transceiver Interface in a rack with 482.5mm (standard 19") spacing. Order HP part number 5061-0074 which has standard 1.75" (4.45 cm) hole spacing.

Rack-Flange and Front-Handle Combination Kit Option 909. This kit is not simply a front-handle kit and rack flange kit packaged together. The combination is made up of unique parts which include both functions. Order HP part number 5061-0075 which has 1.75" (4.45 cm) hole spacing and is a standard flange.

#### 1-10. Accessories Available

50-Ohm Termination. Type-N, 50-ohm, coaxial termination; DC-4 GHz. Order HP part number 908A.

Control Connector and Cable. Control connector with 10 feet (3.05 m) of cable (sheathed, 9-conductor cable: 2, coaxial conductors; 2, DC power supply conductors; and 5, single-conductor wires). Order HP part number 08956-60108. Connector mates with the instrument's front panel connector J9.

Auxiliary Relay Connector. Auxiliary Relay connector hardware (unassembled; cable not included). Order HP part number 08956-60111. Connector mates with rear panel Aux. Relay connector J19.

DC Power Supply Connector. DC Power Supply connector hardware (unassembled; cable not included). Order HP part number 08956-60112. Connector mates with rear panel DC Power Supply connector J18.

#### NOTE

The limit to the length of cable attached to the DC Power Supply connector is determined by the amount of insertion loss developed in that cable. Refer to the dc power supply's operating manual for information which discusses power-cable parameters as a function of insertion loss. The Transceiver Interface has 2 feet (61 cm) of #12 AWG wire between the rear panel DC Power Supply connector and the front panel Control Connector.

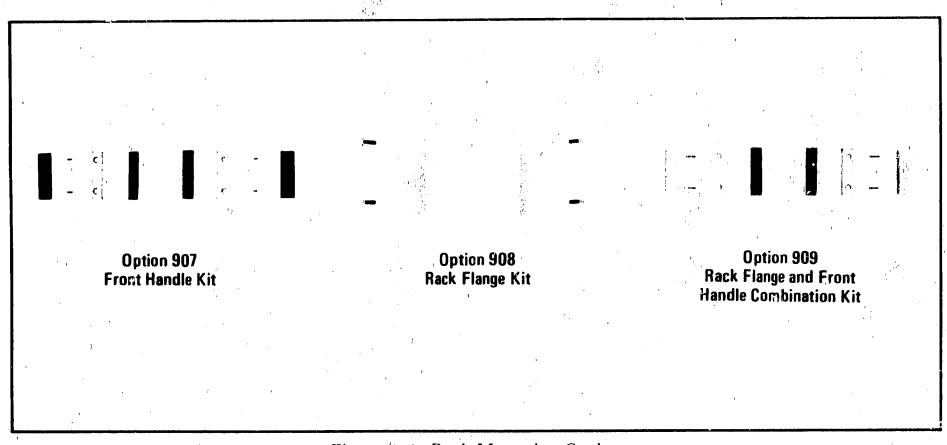


Figure 1-3. Rack Mounting Options

#### 1-11. Service Accessories

HP-IB Test Jumpers. These service accessories are designed for use in the HP-IB signature analysis test. Test Jumper 1 is a dual-in-line test fixture which adapts the HP-IB GPIA socket for the HP-IB test (Test B), HP part number; 85650-60052. Test Jumper 2 is a dual-in-line test fixture which adapts the HP-IB socket for the HP-IB test (Test C), HP part number; 08954-60005. Both test jumpers may be ordered as a kit under HP part number (08954-60115).

#### 1-12. HEWLETT-PACKARD INTERFACE BUS



#### 1-13. Compatibility

The Transceiver Interface has an HP-IB interface and can be used with any HP-IB controller or computer for automatic-system applications. The Transceiver Interface is fully programmable via the HP-Interface Bus. The Transceiver Interface's complete compatibility with HP-IB is defined by the following list of interface functions: SH1, AH1, T6, L4, SR1, RL1, PP0, DC1, DT0, C0, and E1 (refer to Table 3-2). The Transceiver Interface interfaces with the bus via open-collector TTL circuitry. An explanation of the compatibility codes can be found in the IEEE Standard 488 and the identical ANSI Standard MC1.1.

For more detailed information relating to programmable control of the Transceiver Interface, refer to Remote Operation in Section III of this manual.

#### 1-14. Selecting the HP-IB Address

Five miniature HP-IB address switches are located on the rear panel of the Transceiver Interface. These switches represent a five-bit binary number (00 through 31 in decimal). HP-IB addresses greater than 30 (decimal) are invalid. When the instrument is shipped from the factory, the HP-IB address is preset to 03 (decimal). To determine the Transceiver Interfaces HP-IB address, refer to paragraph 2-7, HP-IB Address Selection.

## 1-15. RECOMMENDED TEST EQUIPMENT

Table 1-4 lists the test equipment required for testing and servicing the Transceiver Interface. The Critical Specifications column describes the essential requirements for each piece of test equipment. Other equipment can be substituted if it meets or exceeds these critical specifications.

Table 1-1. Specifications

RF INPUT Range  20 Hz to 1300 MHz  Maximum Power  1 Watt  RF INSERTION LOSS  Loss  ≤0.5 dB  RF port to RF MON- ITOR port 1 or 2.  Loss  -6.15 dB ±0.35 dB  RF SOURCE port 1 or 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.  SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Ratio  ≤1.15  Between RF SOURCE 1 or 2 and RF port.	Planting	D1	
Range 20 Hz to 1300 MHz  Maximum Power 1 Watt  RF INSERTION LOSS  Loss ≤0.5 dB RF port to RF MON-ITOR port 1 or 2.  Loss −6.15 dB	Electrical Specifications	Performance Limit	Conditions
I 300 MHz  RF INSERTION LOSS Loss  Sur  RF SOURCE port 1 or 2.  Loss  -6.15 dB ± 0.35 dB  RF SOURCE port 1 or 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.)  SWR  Ratio  Sur  Sur  Ratio  Sur  Sur  Ratio  Sur  Sur  Sur  Sur  Sur  Sur  Sur  Su	RF INPUT	15. 15. 15. 15. 15. 15. 15. 15. 15. 15.	
RF INSERTION LOSS  Loss  ≤0.5 dB  RF port to RF MON-ITOR port 1 or 2.  Loss  -6.15 dB ±0.35 dB  RF SOURCE port 1 or 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.)  SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Between RF SOURCE 1 or 2 and RF. port. (RF port and unused RF SOURCE port terminated with 50 ohms.)  AUDIO	Range		3.
LOSS  LOSS  ≤0.5 dB  RF port to RF MON-ITOR port 1 or 2.  RF SOURCE port 1 or 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.)  SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Ratio  ≤1.15  Between RF SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)  AUDIO	Maximum Power	1 Watt	d,
ITOR port 1 or 2.  Loss  -6.15 dB ± 0.35 dB  region 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.)  SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Between RF SOURCE 1 or 2 and RF. port. (RF port and unused RF SOURCE port terminated with 50 ohms.)		·	
Loss  -6.15 dB ±0.35 dB  RF SOURCE port 1 or 2 to RF port. (Unused RF SOURCE port terminated with 50 ohms.)  SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Between RF SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)	Loss	· · · · · · · · · · · · · · · · · · ·	RF port to RF MON- ITOR port 1 or 2.
SWR  Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Ratio  ≤1.15  Between RF SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)	Loss	−6.15 dB	or 2 to RF port. (Unused RF SOURCE port termi-
Ratio  ≤1.15  Between RF port and RF MONITOR port 1 or 2.  Between RF SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)			Hated With 50 Offins.
and RF MONITOR port 1 or 2.  Setween RF SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)	SWR		1944. 1944.
SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50 ohms.)	Ratio	≤1.15	and RF MONITOR
	Ratio	≤1.15	SOURCE 1 or 2 and RF port. (RF port and unused RF SOURCE port terminated with 50
Range 20 Hz to DC-Coupled.	Range		DC-Coupled.
AUDIO INSERTION LOSS			
Loss <0.03 20 to 20 kHz.	Loss	<0.03	20 to 20 kHz.
<0.03 dB 20 kHz to 100 kHz.		<0.03 dB	20 kHz to 100 kHz.

<sup>\*</sup>Not just IEEE-488, but the hardware, documentation, and support that delivers the shortest path to a measurement system.

Table 1-2. Supplemental Characteristics

Electrical Characteristics	Performance Limit	Conditions		
EXTERNAL DC POWER SUPPLY				
Current	30A	Voltage <28 Vdc		
Voltage	50 Vdc	Current <15A		
KEY RELAY				
Current	1.5A	Voltage <28 Vdc		
Voltage	50 Vdc	Current <0.5A		
AUXILIARY RELAYS	a. T			
Current	0.5A	Voltage <20 Vdc		
Voltage	50 Vdc	Current <0.2A		

Table 1-3. General Specifications

Operating Characteristics	Performance Limit	Conditions
POWER REQUIREMENTS	,	
Line Voltage		
100, 120 Vac	+5%, -10%	48—440 Hz
220, 240 Vac	+5%, -10%	48—66 Hz
POWER DISSIPATION	22 VA max.	٠.
NET WEIGHT	6.12 kg (13.5 lb)	] ] ·
DIMENSIONS (Full Envelope)		
Height	89 mm (3.5 in.)	,
Width	411 mm (16.2 in.)	
Depth	406 mm (16.0 in.)	

Table 1-4. Recommended Test Equipment

Instrument	Critical Specifications	Model	Use*
Signal Generator	Frequency Range: 5—1000 MHz. Output Level: +13 dBm. Output Level Flatness: +1.5 dB.	HP 8640B Opt. 002	P, T
Audio Source	Frequency Range: 20—100 kHz. Output Level: 1—6V.	HP 8903A	P, T
Audio Analyzer	AC Level Accuracy: ±4% (20 kHz100 kHz, 1 mV6V.		
Digital Multimeter	Accuracy: 4½ digits, +0.02% of reading plus one digit. Range: 20 mV to 6V, 2 Vac. Sensitivity: 100 μV	HP 3455A	P, T
Signature Multimeter	Provides preferred method for coubleshooting digital circuitry.	HP 5005A	Т
Power Meter	Frequency Range: 5—1000 MHz. Input Level: +13 dBm max. Dynamic Range: 40 dB.	HP 436A with HP 8482A	P, T
SWR Briage	Frequency Range: 5—1300 MHz. Impedance: 50 Ohms. Directivity: >40 dB. Connectors: Type-N.	Wiltron 60N50 Opt. 01	Р
Controller HP-IB	HP-IB compatibility as defined by IEEE Standard 488 and the identical ANSI standard MC1.1: SH1, AH1, T6, L4, SR1, RL1, PP0, DC1, DT0, C0, and E1.	HP 9825A/98034B/92213A or HP9826A Opt. 001 or	Т
		HP 85F/00085-15003/82937A	
50 Ohm Load		HP 908A	Р
600 Ohm Load		HP 11095A	Р

# SECTION II INSTALLATION

#### 2-1. INTRODUCTION

This section provides the information needed to install the Transceiver Interface. Included is information pertinent to initial inspection, power requirements, line voltage and fuse selection, power cables, HP-IB address selection, interconnection, mating connectors, operating environment, instrument mounting, storage, and shipment.

#### 2-2. INITIAL INSPECTION

# WARNING

To avoid hazardous electrical shock, do not perform electrical tests when there are signs of shipping damage to any portion of the outer enclosure (covers and panels).

Inspect the shipping container for damage. If the shipping container or cushioning material is damaged, the shipping materials should be kept until the contents of the shipment have been checked for completeness and the instrument has been checked mechanically and electrically. Procedures for checking electrical performance are given in Section IV of this manual. Notify the nearest Hewlett-Packard office if the Transceiver Interface is received in any of the following conditions: incomplete contents, mechanical damage or defect, or failure of any of the instrument's electrical performance tests. If the shipping container is damaged, or the cushioning material shows signs of stress, notify the carrier as well as the Hewlett-Packard office. Keep the shipping materials for the carrier's inspection.

#### 2-3. PREPARATION FOR USE

#### 2-4. Power Requirements

The Transceiver Interface requires a power source of 100 to 120 (+5%, -10%) Vac 48—440 Hz, 220 to 440 (+5%, -10%) Vac 48—66 Hz, single-phase. Power consumption is 22 volt-amperes maximum.

#### **WARNING**

This is a Safety Class I product (i.e., provided with a protective earth terminal). An uninterruptible safety earth ground must be provided from the Mains power input wiring terminals, power cord, or supplied power cord set. Whenever it is likely that the protection has been impaired, the instrument must be made inoperative and be secured against any unintended operation.

If this instrument is to be energized via an external autotransformer for voltage reduction, make sure that the common terminal is connected to the earth pole of the power source.

#### 2-5. Line Voltage and Fuse Selection

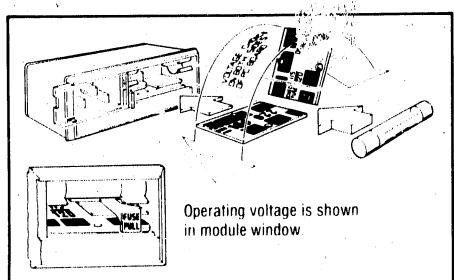
# CAUTION

BEFORE PLUGGING THIS INSTRU-MENT into the Mains (line) voltage, be sure the correct voltage and fuse have been selected.

The rear-panel, Line-Filter Module permits operation from 100, 120, 220, or 240 Vac. The number visible in the window (located on the module) indicates the nominal line voltage to which the instrument must be connected. Verify that the line voltage selection card and the fuse are matched to the power source. See Figure 2-1, "Line Voltage and Fuse Selection". Table 2-1, lists the voltage and current ratings, and the HP part numbers for the replaceable fuses.

# WARNING

For protection against fire hazard, the line fuse should only be a 250V fuse with the correct current rating.



#### SELECTION OF OPERATING VOLTAGE

- 1. Open cover door, pull the FUSE PULL lever and rotate to left. Remove the fuse.
- 2 Remove the Line Voltage Selection Card Position the card so the line voltage appears at top-left cover. Push the card firmly into the slot.
- 3 Rotate the Fuse Pull lever to its normal position. Insert a fuse of the correct value in the holder. Close the cover door.

# WARNING

To avoid the possibility of hazardous electrical shock, do not operate this instrument at line voltages greater than 126.5 Vac with line frequencies greater than 66 Hz (leakage currents at these line settings may exceed 3.5 mA).

Figure 2-1. Line Voltage and Fuse Selection

Table 2-1. Line Fuse Ratings and Part Numbers

Line Voltage	Rating '	Part Numbers		
100/120V	250 mA, 250V	HP 2110-0004		
220/240V	125 mA, 250V	HP 2110-0027		

#### 2-6. Power Cables

# WARNING

BEFORE CONNECTING THIS INSTRU-MENT, the protective earth terminal of the instrument must be connected to the protective conductor of the (Mains) power cord. The Mains plug shall only be inserted in a socket outlet provided with a protective earth contact. The protective action must not be negated by the use of an extension cord (power cable) without a protective conductor (grounding). Grounding one conductor of a two-conductor outlet is not sufficient protection. This instrument is equipped with a three-wire power cable. When connected to an appropriate ac power receptacle, this cable grounds the instrument cabinet. The type of power-cable plug shipped with the instrument depends on the country of destination. See Figure 2-3 for part numbers of the power cables and Mains plugs available.

# 2-7. HP-IB Address Selection

The HP-IB address for the HP 8954A is preset at the factory for address 03. (This decimal value corresponds to a talk address of "C" and a listen address of "#".) Figure 2-2 shows the HP-IB address switch in its preset position.

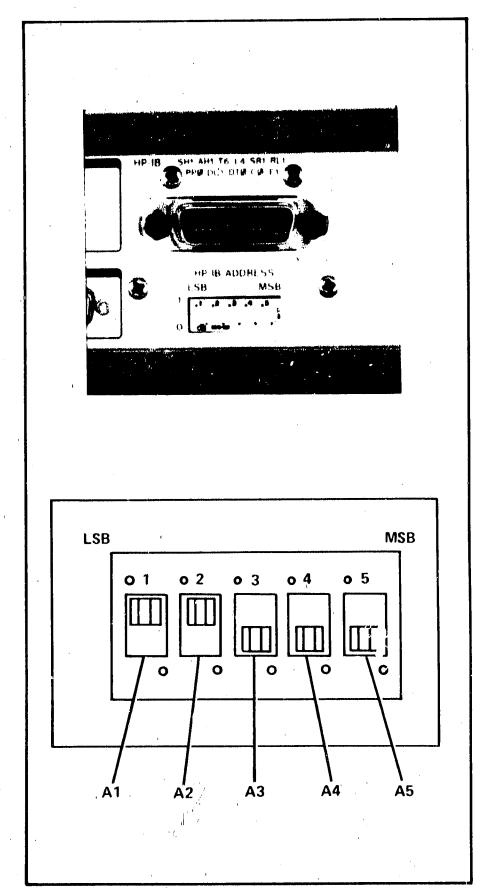


Figure 2-2. HP-IB Address Switch Location and Settings

Plug Type	Cable HP Part Number	CD	Plug Description	Cable Length (inches)	Cable Color	For Use In Country
250V	8120-1351 8120-1703	0 6	Straight*BS1363A 90°	90 90	Mint Gray Mint Gray	United Kingdom, Cyprus, Nigeria, Rhodesia, Singapore
250V	8120-1369 8120-0696	0 4	Straight*NZSS198/ASC112	79 87	Gray Gray	Austrailia, New Zealand
250V	8120-1689 8120-1692	7 2	Straight*CEE7-Y11	79 79	Mint Gray Mint Gray	East and West Europe, Saudi Arabia, Egypt So. Africa, India (unpolarized in many nations)
125V	8120-1348 8120-1398 8120-1754 8120-1378 8120-1521 8120-1676	5 7 1 6 2	Straight*NEMA5-15P 90° Straight*NEMA5-15P Straight*NEMA5-15P 90° Straight*NEMA5-15P	80 80 36 80 80 36	Black Black Black Jade Gray Jade Gray Jade Gray	United States, Canada, Japan (100V or 200V), Mexico, Philippines, Taiwan
250V	8120-2104	3	Straight*SEV1011 1959-24507 Type 12	79	Gray	Switzerland
250V	8120-0698	6	Straight*NEMA6-15P	,		United States, Canada
220V	8120-1957 8120-2956	3	Straight*DHCK 107 90°	79 79	Gray Gray	Denmark
250 V	8120-1860	6	Straight*CEE22-VI (Systems Cabinet use)			

<sup>\*</sup>Part number shown for plug is industry identifier for plug only. Number shown for cable is HP Part Number for complete cable including plug.

E = Earth Ground; L = Line; N = Neutral

Figure 2-3. Power Cable HP Part Numbers

The addresses listed in Table 2-2 can be selected by setting the five segments of the HP-IB address switch (located on the rear ranel) to correspond with the five-bit binary equivalent of the desired device address.

#### NOTE

Binary weighting of Address switch, least significant to most significant as read from left to right.

If the HP-IB settings are changed while the instrument is on, the LINE ON/OFF switch must be cycled off and then bich activates the instrument at the new addres

#### 2-8. Interconnection

Interconnection data for the Hewlett-Packard Interface Bus is provided in Figure 2-4.

#### 2-9. Mating Connectors

Coaxial Connectors. Coaxial mating connectors used with the Transceiver Interface should be either BNC male connectors or 50-ohm, Type-N male connectors that are compatible with those specified in US MIL-C-39012.

**Interface Connectors.** HP-IB mating connector is shown in Figure 2-4. Note that the two securing screws are metric.

For more information regarding Transceiver Interface connectors refer to paragraph 1-10, entitled "Accessories Available".

#### 2-10. Operating Environment

The operating environment should be within the following limitations:

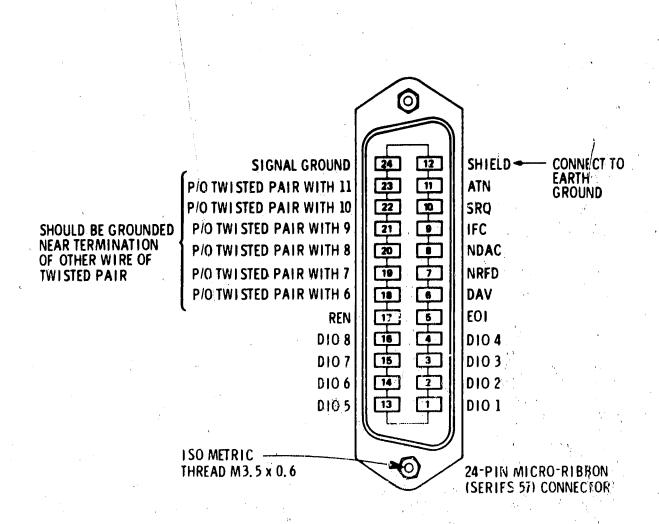
Temperature	
Humidity	<95% relative at 40°C
Altitude	<4570 metres (15,000 feet)

#### 2-11. Bench Operation

The instrument cabinet has plastic feet and foldaway tilt stands for convenience in bench operation. (The plastic feet are shaped to ensure self-alignment of instruments when they are stacked.) The tilt stands raise the front of the Transceiver Interface for easier viewing of the front panel.

Table 2-2. Allowable HP-IB Address Codes

Address Switch Equivalent Equivalent									
A1	A2	A3	A4	A5	Equivalent Docimal	ASCII	ASCII		
LSB	72	NO.	77	MSB	Value	Character (LISTEN)	Character (TALK)		
0	0	0.	0	0	00	SP	<del>                                     </del>		
1		0	0	0	01	3r  !	@ A		
<b></b>	1			<b></b>	<b> </b>	,,	<del>}</del>		
0		0	0	0	02		В		
	1	0	0	0	03	#	C		
0	0	1	0	0	04	\$	D		
1	0	ļ	0	. 0	05	%	E		
0	1	1	0	0	06	&	F		
1	1	1	0.	0	07		G		
0	0	0	1	. 0	08	(	Н		
1	0	0	1	0	09	)	]		
0	1	0	1 "	0	10	*	J ·		
1	1	0	1	0	11	+	, <b>K</b>		
0	0	1	1	0	12	,	L		
1	0	1	1	0	13		<b>M</b>		
0	1	1	1	0	14		N		
1	1	1	1	0	15	1	0		
0	0	0	0	1	16	0	Р		
1	0	0	0	1	17	1	Q		
0	1	0	0	1	18	2	R		
1	1	0	0	1	19	3	S		
0	0	1	0	1	20	4	Ţ		
1	0	. 1	0	1	21	5	U		
0	1	1	0	1	22	6	٧		
1	1	1	0	1	23	7	W		
0	0	0	1	1	24	8	Х		
1	0	0	1	1	25	9	Υ		
0	1	0	1	1	26	;	Z		
1	1	0	1	1	27	;	0		
0	0	1	1	1	28	, <b>&lt;</b>	\		
1	0	1	1	1	29	=	j		
0	1	1.	1	1	30	>	٨		
1	1	1	1	1	31	INVALID	INVALID		
			Facto	ry Sele	cted Addre	)55			



#### **Logic Levels**

The Hewlett-Packard Interface Bus Logic Levels are TTL compatible, i.e., the true (1) state is 0.0 Vdc to +0.4 Vdc and the false (0) state is +2.5 Vdc to +5.0 Vdc.

## **Programming and Output Data Format**

Refer to Section III, Operation.

#### **Mating Connector**

HP 1251-0293; Amphenol 57-30240.

#### Mating Cables Available

HP 10631A, 1 metre (3.3 ft), HP 10631B, 2 metres (6.6 ft) HP 10631C 4 metres (13.2 ft), HP 10631D, 0.5 metres (1.6 ft)

#### **Cabling Restrictions**

- 1. A Hewlett-Packard Interface Bus system may contain no more than 2 metres (6 ft) of connecting cable per instrument.
  - 2. The maximum accumulative length of connecting cable for any Hewlett-Packard Interface Bus system is 20.0 metres (65.6 ft).

Figure 2-4, Hewlett-Packard Interface Bus Connections

#### 2-12. Rack Mounting

Rack mounting information is provided with the rack mounting kits. If the kits were not ordered with the instrument as options, they may be ordered through the nearest Hewlett-Packard office. Refer to paragraph 1-9, "Mechanical Options", in Section I.

#### 2-13. STORAGE AND SHIPMENT

#### 2-14. Environment

The instrument should be stored in a clean, dry environment. The following environmental limitations apply to both storage and shipment.

Temperate	ure		 		55°C to	+75°C
Humidity	· · · · · ·	)	 		<b>&lt;</b> 95% 1	relative
Altitude			 15,300	metr	es (50,00	00 feet)

#### 2-15 Packaging

Original Packaging. Containers and materials identical to those used in factory packaging are available through Hewlett-Packard offices. If the instrument is being returned to Hewlett-Packard for servicing; attach a tag indicating the type of service required, return address, model number, and full serial number, Also, mark the container FRAGILE to ensure careful han-

dling. In any correspondence, refer to the instrument by model number and full serial number.

Other Packaging. The following general instructions should be used for repackaging the instrument with commercially available materials.

- 1. Wrap the instrument in heavy paper or plastic. (If shipping to a Hewlett-Packard office or service center, attach a tag indicating the type of service required, return address, model number, and full serial number).
- 2. Use a strong shipping container. A double-wall carton made of 2.4 MPa (350 psi) test material is adequate.
- 3. Use enough shock absorbing material (75 to 100 millimeter layer; 3 to 4 inches) around all sides of the instrument to provide a firm cushion and to prevent movement in the container. Protect the front panel with cardboard.
- 4. Seal the shipping container securely.
- 5. Mark the shipping container FRAGILE to ensure careful handling.

# OPERATION

# SECTION III OPERATION

#### 3-1. INTRODUCTION

This section provides operating information for the Transceiver Interface. Included are operating instructions, operator's maintenance procedures, operational descriptions of all front- and rear-panel features, operator's checks, and information on Remote (HP-IB) operation.

#### 3-2. Operating Characteristics

For detailed information on the Transceiver Interface's characteristics, refer to Table 1-1, "Specifications", and Table 1-2, "Supplemental Characteristics". For information on the instrument's HP-IB capabilities, refer to the summary contained in Table 3-2, "HP-IB Message Reference List".

#### 3-3. Local Operation

The front-panel operation of the Transceiver Interface is presented in this section under "Front-Panel Features", "General Operating Instructions", and "Detailed Panel Features".

Front-Panel Features. Figure 3-1 illustrates the front panel of the Transceiver Interface and provides descriptions of each key, connector, and switch.

#### 3-4. Remote Operation

The Transceiver Interface is capable of remote operation via the Hewlett-Packard Interface Bus (HP-IB). Knowledge of the instrument's LOCAL mode of operation is beneficial in understanding HP-IB programming. HP-IB information is presented in the following areas of this section:

- 1. Beginning with paragraph 3-12, general HP-IB information.
- 2. Table 3-2, a summary of HP-IB capabilities.
- 3. Table 3-3, a summary of HP-IB program codes.

#### 3-5. Instrument Checks

Operator's checks are simple procedures designed to / verify that the Transceiver Interface is operating properly. Two procedures are provided: one for basic (front-

panel) functional checks, and the other for HP-IB functional checks.

Basic Functional Checks. This procedure assures that the front-panel-controlled functions are being properly executed by the Transceiver Interface. The only equipment needed to perform this test is a signal generator and a spectrum analyzer. (Interconnecting cables and adapters must also be provided.)

# HP-IB Functional Checks. HP-IB

These procedures assume that the instrument's frontpanel operation has been previously verified; that is, that the Basic Functional Checks have been performed. These procedures check all of the applicable bus messages summarized in Table 3-2. This series of procedures requires a computing controller (HP-IB compatible) and an HP-IB interconnecting cable.

## 3-6. GENERAL OPERATING INSTRUCTIONS

WARNING

Before the Transceiver Interface is switched on, all protective earth terminals, extension cords, autotransformers, and devices attached to the instrument should be connected to a protective earth grounding socket. Any interruption of the protective earth grounding will cause a potential shock hazard that could result in personal injury.

For continued protection against fire hazard, replace the line fuse with only a 250V fuse of the same rating. Do not use repaired fuses or short-circuited fuseholders.

# CAUTION

Before the Transceiver Interface is switched on, it must be set to the same line voltage as the power source or damage to the instrument may result.

#### 3-7. Power-On Procedure

The Transceiver Interface has an "off" state and an "on" state. If the Transceiver Interface is already plugged in, set the LINE OFF/ON switch to ON. If the power cable is not plugged in, follow these instructions:

- 1. Ensure that the LINE OFF/ON switch is OFF.
- 2. Check that the instrument's line voltage setting corresponds to the voltage of the power source. Refer to paragraph 2-5.
- 3. Check that the line fuse rating is appropriate for the line voltage being used. Refer to paragraph 2-5.
- 4. Plug in the power cable.
- 5. Set the LINE OFF/ON switch to ON.

#### 3-8. OPERATOR'S MAINTENANCE

**WARNING** 

For continued protection against fire hazards, replace the line fuse with only a 250V fuse of the same rating. Do not use repaired fuses or short-circuited fuseholders.

The only maintenance the operator may need to perform is the replacement of the primary power fuse (in A4 Line Filter Module), the TRANSMIT KEY FUSE (accessible from the front panel) or the Power Supply fuses A2F1, and A2F2 (located inside the instrument). Instructions on how to change the primary power fuse are found in Figure 2-1, steps 1 and 3, and paragraph 2-5.

 Primary power fuses may be ordered under HP Part Numbers 2110-0004 (0.250A, 250V) for 100/120 Vac operation and 2110-0027 (0.125A, 250V) for 220/240 Vac operation.

# CAUTION

Before replacing the TRANSMIT KEY fuse, ensure that the Transceiver Interface LINE OFF/ON switch is in the OFF position.

The TRANSMIT KEY FUSE is contained in the front-panel fuse holder. It can be easily removed with a flat-blade screwdriver. The TRANSMIT KEY FUSE may be ordered under HP part number 2100-0043 (1.5A, 250V).

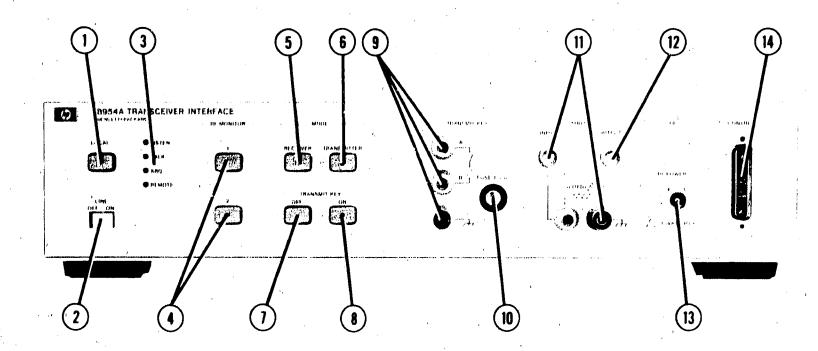
# CAUTION

Before replacing the Power Supply fuses, ensure that the Transceiver Interface LINE OFF/ON switch is in the OFF position.

• The Power Supply fuses A2F1 and A2F2 are located on the A2 assembly (see Service Sheet 4). The fuses may be ordered under HP part numbers HP 2110-0269 (A2F1; 0.75A, 250V) and HP 2110-0027 (A2F2; 0.125A, 250V).

#### 3-9. DETAILED PANEL FEATURES

The Transceiver Interface may be controlled by either the front panel or the Hewlett-Packard Interface Bus. The front- and rear-panel features are described in detail in Figures 3-1 and 3-2.



- 1. LOCAL Key. The LOCAL key returns the instrument to the local operating mode (full, front-panel control) from the remote mode of operation. The LOCAL key is disabled if a Local Lockout command has been given by the HP-IB controller.
- 2. **LINE OFF/ON.** The LINE OFF/ON switch applies line power to the Transceiver Interface when the switch is set to the ON position.
- 3. **REMOTE Annunciators.** Four LED annunciators are used to display the instrument's operational status in the remote mode. The LISTEN and TALK annunciators indicate that the instrument is addressed to LISTEN or TALK. The SRQ annunciator indicates that the Transceiver Interface has initiated a service request. The REMOTE annunciator indicates that the instrument has entered the remote operating mode.
- 4. **RF MONITOR Keys (1 and 2).** The RF MONITOR keys (1 and 2) allow the input signal to the RF, Type-N connec (front panel), to be output at either RF MONITOR 1 or m. IONITOR 2, Type-N connectors (rear panel).

The utilization of either monitor may be done only when the instrument is in its TRANSMITTER MODE. (Refer to TRANSMITTER MODE Key explanation).

- 5. RECEIVER MODE Key. The RECEIVER MODE key causes the instrument to make the following internal relay connections to accompodate receiver testing:
  - Input signals to the RF SOURCE 1 and/or 2, Type-N connectors (rear panel), are switched to the RF, Type-N connector (front panel). (Simultaneous input signals to the RF SOURCE connectors 1 and 2 are combined through a 6-dB power combiner before being output at the RF Power connector.)
  - Input signals to the AUDIO SOURCE, BNC connector (rear panel) are switched to the RF SOURCE MOD 1, BNC connector (rear panel).
- Input signals to the AUDIO INPUT, BNC connector (front panel) are switched to the AUDIO ANALYZER, BNC connector (rear panel).
- Opens the Transmit Key relay if the instrument is in the Transmit mode with the Transmit Key on.

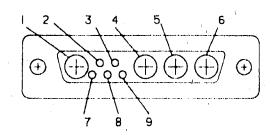
- 6. TRANSMITTER MODE Key. The TRANSMITTER MODE key causes the instrument to make the following internal relay connections to accommodate transmitter testing:
- Input signals to the RF Power, Type-N connector (front panel) are switched to either RF MONITOR 1 or 2, Type-N connector (rear panel).
- Input signals to the AUDIO SOURCE, BNC connector (rear panel) are switched to the AUDIO OUTPUT, BNC connector (front panel).
- Input signals to the RF MONITOR DEMOD 1, BNC connector (rear panel) are switched to the AUDIO AN-ALYZER, BNC connector (rear panel). See Figure 1-2 for an illustration of relay activity for both the receiver and transmitter modes.
- 7. **TRANSMIT KEY OFF MODE.** The TRANSMIT KEY OFF key opens the relay (TRANSMIT KEY Relay) that keys the transmitter.
- 8. TRANSMIT KEY ON MODE. The TRANSMIT KEY ON key closes the relay contacts (TRANSMIT KEY Relay) which keys the transmitter when the instrument is in the TRANSMITTER MODE. In the RECEIVER MODE, when the TRANSMIT KEY ON key is selected, the Transceiver Interface switches to the TRANSMITTER MODE.
- 9. TRANSMIT KEY. The TRANSMIT KEY consists of connectors A, B, and ground , which are provided for keying the transmitter. A and B are connected via relay contacts that are controlled by the TRANSMIT KEY ON and TRANSMIT KEY OFF. The TRANSMIT KEY connectors A and B may be allowed to float or be referenced to ground ,

# CAUTION

Damage to the test setup may occur if the transmitter is keyed during testing without an attenuator connected between the device under test and the Transceiver Interface. The attenuator should be selected to prevent the RF input power from exceeding 1 watt.

10. **TRANSMIT KEY FUSE.** The TRANSMIT KEY FUSE will open if current in excess of 1.5A is drawn through the instrument's transmitter-key circuit.

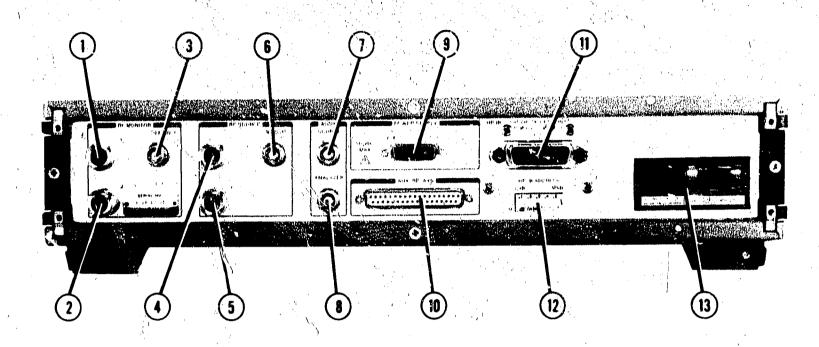
- 11. AUDIO INPUT. When the Transceiver Interface is in the RECEIVER MODE, an audio input signal to the AUDIO INPUT, BNC connector is output at the AUDIO ANALYZER connector (rear panel). The AUDIO INPUT is in parallel with two terminal posts (LOAD) for attaching a simulated speaker impedance.
- 12. AUDIO OUTPUT. In the TRANSMITTER MODE, the AUDIO OUTPUT, BNC connector outputs a signal received from the AUDIO SOURCE input (rear panel). The AUDIO OUTPUT signal is used as the microphone input to the transceiver under test.
- 13. **RF POWER.** The RF Power, Type-N connector, is used for both RF input and output signals. When the instrument is in the RECEIVER MODE, the RF Power connector is switched to RF SOURCE 1 and 2. In the TRANSMITTER MODE, the RF Power connector is switched to either RF MONITOR 1 or 2. The maximum allowable RF input power is +30 dBm (1 Watt). The input impedance is 50 ohms nominal.
- 14. **CONTROL.** The CONTROL connector consists of the following Transceiver Interface inputs and outputs (see following illustration):



CONTROL CONNECTOR FRONT VIEW

- Pin 1 is in parallel with the AUDIO INPUT (front panel);
   both BNC connector and terminal posts.
- Pins 2 and 3 are in parallel with the TRANSMIT KEY terminals B and A, (front panel) respectively.
- Pin 4 is wired to the negative (-) dc voltage-input pin and the negative (-) dc voltage-sense pin (pin 4 and 5 respectively) of the rear-panel POWER SUPPLY connector. Pin 5 is wired to the positive (+) dc voltage-input and the positive (+) dc voltage sense pin (pin 4 and 7 respectively) of the rear-panel POWER SUPPLY connector.
- Pin 6 is in parallel with front-panel AUDIO OUTPUT, BNC connector.

Refer to paragraph 1-10 and Service Sheet 2 for more information regarding this connector.



- 1. RF MONITOR 1. In the TRANSMITTER MODE, RF MONITOR 1, Type-N connector outputs an RF signal that is received from the RF connector (front panel). See Figure 3-1, Front-Panel Features for RF MONITOR 1 selection procedure (via front-panel keys).
- 2. **RF MONITOR 2.** In the TRANSMITTER MODE, RF MONITOR 2, Type-N connector outputs an RF signal that is received from the RF connector (front panel). See Figure 3-1, Front-Panel Features for RF MONITOR 2 selection procedure (via front-panel keys).
- 3. **RF MONITOR DEMOD 1.** In the TRANSMITTER MODE, the transmitter's demodulated RF signal is switched from the RF MONITOR DEMOD 1, BNC connector to the AUDIO ANALYZER connector (rear panel).
- 4. **RF SOURCE 1.** In the RECEIVER MODE, an RF signal path is connected from the RF SOURCE 1, Type-N connector to the RF connector (front panel). Refer to following NOTE.
- 5. **RF SOURCE 2.** In the RECEIVER MODE, an RF signal path is connected from the RF SOURCE 2, Type-N connector to the RF connector (front panel). Refer to following NOTE.

#### NOTE

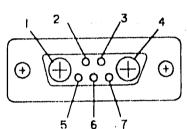
Independent input signals to RF SOURCE 1 and RF SOURCE 2 are combined through a 6-dB power combiner before they are output at the RF POWER connector (front panel). If only one RF SOURCE is used, the other RF SOURCE connector must be terminated with 50 ohms.

- 6. RF SOURCE MOD 1. In the RECEIVER MODE, an audio signal path is connected from the RF SOURCE MOD 1, BNC connector to the AUDIO SOURCE input connector (rear panel). The RF SOURCE MOD 1 output signal is used as an external-modulation input to the RF signal source.
- 7. AUDIO SOURCE. In the TRANSMITTER MODE, an input signal from an audio source to the AUDIO SOURCE BNC connector is output at the AUDIO OUTPUT connector (front panel). In the RECEIVER MODE, an input signal from an audio source to the AUDIO SOURCE connector is output at the RF SOURCE MOD 1 connector (reer panel).
- 8. **AUDIO ANALYZER.** In the TRANSMITTER MODE, the AUDIO ANALYZER, BNC connector outputs an audio signal that is received from the RF MONITOR DEMOD, BNC connector (rear panel).

If the MIC. SENSE relay is activated (HP-IB control only), the AUDIO ANALYZER connector will output a signal received from the AUDIO SOURCE connector.

In the RECEIVER MODE, the AUDIO ANALYZER, BNC connector outputs an audio signal that is received from the AUDIO INPUT connector (front panel)

9. **POWER SUPPLY.** The POWER SUPPLY, seven-pin connector is wired to the CONTROL connector (front panel). This connector is used as the input for an external dc power supply. The external supply provides a programmable voltage source for the transceiver under test.



POWER SUPPLY CONNECTOR FRONT VIEW

Pin 1 is the positive (\*) input pin and Pin 4 is a negative (-) input pin. Additional POWER SUPPLY connections are the remote sensing input pins, which includes: Pin 5; which is the positive (+) voltage sense input pin, and Pin 7; which is the negative (-) voltage sense input pin.

Maximum input voltage is 50 Vdc (current <15A).

- 10. AUX. RELAYS. The AUX. RELAYS, 36-pin connector is the external connection to 16 sets of relay contacts (single-pole, single-throw); relays are internal to the Transceiver Interface. Service Sheet 2 contains more detailed information regarding these relays.
- 11. **HP-IB Connector.** The HP-IB, 24-pin connector is used to connect the Transceiver Interface to the Hewlett Packard-Interface Bus. This will allow the instrument to be controlled with any HP-IB controller. Connection information is presented in paragraph 2-9.
- 12. HP-IB Address Switch. The HP-IB address switch is a five-segment switch used to select the Transceiver Interface's HP-IB address. Address selection information is presented in paragraph 2-7.
- 13. Line Filter Module. The Line Filter Module permits operation from 100, 120, 220, or 240 Vac. The number visible in the module window indicates the nominal line voltage to which the instrument must be connected. The center conductor is connected to safety earth ground. Line-voltage selection information is presented in paragraph 2-5.

#### 3-10. OPERATOR'S CHECKS

Operator's checks are simple procedures designed to verify that the main functions of the Transceiver Interface operate properly. Two procedures are provided: one for front-panel functional checks, and the other for HP-IB functional checks.

# 3-11. Basic Functional Checks

# **DESCRIPTION:**

This procedure assures that the front-panel-controlled functions are being properly executed by the Transceiver Interface. The only equipment needed to perform this test is a signal generator and a spectrum analyzer. (Interconnecting cables and adapters must also be provided.)

#### **EQUIPMENT:**

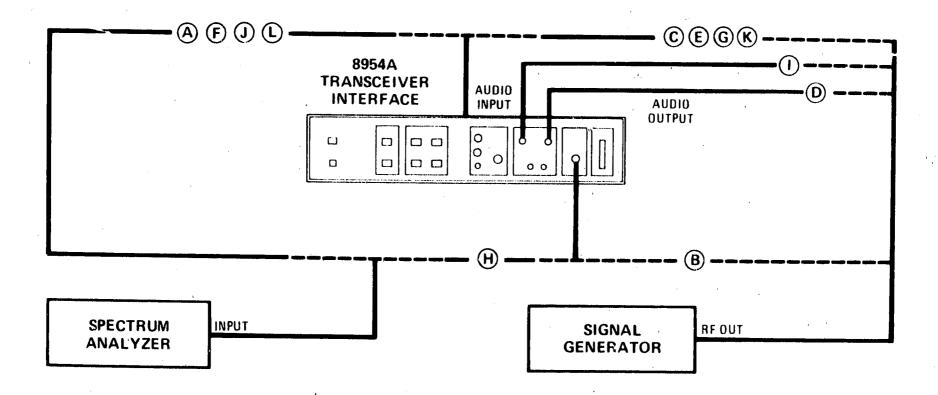


Figure 3-3. Test Configuration for Basic Function Checks

# 3-11. Basic Functional Checks (Cont'd)

**BASIC FUNCTIONAL CHECKS** CONNECTIONS (PROCEDURE STEPS) (A) RF MON 1 or 2 to Spectrum Analyzer Input. 3-8 B Signal Generator output to RF POWER input. © AUDIO SOURCE to Spectrum Analyzer Input. 9-12 Signal Generator output to AUDIO OUTPUT. © Signal Generator output to RF MONITOR DEMOD. 1 13---15 (i) AUDIO ANALYZER to Spectrum Analyzer. © Signal Generator output to RF SOURCE 1. 18--22 (H) RF POWER to Spectrum Analyzer input. ① Signal Generator output to AUDIO INPUT. 24---25 AUDIO ANALYZER to Spectrum Analyzer. (K) Signal Generator output to AUDIO SOURCE. 26-27

Table 3-1. Connections for Basic Functional Checks

#### **PROCEDURE:**

1. Ensure that the power cable is plugged into a suitable source of Mains Power. (Refer to paragraph 2-4, 2-5, and 2-6.)

() RF SOURCE MOD 1 to Spectrum Analyzer.

- 2. Set the LINE OFF/ON switch to ON. The Transceiver Interface powers up in the RECEIVER MODE (key-cap LED, on) with RF MONITOR 1 selected (key-cap LED, on).
- 3. Connect the Transceiver Interface RF connector to the signal generator's RF output and the Transceiver Interface RF MONITOR 1 connector (on the rear panel) to the spectrum analyzer input.

# **Transmitter Mode Checks**

- 4. Set the output amplitude of the signal generator to 0 dBm, and set the carrier frequency to 10 MHz.
- 5. Set the center frequency of the spectrum analyzer to 10 MHz, and set the reference level to 0 dBm.
- 6. Select the TRANSMITTER MODE. Verify that the level displayed on the spectrum analyzer is 0 dBm +5 dB.
- 7. Connect the spectrum analyzer to the RF MONITOR 2 connector (on the rear panel). The signal level on the spectrum analyzer should be less than—60 dBm.
- 8. Select RF MONITOR 2. Verify that the level displayed on the spectrum analyzer is 0 dBm +5 dB.

#### 3-11. Basic Functional Checks (Cont'd)

#### **Transmitter Mode Checks (Cont'd)**

- 9. Set the signal generator's carrier frequency to 100 kHz and the spectrum analyzer's center frequency to 100 kHz.
- 10. Connect the signal generator to the AUDIO SOURCE connector (rear panel).
- 11. Connect the spectrum analyzer to the AUDIO OUTPUT connector (front panel). Verify that the level displayed on the spectrum analyzer is 0 dBm +5 dB.
- 12. Select the RECEIVER MODE. The signal level on the spectrum analyzer should be less than -60 dBm.
- 13. Connect the signal generator to the RF MONITOR DEMOD 1 connector (on the rear panel).
- 14. Connect the spectrum analyzer to the AUDIO ANALYZER connector (on the rear panel).
- 15. Select the TRANSMITTER MODE. Verify that the level displayed on the spectrum analyzer is 0 dBm +5 dB.
- 16. Select the TRANSMIT KEY ON MODE. Verify that there is continuity between TRANSMIT KEY terminals A and B.

#### **Receiver Mode Checks**

- 17. Set the signal generator's frequency to 10 MHz and the spectrum analyzer's center frequency to 10 MHz.
- 18. Connect the signal generator to the RF SOURCE 1 connector (on the rear panel).
- 19. Connect the spectrum analyzer to the RF connector (on the front panel).
- 20. Terminate RF SOURCE 2 connector with a 50-ohm load (RF SOURCE 1 and RF SOURCE 2 are connected through a 6-dB power combiner).
- 21. Select the RECEIVER MODE. Verify that the signal level displayed on the spectrum analyzer is -6 dBm +5 dB.
- 22. Connect the signal generator to the RF SOURCE 2 connector. Connect the 50-ohm load to the RF SOURCE 1 connector. Verify that the level displayed on the spectrum analyzer is -6 dBm +5 dB.
- 23. Set the signal generator's carrier frequency to 100 kHz and the spectrum analyzer's center frequency to 100 kHz.
- 24. Connect the signal generator to the AUDIO INPUT connector (on the front panel).



#### 3-11. Basic Functional Checks (Cont'd)

#### **Receiver Mode Checks (Cont'd)**

- 25. Connect the spectrum analyzer to the AUDIO ANALYZER connector (on the rear panel). Verify that the level displayed on the spectrum analyzer is 0 dBm +5 dB.
- 26. Connect the signal generator to the AUDIO SOURCE connector on the rear panel.
- 27. Connect the spectrum analyzer to the RF SOURCE MOD 1 connector on the rear panel. Verify that the level displayed on the spectrum analyzer is 0 dBm ±5 dB.

# 3-12. HP-IB Functional Checks TPB

#### **DESCRIPTION:**

The following procedures check the Transceiver Interface's ability to: recognize its own HP-IB talk and listen address, properly make remote-to-local transitions and process all of the applicable HP-IB messages described in Table 3-2. During these tests, aladata out/output bus lines, control lines, and handshake lines of the Tranceiver Interface's HP-IB are controlled. A Transceiver Interface, a bus controller, and an HP-IB interface with appropriate cabling are required to perform these procedures. Since these checks are intended to be independent from one another, each begins with the instrument reset to its initialized condition.

The validity of these checks is based on the following assumptions:

- The Transceiver Interface performs properly when operated via the front-panel keys (that is, in the Local operating mode). This can be verified by performing the Basic Functional Checks outlined in paragraph 3-11.
- The bus controller properly executes HP-IB operations.
- The bus controller properly interfaces with the HP-IB (able to transfer control instructions).
- The select code of the bus controller's interface is set to 7.
- The HP-IB address of the Transceiver Interface is set to 03 (the factory-set address).

The select-code address, combination 703, is used. (This select-code address is not necessary for these checks to be valid; however, the program lines presented in the following procedures would need modification for any other combination.)

If the Transceiver Interface appears to fail any of the Remote functional checks, the validity of the preceding assumptions should be reconfirmed before attempting to service the instrument.

#### NOTE

The Transceiver Interface's proper operation is verified by successfully performing the HP-IB functional checks. These procedures do not check all Transceiver Interface program-code responses. However, if the front-panel operation and HP-IB functional checks are confirmed to be correct, the instrument will most likely respond properly to all of its program codes.

#### HP-IB

#### **OPERATORS CHECKS**

# 3-12. HP-IB Functional Checks (Cont'd)

#### **INITIAL SETUP:**

The test setup is the same for all of the checks; that is, the Transceiver Interface is connected to the bus controller's HP-IB interface via the appropriate cabling.

#### EQUIPMENT: 40

or or	
or	

#### **Address Recognition**

This check determines whether the Transceiver Interface is capable of recognizing an HP-IB address.

#### NOTE

It is assumed that the Instrument is in the Local operating mode and that it properly handshakes on the bus.

Before beginning this check, set the LINE OFF/ON switch to OFF, then ON, for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9326A (BASIC)
Set the Remote Enable, bus-control line (REN) false.	Icl 7	LOCAL /
Send the listen address to the Transceiver Interface.	wrt 703	OUTPUT 703

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface REMOTE annunciator remains off and that its LISTEN annunciator lights.

	. 7.0	
Unaddress the Transceiver Interface by sending a dif-	wrt 719	OUTPUT 719
ferent address.		

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators are both off.



#### 3-12. HP-IB Functional Checks (Cont'd)

#### Remote and Local Messages, and LOCAL Key

This check determines whether the Transceiver Interface properly switches from Local to Remote operation, and from Remote to Local operation.

#### NOTE

It is assumed that the Transceiver Interface is able to properly handshake on the bus and recognize its own HP-IB address.

Before beginning this check, set the LINE OFF/ON switch to OFF, then ON for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9826A (BASIC)
Send the Remote message which sets the Remote Enable, bus-control line (REN) true and addresses the Transceiver Interface to listen.	rem 703	REMOTE 703

OPERATOR'S

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators both

**RESPONSE:** light.

Send the Local message to the Transceiver Interface.	lcl 703	LOCAL 703

**OPERATOR'S** 

Verify that the Transceiver Interface's REMOTE annunciator turns off and that its

**RESPONSE:** LISTEN annunciator remains on.

		,
Send the Remote message to the Transceiver Interface.	rem 703	REMOTE 703

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators are both on. Press the LOCAL key on the front panel of the Transceiver Interface. Verify that the REMOTE annunciator turns off and that the LISTEN annunciator remains on.



## 3-12. HP-IB Functional Checks (Cont'd)

# **Data Message**

This check determines that the Transceiver Interface properly receives data messages.

#### NOTE

It is assumed that the Transceiver Interface is able to handshake, recognize its own address, and properly make Remote/Local transitions. The data message sent will cause the HP-IB data lines to be placed in both the true and false states.

Before beginning this check, set the LINE OFF/ON switch to OFF, then to ON, for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9826A (BASIC)
Send the first part of the Remote message (which enables the Transceiver Interface to Remote).	rem 703	REMOTE 703
Address the Transceiver Interface to listen (which completes the Remote message), and send the data message (which selects the TRANSMITTER MODE).	wrt 703, "XM"	OUTPUT 703; "XM"

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators both light and that the TRANSMITTER MODE annunciator (key-cap LED) lights.



# 3-12. HP-IB Functional Checks (Cont'd)

#### Local Lockout and Clear Lockout/Set Local Message

This check determines whether the Transceiver Interface properly receives the Local Lockout message that disables all front-panel keys. In addition, this check determines whether the Clear Lockout/Set Local message is properly received and executed by the instrument.

#### NOTE

It is assumed that the Transceiver Interface is able to handshake, recognize its own address, and properly make Remote/Local transitions.

Before beginning this check, set the LINE OFF/ON switch to OFF, then to ON, for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9826A (BASIC)
Send the first part of the Remote message (which enables the Transceiver Interface to remote).	rem 7	REMOTE 7
Send the Local Lockout message.	llo 7	LOCAL LOCKOUT 7
Address the Transceiver Interface to listen (which completes the Remote message).	wrt 703	OUTPUT 703

OPERATOR'S RESPONSE:

Verify that the Transceiver interface's REMOTE and LISTEN annunciators both light. Press the LOCAL key on the front panel of the Transceiver Interface and verify that the REMOTE and LISTEN annunciators both remain on.

Send the Clear Lockout/Set Local message.	Icl 7	LOCAL 7

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE annunciator is turned off and that its LISTEN annunciator remains on.

3-13



## 3-12. HP-IB Functional Checks (Cont'd)

#### **Clear Message**

This check determines whether the Transceiver Interface properly responds to the Clear message.

#### NOTE

It is assumed that the Transceiver Interface is able to handshake, recognize its own address, and properly make Remote/Local transitions.

Before beginning this check, set the LINE OFF/ON switch to OFF, then to ON, for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9826A (BASIC)
Send the first part of the Remote message (which enables the Transceiver Interface to Remote).	rem 7	REMOTE 7
Address the Transceiver Interface to listen (which completes the Remote message), and send the Data message.	wrt 703, "XYZ"	OUTPUT 703; "XYZ"

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators remain on and that the SRQ annunciator lights.

Send the Clear message.	clr 703	RESET 703
		CLEAR 703 (HP 85 & 9826A)

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators remain on and that the SRQ annunciator is not on.



# 3-12. HP-IB Functional Checks (Cont'd)

# **Abort Message**

This check determines whether the Transceiver Interface becomes unaddressed when it receives the Abort message.

## NOTE

It is assumed that the Transceiver Interface is able to handshake, recognize its own address, and properly make Remote/Local transitions.

Before beginning this check, set the LINE OFF/ON switch to OFF, then to ON, for instrument initialization.

Description	HP 9825A (HPL)	HP 85F, HP 9845A & HP 9826A (BASIC)
Send the complete Remote message.	rem 703	REMOTE 703

OPERATOR'S RESPONSE:

Verify that the Transceiver Interface's REMOTE and LISTEN annunciators both light.

Send the Abort message (which unaddresses the Transceiver Interface to listen).	cli 7	ABORTIO 7 ABORT 7
		(HP 9826A)

OPERATOR'S RESPONSE:

Verify that the LISTEN annunciator turns off.



#### 3-13. REMOTE OPERATION, HEWLETT-PACKARD INTERFACE BUS

The Transceiver Interface can be operated through the Hewlett-Packard Interface Bus (HP-IB). Bus compatability, programming, and data formats are described in the following paragraphs.

All front-pan 'functions and auxiliary relays are programmable via the HP-IB. A quick check of the Transceiver Interface's HP-IB input/output capability is described in paragraph 3-12, "HP-IB Functional Checks". These checks are used to verify that the Transceiver Interface responds to each of the applicable HP-IB messages described in Table 3-2.

#### 3-14. HP-IB Compatibility

The Transceiver Interface has an open collector, TTL, HP-IB interface capability. This capability enables the instrument to be controlled by any computer or computing controller that is HP-IB programmable. The Transceiver Interface is fully programmable via the Hewlett-Packard Interface Bus. The instrument's programming capability is described by the twelve HP-IB messages listed in Table 3-2. Foremost among these messages is the Data message. Data messages contain the program codes that control the Transceiver Interface's signal paths. The Transceiver Interface's complete compatability with HP-IB is further defined by the following list of interface functions: SH1, AH1, T6, L4, SR1, RL1, PP0, DC1, DT0, and C0. A more detailed explanation of these compatibility codes can be found in the IEEE Standard 488 (and the identical ANSI Standard MC1.1).

#### 3-15. Remote Mode

Remote Capability. In Remote operation, the front-panel keys are disabled (except for the LINE OFF/ON switch and the LOCAL key). The Transceiver Interface can be addressed to listen and to talk. When addressed to listen, the Transceiver Interface will respond to the following messages: Data, Clear, Remote, Local, Local Lockout, Clear Lockout/Set Local, and Abort. Each message is discussed in detail in the following paragraphs of this section. When addresed to talk, the Transceiver Interface outputs the following messages: Service Request and Instrument Identification (after receiving the ID Output Command).

Local-to-Remote Change. The Transceiver Interface transfers to the Remote operating mode upon receipt of the Remote message. The Remote message is comprised of two parts. They are:

- Remote Enable bus-control line (REN) set true.
- Device listen address received once (while REN is true).

The Transceiver Interface's REMOTE and LISTEN annunciators will both light and the instrument's relay switch positions will remain unchanged when the local to remote transition occurs.

#### 3-16. Local Mode

Local Capability. In Local operation, the Transceiver Interface's front panel is fully operational and the instrument will respond to the Remote message. Whether addressed or not, the Transceiver Interface will also respond to the Clear, Local Lockout, Clear Lockout/Set Local, and Abort messages. It will not, however, respond to the Data messages (unless it has been previously addressed).

Remote-to-Local Change. The Transceiver Interface returns to Local operation upon receipt of the Local message (GTL) or Clear Lockout/Set Local message. The Clear Lockout/Set Local message sets the Remote Enable bus-control line (REN) false. The instrument can always be set to Local operation by pressing the front-panel LOCAL key provided that a Local Lockout is not in effect. The signal paths will remain unchanged when the remote-to-local transition occurs.

Local Lockout. When a data transmission is interrupted (which can happen by returning the Transceiver Interface to Local operation with the LOCAL key) the data can be lost. This would leave the Transceiver Interface in an unknown state. To prevent this, a Local Lockout is recommended. Local Lockout disables the LOCAL key and allows a return-to-local only under program control.

#### NOTE

A return-to-local can also be accomplished by setting the LINE OFF/ON switch first to off, then back to ON. This technique, however, has some potential disadvantages:

- It defeats the purpose of Local Lockout; that is, the system controller will lose its control over the Transceiver Interface.
- Some HP-IB conditions are reset to their default state during turn on.



### 3-17. Addressing

When the Transceiver Interface is in the commandentry mode, it interprets the byte of information on its eight-data, input/output lines as either an address or a bus command. The command-entry mode is entered when the Attention bus-control line (ATN) is true and the Interface Clear bus control line (IFC) is false. Whenever the Transceiver Interface is being addressed (whether in Local or Remote operation), the front-panel LISTEN annunciator lights if addressed to listen and the TALK annunicator lights if addressed to talk.

The Transceiver Interface's address is established by five switches located on the rear panel of the instrument. The address selection procedure is described in section II (Installation). Refer to Table 2-2 for a list of the valid decimal addresses and their equivalent ASCII characters.

### 3-18. Data Messages

The Transceiver Interface communicates on the interface bus with Data messages. Each Data message consists of one or more bytes of information sent over the Transceiver Interface's eight, input/output bus lines (DIO1 through DIO8) during the data-entry mode. The data-entry mode is established when Attention

bus-control line (ATN) is false. Data messages include the program codes listed in Table 3-3. These program codes contain the necessary information to: program all of the instrument functions available in LOCAL operation, program the 16 auxiliary relays, and program the Output Commands.

### 3-19. Receiving the Data Message

The Transceiver Interface must be in Remote operation and addressed to listen before it can respond to Data messages. The instrument will remain addressed to listen until it receives an Abort message, a universal unlisten command from the controller, or an address to talk.

Data Message Input Format. Data messages contain the controller's talk address, the Transceiver Interface's listen address, a string of program codes, and an End Of String message (EOS). The auxiliary relay code can be entered at any place in the string. The EOS message can be a Line Feed (LF), a bus END message (EOI and ATN bus-control lines both set true), or an internally produced EOS. Figure 3-4 provides some examples of Data messages.

A complete list of ASCII characters with conversion to binary, octal, decimal, and hexadecimal is provided in Table 2-2.

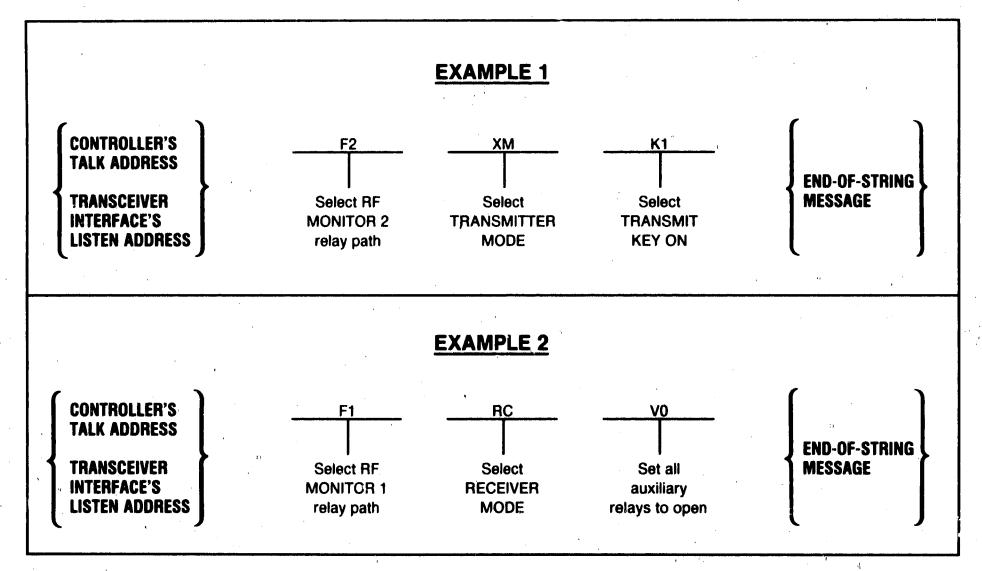


Figure 3-4. Data Message Examples



### 3-20. Receiving the Trigger Message

The Transceiver Interface does not have the capability to respond to the trigger message.

### 3-21. Receiving the Clear Message

The Transceiver Interface will respond to a Clear message by setting the listen or talk function off. The Transceiver Interface will respond equally to the Selected Device Clear (SDC) bus command when addressed to listen, and to the Device Clear (DCL) bus command whether addressed or not.

### 3-22. Receiving the Remote Message

The Remote message is comprised of two parts. First, the Remote Enable, bus-control line (REN) is held true, then the device listen address is sent by the controller. These two actions occur synchronously to configure the Transceiver Interface in the Remote operating mode. Therefore, the instrument is enabled to go in Remote operation when the controller begins the Remote message. The Transceiver Interface does not actually make the transition to Remote operation until it is addressed to listen for the first time. All instrument settings remain unchanged when the transition from local-to-remote operation occurs. The frontpanel REMOTE and LISTEN annunciators will both light and remain on when the Transceiver Interface has received the Remote message and is addressed to listen.

### 3-23. Receiving the Local Message

The controller will configure the Transceiver Interface in the Local mode by sending the Go-to-Local (GTL) bus command. If addressed to listen, the Transceiver Interface will return to Local operation (full, front-panel control) when it receives the Local message. If the instrument is in Local Lockout when the Local message is received, full, front-panel control will be returned, but Local Lockout will remain in effect. Unless the Tranceiver Interface receives the Clear Lockout/Set Local message, it will return to Local Lockout the next time it receives a Remote message. All instrument settings remain unchanged when the transition from Remote to Local is made.

The front-panel REMOTE annunciator will be turned off when the Transceiver Interface switches to Local operation. However, the front-panel LISTEN annunciator will remain lit if the Transceiver Interface is still being addressed to listen (whether in Remote or Local operation), and the front-panel TALK annunicator will remain lit if the instrument is addressed to talk.

The front-panel LOCAL key can also be used to return the Transceiver Interface to Local operation. However, pressing the LOCAL key (when the instrument is not in Local Lockout) might interrupt a Data message being sent to the Transceiver Interface. This would leave the Transceiver Interface in a state unknown to the controller. This situation is undesirable and can be avoided by sending the Local Lockout message to disable the LOCAL key.

### 3-24. Receiving the Local Lockout Message

The controller sends the Local Lockout command preventing access to the Local mode via the Transceiver Interface's front panel. If the Transceiver Interface is in Remote operation, it will respond to the Local Lockout message by disabling the front-panel LOCAL key. Local Lockout prevents the loss of data or system control due to someone accidentally pressing the frontpanel LOCAL key. If the Transceiver Interface is in Local operation when it is enabled to Remote operation (that is, REN is set true) and it receives the Local Lockout message, it will switch to Remote with Local Lockout operation the first time it is addressed to listen. Once in Local Lockout, the Transceiver Interface can only be returned to Local operation by the controller, by unplugging or resetting the instrument, or by placing the LINE OFF/ON to OFF and then back to ON.

## 3-25. Receiving the Clear Lockout/Set Local Message

The Clear Lockout/Set Local message is the way the controller sets the Remote Enable, bus-control line (REN) false. The Transceiver Interface will return to Local operation (front-panel control) when it receives the Clear Lockout/Set Local message. All instrument settings remain unchanged after the transition from Remote operation (with lockout) to Local operation occurs. The front-panel REMOTE annunciator will be turned off when the Transceiver Interface switches to Local operation.

### 3-26. Receiving the Pass Control Message

The Transceiver Interface does not respond to the Pass Control message because it does not have a control capability.

### 3-27. Sending the Request Service Message

The Require Service Message is the way the Transceiver Interface sets the Service Request, bus-control line (SRQ) true. When the Service Request message is received, the controller can be instructed to serial poll the instruments on the bus.

### 3-28. Sending the Status Byte Message

The Status Byte message is the way the Transceiver Interface responds to a Serial Poli Enable (SPE) bus command and sends the Status Byte message to the controller. The Transceiver Interface sends the eight-bit, data word which has the following meaning to the controller:

bit

- 0 Not used.
- 1 Not used.
- 2 Illegal Transceiver Interface bus command.
- Not used, "always a one except when controller is reset".
- 4 HP-IB error, "hardware broken".
- 5 Not used.
- 6 Universal HP-IB Request Service Bit.
- 7 Bus command complete (HP-IB or front panel not busy).

### 3-29. Sending the Status Bit Message

The Transceiver Interface does not have the capability to respond to a Parallel Poll Enable (PPE) bus command; therefore, it cannot send the Status Bit message.

### 3-30. Receiving the Abort Message

The Abort message is the way the controller sets the Interface Clear, bus-control line (IFC) true. When the Abort message is received, the Transceiver Interface becomes unaddressed and stops listening.

### 3-31. OUTPUT COMMANDS

The Output Commands in the following paragraphs are available for use with a remote controller.

### 3-32. Identification (ID)

The Identification command is used to identify the Transceiver Interface. When the command is sent by the controller and the Transceiver Interface is addressed to talk, it answers "8954A TRANSCEIVER INTERFACE" (Month, Day Year).

### 3-33. Output Memory (OM)

The Output Memory command is used to provide information for a service routine. (Refer to Section VIII, Service Sheet 1, for details.)

### 3-34. Request Service (RS)

The Request Service command allows the Transceiver Interface to Request Service when an incorrect command is received from the instrument controller. (Refer to paragraph 3-27.)

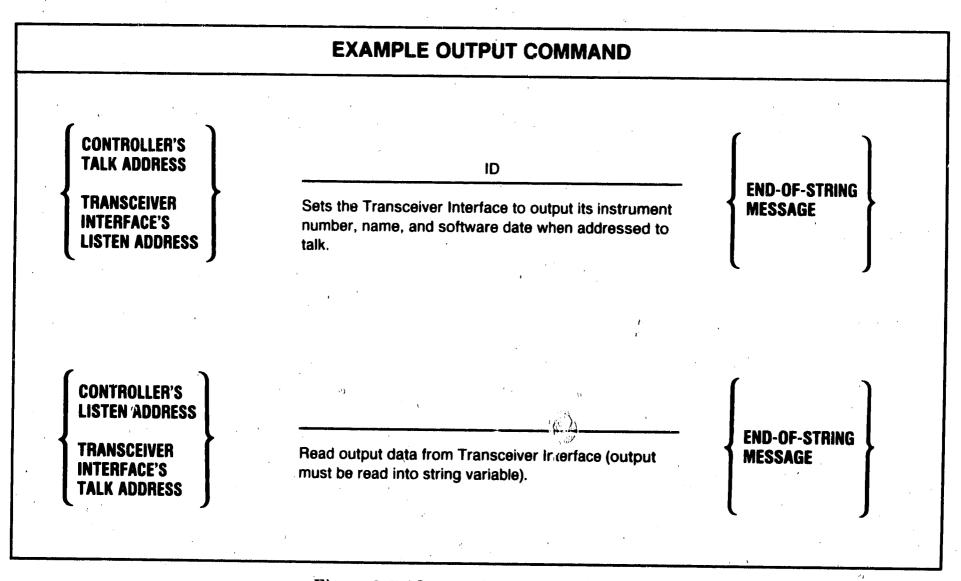


Figure 3-5. Output Command Example

Table 3-2. HP-IB Message Reference List

HP-iB Message	Applicable	Response	Related Command	Interface Functions
Data	Yes	All front-panel functions are programmable. Front-panel LISTEN annunciator lights when instrument is addressed to listen. TALK annunciator lights when addressed to talk.		T6, L4, AH1, SH1
Trigger	No	Transceiver Interface does not have Device Trigger (DT0) capability.	GET	<b>DTO</b> ,
Clear	Yes	Clears the status byte. Responds equally to Device Clear (DCL) and Selected Device Clear (SDC) bus commands.	DCL, SDC	DC1
Remote	Yes	Remote operation is entered when Remote Enable (REN), bus-control line is true and instrument is first addressed to listen. Front-panel REMOTE and LISTEN annunciators light when remote operation is entered; all front-panel keys are disabled (except for the (LOCAL key).	REN	RL1
Local	Yes	Transceiver Interface sturns to local operation (front-panel control) when either Go To Local bus command is received or front-panel LOCAL key is pressed.	GTL	RL1
Local Lockout	Yes	Disables front-panel LOCAL key so only controller can return instrument to local operation.	LL0	. ,
	No	Electrical interface designation. Open collector bus drivers.		E1
Clear	Yes	Transceiver Interface returns to local operation and clears local lockout when REN bus-control line goes false.	REN	RL1
Pass Control Take Control	No	Transceiver Interface has no control capability.		COO
Require Service	Yes	Transceiver Interface sets Service Request, bus-control line (SRQ) true if an invalid program code is received.	SRQ	SR1
Status Byte	Yes	Transceiver Interface responds to a Serial Poll Enable bus command (SPE) by sending one byte of information, when addressed to talk. If instrument is holding SRQ control line true (issuing the Require Service message), RQS bit 7 in Status Byte, and bit representing condition that caused Require Service message to be issued, will both be true. Bits in the Status Byte are latched but can be cleared by:	SPE, SPD	Т6
,		<ol> <li>Removing causing condition.</li> <li>Reading Status Byte</li> </ol>	,	
Status Bit	No	Transceiver Interface does not have capability to respond to parallel poll.		PPO
Abort	Yes	Instrument stops listening or talking.	IFC	T6, L4
·				
ı				

### Table 3-3. HP-IB Programming Codes

Program Codes *	Parameter	Comments
C1	MIC SENSE Relay ON	Activates relay A2K20
C4	MIC SENSE Relay OFF	Deactivates relay A2K20. (Receiver or Transmitter keys will also accomplish the same function.)
F1	RF MONITOR 1	Activates relay K2.
F2	RF MONITOR 2	Activates relay K2.
RC	RECEIVER MODE	Activates relay K1.
ХМ	TRANSMITTER MODE	Activates relay K1.
J1 J2 J3 J4		Turns on A2TP14 Turns off A2TP14 Turns on A2TP15 Turns off A2TP15
ко	TRANSMIT Key OFF	Opens relay A2K17.
K1	TRANSMIT Key ON	Closes relay A2K17 (forces XMT).
GF	TRANSMIT Key ON	Closes relay A2K17 without forcing XMT mode.
V1—V9	Auxiliary Relays	Opens relays A2K1—A2K9. (V1 opens A2K1.)
VAVG	Auxiliary Relays	Opens relays A2K10—A2K16. (VA opens A2K10.)
U1—U9	Auxiliary Relays	Closes relays A2K1—A2K9. (U1 closes A2K1.)
UA—UG	Auxiliary Relays	Closes relays K10—K16. (UA closes A2K10.)
<b>V0</b>	Auxiliary Relays	Opens relays A2K1—A2K16 all with one command.
U0	Auxiliary Relays	Closes relays A2K1—A2K16 all with one command.
ID	Output Command	Instrument identification; when addressed to talk, outputs instrument name, number, and Software Pate.
ОМ	Output Command	Output Memory; information for service routine, refer to Section VIII, Service Sheet 1.
RS	Output Command	Request Service; allows Transceiver Interface to request service, refer to paragraph 3-27.

# PERFORMANCE CHECK

ADJUSTMENTS

# SECTION IV PERFORMANCE TESTS

### 4-1. INTRODUCTION

The procedures, in this section, test the instrument's electrical performance using the specifications of Table 1-1 as the performance standards. All tests can be performed without access to the interior of the instrument. A simpler operational test is included in paragraph 3-11, under "Basic Functional Checks".

### NOTE

No warm-up time period is required for these tests.

### 4-2. EQUIPMENT REQUIRED

Equipment required for the performance tests is listed in Table 1-4, "Recommended Test Equipment", in Section I (General Information). Any equipment that satisfies the critical specifications given in the table may be substituted for the recommended model(s).

### 4-3. PERFORMANCE TEST RECORD

Results of the performance tests may be tabulated on the Performance Test Record, Table 4-2 at the end of the procedures. The Test Record lists all of the tested specifications and their acceptable limits. The results, recorded at incoming inspection, can be used for comparison in periodic maintenance and troubleshooting.

### 4-4. ABBREVIATED PERFORMANCE TESTS

No abbreviation of performance testing is recommended.

### PERFORMANCE TESTS

### 4-5. SWR PERFORMANCE TEST

### **SPECIFICATION**

Electrical Characteristics	Performance Limits	Conditions
SWF		
RF to RF MONITOR 1 or RF MONITOR 2	≤1.15 dB	RF MONITOR port under test, terminated with 50 ohms
RF SOURCE 1 or RF SOURCE 2 to RF	≤1.15 dB	RF and unused RF SOURCE port terminated with 50 ohms

### DESCRIPTION

SWR is measured by comparing the reflected power (of frequencies from 5 MHz to 1300 MHz) to a reference that exhibits 100% return loss. The reference level is determined by disconnecting the Transceiver Interface from the SWR bridge to create an open circuit (100% reflected power) to the power meter. The dB [REF] Mode, on the power meter, is then used to record the reference. The reflected power at any frequency can be compared to the reference level. The return loss of the RF, RF SOURCE 1 and 2, RF MONITOR 1 and 2 ports should be less than or equal to 22.0 dB.

### 4-5. SWR PERFORMANCE TEST (Cont'd)

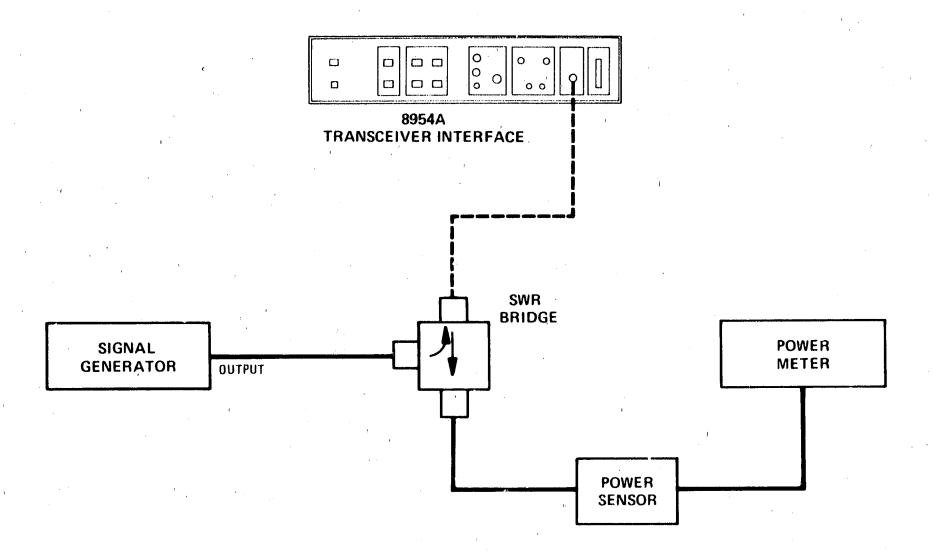


Figure 4-1. SWR Performance Test Setup

### EQUIPMENT

Signal Generator	HP 8640B Opt.002
Power Meter	HP 436A
Power Sensor	HP 8482A
SWR Bridge	. Wiltron 60N50 Opt. 01
Cables (UG-210/U Type-N)	HP 11500B (2 Required)
50-ohm terminations	HP 908A (2 Required)

### **PROCEDURE**

- 1. Zero and calibrate the power meter.
- 2. Set the equipment as follows:

1 '			
Signal Generator:		•	
Output Level		$\cdots \cdots + 13$	lBm
/ AM Modulation			
FM Modulation			Off
			t.
l'ransceiver Interface:	· · · · · · · · · · · · · · · · · · ·	• •	
MODE	7 % 2 3 %	TRANSMITT	rrr

### 4-5. SWR PERFORMANCE TEST (Cont'd)

- 3. Before connecting the Transceiver Interface to the SWR bridge, press dB [REF] on the power meter to set the open circuit (which exhibits maximum return loss) as a reference.
- 4. Connect the equipment as shown in Figure 4-1. Connect the SWR bridge to the RF port on the Transceiver Interface and select RF MONITOR 1. Terminate the RF MONITOR 1 port with 50 ohms.
- 5. Tune the signal generator to each frequency to be recorded in step 9. Use the Fine Tune control on the signal generator to peak the reflected power.
- 6. Set the cal factor of the power sensor for each frequency to be measured. (See the Cal Factor % table on the power sensor body.)
- 7. For each frequency measured, when the peak selected power is found, disconnect the SWR bridge from the Transceiver Interface and select the power meter's dB [REF] mode to establish the 0-dB reference.
- 8. Reconnect the SWR bridge to the Transceiver Interface. The reflected power displayed on the power meter is in respect to the established 0-dB reference.
- 9. Manually tune the signal generator from 5 MHz to 1000 MHz. Record, in the following table, those frequencies that have reflected-power readings greater than -22.0 dB on the power meter. (If the reading on the 436A is 0 and the underrange LED is lit, the reflected power measured is <-30 dB. Proceed to step 11.)

The maximum value of return loss is -22.0 dB for the SWR to be less than 1.15.

Frequency	Return Loss dB	Maximum Return Loss dB
5 MHz		-22.0
MHz	,	-22.0
MHz	\ <u>\</u>	-22.0
MHz		-22.0
1000 MHz		-22.0

11. Connect the equipment as shown in Figure 4-1. Connect the SWR bridge to the RF port on the Transceiver Interface, select RF MONITOR 2 and then terminate RF MONITOR 2 with 50 ohms. Repeat steps 5 through 9.

Frequency	Return Loss dB	Maximum Return Loss dB
5 MHz	)	-22.0
MHz		-22.0
MHz	1	-22.0
MHz	,	-22.0
1000 MHz		-22.0

### 4-5. SWR PERFORMANCE TEST (Cont'd)

12. Connect the SWR Bridge to the RF SOURCE 2 connector and select the Transceiver Interface's RE-CEIVER MODE. Terminate both the RF and the RF SOURCE 1 ports with 50-ohm loads. Repeat steps 5 through 9.

Frequency	Return Loss dB	Maximum Return Loss dB
5 MHz	*	-22.0
MH2		-22.0
MHz		-22.0
MHz		-22.0
1000 MHz		-22.0

13. Connect the SWR Bridge to the RF SOURCE 1 connector and terminate the RF and RF SOURCE 2 port with 50 ohms. Repeat steps 5 through 9.

Frequency	Return Loss dB	Maximum Return Loss dB
5 MHz	*****	<b>-≥2.0</b>
MHz		<b>−22</b> .∂
MHz		-22.0
MHz		-22.0
1000 MHz		-22.0

### 4-6. RF INSERTION LOSS

### **SPECIFICATION**

Electrical Characteristics	Performance Limits	Conditions
RF INSERTION LOSS		
RF to RF MONITOR 1 or RF MONITOR 2	_≤0.5 dB	T .
RF to RF SOURCE 1 or RF SOURCE 2	−6.15 dB ±0.35 dB	Unused RF SOURCE port ter- minated with 50 ohms

### **DESCRIPTION**

To measure RF insertion loss, a signal generator is connected to the power meter through the Transceiver Interface. The insertion loss of each RF signal path is measured and compared to a reference power level obtained when the signal generator's output power is measured directly by the power meter.

### 4-6. RF INSERTION LOSS (Cont'd)

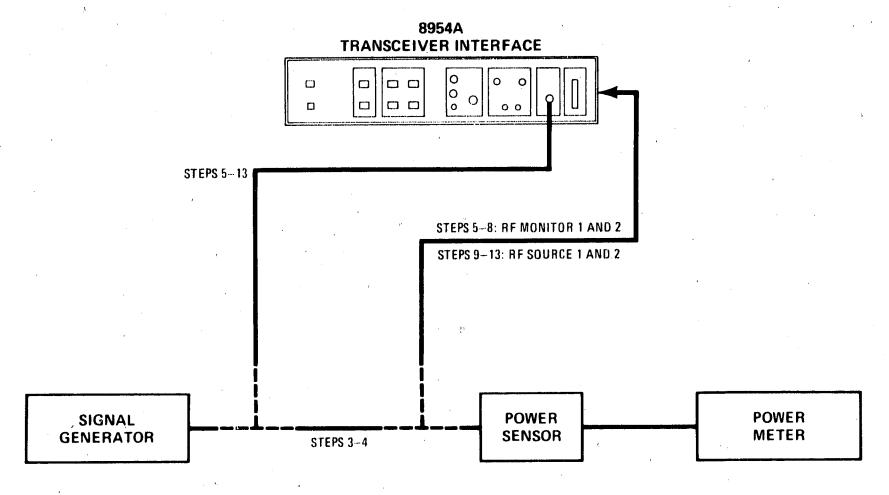


Figure 4-2. RF Insertion Loss Test

### **EQUIPMENT**

Signal Generator	HP 8640A Opt. 002
Power Meter	HP 436A
Power Sensor	HP 8482A
50-ohm Termination	
Cable ( UG-210/U type-N connectors)	HP 11500B
Adapter, N (f) to N (f)	

### **PROCEDURE**

- 1. Zero and calibrate the power meter.
- 2. Set the instrument controls as follows:

·			٠,			4)
Signal Generator:	•					
Frequency MHz						1000
Output Level						
Amplitude Modulation						
Frequency Modulation						
		• •	0, 1	* **		
Power Meter: Mode		2	*			
Mode						dBm
Transceiver Interface:	•	q	,	,		
MODE	у т			·	TRANS	SMITTER
RF MONITOR						

### 4-6. RF INSERTION LOSS (Cont'd)

- 3. Connect the equipment as shown in Figure 4-2. Using the listed adapter HP 1250-0777, connect the power sensor to the output end of cable 11500B. (Calibrating at the end of the cable compensates for any loss that might be incurred within the cable.)
- 4. When the reading on the power meter stabilizes, select the power meter's dB [REF] Mode.
- 5. Connect the power sensor to RF MONITOR 1 on the rear panel. Remove the adapter and connect the signal generator to the RF input.

	the signal generator to the Rr input.
6.	The power meter should read less than or equal to 0.5 dB. Record this reading in the space provided.
1	
	<0.5 dB
7.	Connect the power sensor to RF MONITOR 2 on the rear panel. Press RF MONITOR 2 on the front panel of the Transceiver Interface.
8.	The power meter should read less than or equal to 0.5 dB. Record this reading in the space provided.
	<0.5 dB
9.	Connect the power sensor to RF SOURCE 1, and terminate RF SOURCE 2 with 50 ohms.
l0.	Select the Transceiver Interface's RECEIVER MODE.
11.	The power meter should read $-6.15$ dB $\pm$ 0.35 dB. Record this reading in the space provided.
	$-6.15 \text{ dB} \pm 0.35 \text{ dB}$

12.	Connect the power sensor to the RF	SOURCE 2 and terminate F	RF SOURCE 1	with 50	ohms
-----	------------------------------------	--------------------------	-------------	---------	------

13.	The power meter	should read	-6.15 dB	$\pm 0.35$ dB.	Record t	his reading	g in the s	pace p	rovided
-----	-----------------	-------------	----------	----------------	----------	-------------	------------	--------	---------

 -6 15 dR	± 0.35 dB
 0.10 UD	2 0.00 UD

14. Repeat steps 3 through 13 for any frequency between 100 kHz and 1.0 GHz.

### 4-7. AUDIO INSERTION LOSS

### **SPECIFICATIONS**

Electrical Characteristics	Performance Limits	Conditions
AUDIO INSERTION LOSS	1	
20 Hz to 20 kHz 20 Hz to 100 kHz	<0.03 dB <0.3 dB	Audio Input and Output Terminated in 600 ohms

### 4-7. AUDIO INSERTION LOSS (Cont'd)

### **DESCRIPTION**

An audio source is connected directly to a digital volt meter with a 600-ohm load. A reference voltage is noted. The Transceiver Interface is connected between the audio source and the digital voltmeter. The voltage level is recorded as each of the audio paths is checked. Audio insertion loss is calculated by dividing the reference voltage by the recorded voltage levels and converting the resultant quotient to dB.

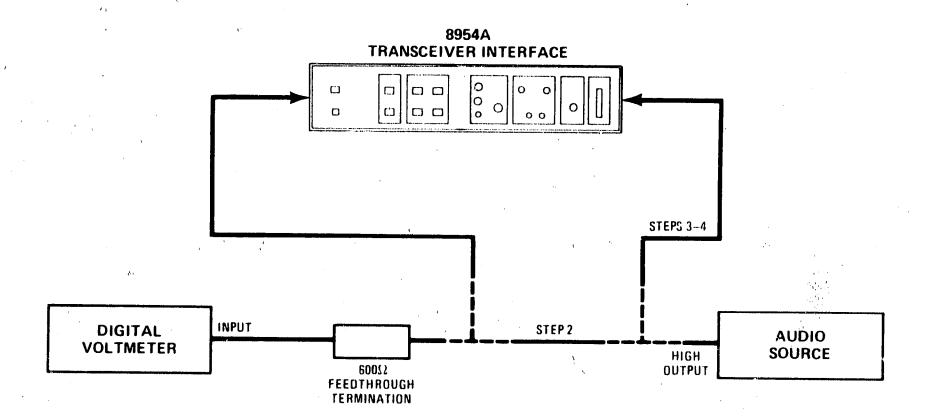


Figure 4-3. Audio Insertion Loss Test Setup

### **EQUIPMENT**

Digital Voltmeter	HP 3455A
Audio Source	HP 8903A
600-ohm feedthrough	HP11095A
Cables (2 required)	HP 10503A

### **PROCEDURE**

1. Set the equipment controls as follows:

Audio Source:					•
Frequency	· • • • • •			• • • • • • • • • • •	20 kH
Amplitude		· · · · · · ·	• • /• • • • •		9
Output Ground		· · · · · .			Groun
- From A Character.					
Function				, 	~V(ac
Trigger					Interne
Range	i				Aut

### 4-7. AUDIO INSERTION LOSS (Cont'd)

2. Connect the audio source output to the digital voltmeter input through the 600-ohm feedthrough. Record the reading  $(V_0)$ . Voltage  $V_0$  is the reference voltage for the insertion loss measurements.

 $V_0 =$ 

- 3. Connect the equipment as shown in Figure 4-3.
- 4. Configure the Transceiver Interface according to Table 4-1. Record the ac voltage  $(V_n)$  for each path selected and determine the audio insertion loss in dB by the following formula:

Insertion Loss  $dB = 20 \cdot \log (V_0/V_n) =$ 

5. Change the frequency of the audio source to 100 kHz, and repeat steps 2 through 4.

Insertion Loss =  $20 \cdot \log (V_0/V_n)$ 

Table 4-1. Audio Insertion Loss

Transce::::::::::::::::::::::::::::::::::::	Audio	Voltmeter Reading Digital V <sub>n</sub> (ac Volts)				n Loss Vn
		Voltmeter Connection	20 kHz	100 kHz	20 kHz <0.03 dB	100 kHz <0.3 dB
TRANSMITTER MODE	AUDIO SOURCE	AUDIO OUTPUT				***************************************
TRANSMITTER MODE	RF MONITOR DEMOD 1	AUDIO ANALYZER	· ,			
RECEIVER MODE	AUDIO SOURCE	RF SOURCE MOD 1				
RECEIVER MODE	AUDIO INPUT	ANALYZER				Margaritin de State de Maria de La Constantina

Table 4-2. Performance Test Record (1 of 3)

	•	•	•	
	wlett-Packard Company	Te	sted By	
	idel 8954A Insceiver Interface			
Sei	rial Number	Da	te	
Para.			Results	
No.	Test Description	Min	Actual	Max
4-5.	SWR:			
	RF to RF MONITOR 1		No.	
	5 MHz			−22.0 dB
	MHz			−22.0 dB
	MHz	4		−22.0 dB
	MHz			−22.0 dB
	1000 MHz	,	4	-22.0 dB
t.,		,		
	RF to RF MONITOR 2		•	,
	5 MHz		-	−22.0 dB
	MHz			-22.0 dB
	MHz			-22.0 dB
	MHz			-22.0 dB
	1000 MHz			−22.0 dB
• •	DE COUDCE 4 As DE			d.
·	RF SOURCE 1 to RF	,		
	5 MHz			−22.0 dB
,	MHz	, , , ,		22.0 dB
	MHz			-22.0 dB
,	MHz		1	-22.0 dB
	1000 MHz		(	−22.0 dB
	RF SOURCE 2 to RF			
				200.17
	5 MHz			-22.0 dB
	MHz			-22.0 dB
	MHz	<b>'</b>		−22.0 dB
	MHz	•	-	-22.0 d/3
	1000 MHz			−22.0 dB
			,	1

Table 4-2. Performance Test Record (2 of 3)

Hewlett-Packard Company	Tested By	·
Model 8954A		•
Transceiver Interface		·
,		,

Para.	Test Description	Results					
No.		Min	Actual	Max			
4-6	RF INSERTION LOSS:	. ,					
	RF to RF MONITOR 1						
	100 kHz, 0 dBm			0.5 dB			
:	Hz, 0 dBm			0.5 dB			
	Hz, 0 dBm			0.5 dB			
	Hz, 0 dBm			0.5 dB			
	1000 MHz, 0 dBm			0.5 dB			
	RF to RF MONITOR 2						
	100 kHz, 0 dBm			0.5 dB			
	Hz, 0 dBm			0.5 dB			
	Hz, 0 dBm			0.5 dB			
	Hz, 0 dBm			0.5 dB			
,	1000 MHz, 0 dBm			0.5 dB			
	RF to RF SOURCE 1						
,	100 kHz, 0 dBm	−5.80 dB		−6.50 dB			
	Hz, 0 dBm	−5.80 dB		-6.50 dB			
į	Hz, 0 dBm	−5.80 dB		−6.50 dB			
	Hz, 0 dBm	-5.80 dB		⊸ −6.50 dB			
<b>;</b>	1000 MHz, 0 dBm	−5.80 dB	***************************************	−6.50 dB			
÷	RF TO RF SOURCE 2			•			
	100 kHz, 0 dBm	-5.80 dB		−6.50 dB			
	Hz, 0 dBm	-5.80 dB		6.50 dB			
	Hz, 0 dBm	-5.80 dB		-6.50 dB			
	Hz, 0 dBm	-5.80 dB	Mark 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 - 1990 -	−6.50 dB			
	1000 MHz, 0 dBm	-5.80 dB		−6.50 dB			

Table 4-2. Performance Test Record (3 of 3)

Mod	viett-Packard Company del 8954A		Tes	ted By			
Tra	nsceiver Interface	, , , , , , , , , , , , , , , , , , ,					
Ser							
		Results					
Para. No.	Test Description		· ·	Ashal	Max		
140.		Min		Actual	IVIQA		
. <b>4-7</b>	AUDIO INSERTION LOSS:						
	AUDIO SOURCE to AUDIO OUTPUT				t.		
	(TRANSMITTER MODE)						
ļ	20 Hz to 20 kHz				0.03 dB		
ŕ	20 Hz to 100 kHz	Control of			0.3 dB		
	ranger († 1945) 1 maart - Johann Daniel, die Spaniel († 1945)						
	RF MONITOR DEMOD 1 to AUDIO ANALYZER (TRANSMITTER MODE)	)					
	20 Hz to 20 kHz				0.03 dB		
	20 Hz to 100 kHz				0.3 dB		
	AUDIO SOURCE to RF SOURCE MOD 1 (RECEIVER MODE)						
'	20 Hz to 20 kHz				0.03 dB		
	20 Hz to 100 kHz				0.3 dB		
	AUDIO INPUT to AUDIO ANALYZER (RECEIVER MODE)			,			
,	20 Hz to 20 kHz				0.03 dB		
	20 Hz to 100 kHz	,	-	,	0.3 dB		
•			· ,				
	)						

### SECTION V ADJUSTMENTS

### 5-1. INTRODUCTION

This section normally contains information necessary to adjust the instrument into compliance with it's performance specifications. However, since this instrument does not have any adjustments, no information is given here.

# 

### SECTION VI REPLACEABLE PARTS

### 6-1. INTRODUCTION

This section contains information for ordering parts. Table 6-1 lists abbreviations used in the parts list and throughout the manual. Table 6-3 lists all replaceable parts in reference designator order. Table 6-1 contains the names and addresses that correspond to the manufacturer's code numbers.

### 6-2. ABBREVIATIONS

Table 6-2 lists abbreviations used in the parts list, schematics, and throughout the manual. In some cases, two forms of the abbreviation are used, one all in capital letters, and one partial or no capitals. This occurs because the abbreviations in the parts list are always capitals. However, in the schematics and other parts of the manual, other abbreviation forms are used with both lower case and upper case letters.

### 6-3. REPLACEABLE PARTS LIST

Table 6-3 is the list of replaceable parts and is organized as follows:

- a. Electrical assemblies and their components in alphanumeric order by reference designation.
- b. Chassis-mounted parts and mechanical parts in alphanumeric order by reference designation.

The information given for each part consists of the following:

- a. The Hewlett-Packard part number.
- b. Part number check digit (CD).
- c. The total quantity (Qty) for the entire instrument except for the option assemblies.
- d. The description of the part.
- e. A typical manufacturer of the part in a five-digit code.
- f. The manufacturer's number for the part.

### NOTE

The total quantity for each part is given only once, that is, at the first occurrence of the part number in the list. The total quantities for the optional assemblies are totaled by assembly and not integrated into the standard list.

### 6-4. FACTORY SELECTED PARTS (\*)

Parts marked with an asterisk (\*) are factory selected parts. The value listed in the parts list is the nominal value. Refer to Sections V and VIII of this manual for information on determining what value to use for replacement.

### 6-5. PARTS LIST BACKDATING (†)

Parts marked with a dagger (†) are different in Transceiver Interfaces with serial number prefixes lower than the one that this manual applies to directly. Table 7-1 lists the backdating changes by serial number prefix. Table 7-2 lists components affected by each change.

### 6-6. PARTS LIST UPDATING (Change Sheet)

Production changes to Transceiver Interfaces made after the publication date of this manual are accompanied by a change in the serial prefix. Changes to the parts list are recorded by serial number prefix on a MANUAL CHANGES supplement. Also, parts list errors are noted in the ERRATA portion of the MANUAL CHANGES supplement.

### 6-7. ILLUSTRATED PARTS BREAKDOWNS

Most mechanical parts are identified in figures 6-1 through 6-5. These figures are located at the end of the replaceable parts table.

### 6-8. ORDERING INFORMATION

To order a part listed in the replaceable parts table, include the Hewlett-Packard part number (with the check digit) and the quantity required. Address the order to the nearest Hewlett-Packard office. The check digit will ensure accurate and timely processing of your order.

To order a part that is not listed in the replaceable parts table, include the instrument model number, instrument serial number, description and function of the part, and the quantity of parts required. Address the order to the nearest Hewlett-Packard office.

### NOTE

Within the USA, it is better to order directly from the HP Parts Center in Mountain View, California. Ask your nearest HP office for information and forms for the "Direct Mail Order System".

### 6-9. RECOMMENDED SPARES LIST

Stocking spare parts for an instrument is often done to ensure quick return to service after a malfunction occurs. Hewlett-Packard has prepared a "Recommended Spares" list for this instrument. The contents of the list are based on failure reports and repair data. Quantities given are for one year of parts support. A complimentary copy of the "Recommended Spares" list may be requested from your nearest Hewlett-Packard office.

When stocking parts to support more than one Transceiver Interface or to support a variety of Hewlett-Packard instruments, it may be more economical to work from one consolidated list rather than simply adding together stocking quantities from the individual instrument lists. Hewlett-Packard will prepare a consolidated "Recommended Spares" lists for any number or combination of instruments. Contact your nearest Hewlett-Packard office for details.

Table 6-1. Manufacturers Code List

MFR. NO.	MANUFACTURER NAME	ADDRESS	ZIP CODE
H9027	SCHURTER A G H	LUZERN SW	
00000	ANY SATISFACTORY SUPPLIER		·
01121	ALLEN-BRADLEY CO	MILWAUKEE WI	53204
01295	TEXAS INSTR INC SEMICOND CMPNT DIV	DALLAS TX	75222
04713	MOTOROLA SEMICONDUCTOR PRODUCTS	PHOENIX AZ	85008
06915	RICHCO PLASTIC CO	CHICAGO IL	60646
17856	SILICONIX INC	SANTA CLARA CA	95054
24546	CORNING GLASS WORKS (BRADFORD)	BRADFORD PA	16701
24931	SPECIALTY CONNECTOR CO INC	GREENWOOD IN	46227
27014	NATIONAL SEMICONDUCTOR CORP	SANTA CLARA CA	95051
28480	HEWLETT-PACKARD CO CORPORATE HQ	PALO ALTO CA	94304
3L585	RCA CORP SOLID STATE DIV	SOMERVILLE NJ	
56289	SPRAGUE ELECTRIC CO	NORTH ADAMS MA	01247
;			<b>[</b>
ı			
	P)		
			<b>,</b>
		r ·	
i	·	•	. [
ŀ			- I

Table 6-2. Reference Designations and Abbreviations (1 of 2)

	REFERENCE DESIGNATIONS	
A	FL Hardware HY Circulator J Electrical Connector (Stationary Portion), Jack K Relay L Coil, Inductor M Meter MP Miscellaneous Mechanical Part P Electrical Connector (Movable Portion), Plug Q Silicon Controlled Rectifier (SCR), Transistor, Triode Thyristor	RT. Switch S. Switch T. Transformer TB Terminal Board TC. Thermocouple TP. Test Point U Integrated Circuit,  Microcircuit V Electron Tube VR Breakdown Diode (Zener),  Voltage Regulator W Cable, Transmission  Path, Wire X Socket Y Crystal Unit
Electrical Part F Fuse	R Resistor	(Piezoelectric, Quartz) Z Tuned Cavity, Tuned Circuit
**		,
	ABBREVIATIONS	
A Across Flats, Acrylic, Air	COM Commercial, Common CONN Connect, Connector	EXT Extended, Extension, External, Extinguish
(Dry Method), Ampere ADJ Adjust, Adjustment	CONT Contact, Continuous, Control, Controller	<b>F</b>
ALC Alcohol, Automatic Level Control AM Amplitude Modulation AMP Amperage AMPL Amplifier ANLG Analog ASSY Assembly ASTBL Astable	CONV	F. Fahrenheit, Farad, Female, Film (Resistor), Fixed, Flange, Flint, Fluorine, Frequency FEM Female FF Flange, Female Connection; Flip Flop FL Flash, Flat, Fluid
ATTEN Attenuation, Attenuator	D	Foam, Frequency Modulation
BCD Binary Coded Decimal BFR Before, Buffer BNC Type of Connector	D. Deep, Depletion, Depth, Diameter, Direct Current DB Decibel, Double Break DBL Double DCDR Decoder	FR Folder FT Current Gain Bandwidth Product (Transition Frequency); Feet, Foot FXD Fixed
BSC Basic	DEG Degree DIFF Differential DO. Package Type Designation	G GE Germanium
C Capacitance, Capacitor, Center Tapped, Centistoke, Ceramic, Cermet, Circular Mil Foot, Closed Cup,	DRVR	GENGeneral, Generator GHZGigahertz GLGlass GPGeneral Purpose, Group
Cold, Compression CER. Ceramic CH Center Hole CHAM Chamfer CNTR Container, Counter COAX Coaxial	E-MODE Enhancement Mode ECL Emitter-Coupled Logic EPROM Eraseable Programmable Read Only Memory EXCL Englished Englished	H  HD Hand, Hard, Head, Heavy Duty HEX. Hexadecimal,
Coaxiai	EXCL Excluding, Exclusive	Hexagon, Hexagonal

Table 6-2. Reference Designations and Abbreviations (2 of 2)

		C · ·
HI High	MOSFET Metal Oxide	RES Research, Resistance,
HS Heat Sealed, Heat Shrink,	Semiconductor Field	Resistor, Resolution
High Speed	Effect Transistor	RETRIG Retriggerable
Tilgii Specu		
•	MTG Mounting	RGLTR Regulator
, 1	MV Millivolt, Multivibrator	RKR Rocker
·	MW Milliwatt	RND Round
IC Collector Current,	4.5	RPG Rotary Pulse Generator
Integrated Circuit	N	RT Real Time, Right
ID Identification,		
Inside Diameter	N-CHAN N-Channel	S
IF Forward Current,	NAND Logic Not-AND	5
	<u> </u>	SCR Screw, Scrub, Silicon
Intermediate Frequency	NM Nanometer, Nonmetallic	Controlled Rectifier
IN Inch, Indium	NMOS N-Channel Metal	SEC Second, Secondary
IN Inch, Indium	Oxide Semiconductor	•
INP Input	NO Normally Open, Number	SGLSingle
INT Integral, Intensity,	NPN Negative Positive Negative	SHFT Shaft
Internal	(Transistor)	SI Silicon, Square Inch
INTL Internal, International	NS Nanosecond,	SLDR Solder
INV Invert, Inverter	Non-Shorting, Nose	SM Samarium, Seam,
inventer invent.	non-anorting, nose	Small, Square Meter,
		Sub Modular, Subminiature
J	<b>O</b>	
		SMB Subminiature, B Type
J-FET Junction Field	OCTL Octal	(Snap-On Connector)
Effect Transistor	OD Olive Drab,	SNP Snap
JFET Junction Field	Outside Diameter	STAT Status
' Effect Transistor	OP Operational	STL Steel
8	OPT Optical, Option, Optional	SW Single Wall, Switch
JGK Jade Gray Knob	OP1 Optical, Option, Optional	SZ Size
(HP 6009-0021)	_	
	D	
	1	Tr.
K		T
	PAN-HD Pan Head	•
K KB Knob	·	TA Ambient Temperature,
	PC Picocoulomb, Piece,	TA Ambient Temperature, Tantalum
KB Knob	PC Picocoulomb, Piece, Printed Circuit	TA Ambient Temperature, Tantalum TC Thermoplastic
	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded
KB Knob	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch	TA Ambient Temperature, Tantalum TC Thermoplastic
KB Knob  L  LED Light Emitting Diode	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation	TAAmbient Temperature, Tantalum TCThermoplastic THDThread, Threaded THKThick
KB Knob  L  LED Light Emitting Diode  LG Length, Long	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple
KB Knob  L  LED Light Emitting Diode  LG Length, Long	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable,
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns
LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent,
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent,
LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent,
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U U/W Used With
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic
KB. Knob  L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Wiener U  U/W Used With UF Microfarad
KB	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U U/W Used With
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Western With UF Microfarad
LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified,	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Western With UF Microfarad
LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified, Modular, Modulated, Modulator	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four	TA. Ambient Temperature, Tantalum TC. Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Wanadium, Variable, Violet, Volt, Voltage
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified, Modular, Modulated, Modulator MONO/ASTBL Monostable/	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four R  RCVR Receiver	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Microfarad  V  V Vanadium, Variable, Violet, Volt, Voltage VAR Variable
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified, Modular, Modulated, Modulator MONO/ASTBL Monostable/ Astable	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four R  RCVR Receiver RCVY Recovery	TA. Ambient Temperature, Tantalum TC. Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Wanadium, Variable, Violet, Volt, Voltage
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified, Modular, Modulated, Modulator MONO/ASTBL Monostable/	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four R  RCVR Receiver	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Microfarad  V  V Vanadium, Variable, Violet, Volt, Voltage VAR Variable
L  LED Light Emitting Diode LG Length, Long LKG Leakage, Locking LKWR Lockwasher LO Local Oscillator, Low LS Loudspeaker, Low Power Schottky, Series Inductance LT Left, Light, Liter  M  MA Milliampere MACH Machined MCD Millicandela MISC Miscellaneous MLD Mold, Molded MOD Model, Modified, Modular, Modulated, Modulator MONO/ASTBL Monostable/ Astable	PC Picocoulomb, Piece, Printed Circuit PCB Printed Circuit Board PD Pad, Palladium, Pitch Diameter, Power Dissipation PF Picofarad; Pipe, Female Connection; Power Factor PL Phase Lock, Plain, Plate, Plug PLSTC Plastic POS Position, Positive POZI Pozidriv Recess PRCN Precision PRP Purple, Purpose PVC Polyvinyl Chloride  Q  QUAD Set of Four R  RCVR Receiver RCVY Recovery	TA Ambient Temperature, Tantalum TC Thermoplastic THD Thread, Threaded THK Thick TPG Tapping TPL Triple TRIG Trigger, Triggerable, Triggering, Trigonometry TRMR Trimmer TRN Turn, Turns TTL Tan Translucent, Transistor Transistor Logic  U  U/W Used With UF Microfarad  V  V Vanadium, Variable, Violet, Volt, Voltage VAR Variable VDC Volts, Direct Current

Table 6-3. Replaceable Parts (1 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
	1 1 2		•			
<b>A1</b>	08954-60001	2	1	KEYEGARD/ANNUNCIATORS ASSEMBLY	28480	08954-60001
01 DS1 01 DS2 01 DS3 01 DS4 01 DS5	1990-0487 1990-0487 1990-0486 1990-0485 1990-0670	77650	1 1 4	LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V LED-LAMP LUM-INT=800UCD IF=30MA-MAX LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V	28489 28480 28480 28480 28480 28480	5082-4584 5082-4584 5082-4684 5082-4984 1990-0670
A1D56 A1D57 A1D58 A1D59	1990-0670 1990-0670 1990-0670 1990-0665	0 0 0 3	1	LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V LED-LAMP LUM-INT=1MCD IF=20MA-MAX BVR=5V LED-LAMP LUM-INT=1MCD IF=20MA-MAX RVR=5V LED-LAMP LUM-INT=;MCD IF=20MA-MAX BVR=5V	28480 28480 28480 28480 28480	1990-0670 1990-0670 1990-0670 1990-0665
1111	1251-5719	2	. 4	CONNECTOR 26-PIN M POST TYPE	26480	1251-5719
1R1	1010-0272	8	1	NETWORK-RES 10-SIP330.0 OHM X 9	01121	210A201
1181 1182 1183	5060-9436 5041-0310 5060-9436 5041-0319 5060-9436 5041-0319	78777	7 2 5	PUSHBUTTON SWITCH P.C. MOUNT KEY CAP-LOCAL PUSHBUTTON SWITCH P.C. MOUNT KEY CAP-HALF GRAY-LIT PUSHBUTTON SWITCH P.C. MOUNT KEY CAP-HALF GRAY-LIT	28460 28480 28480 28480 28480 28480	5060-9436 5041-0310 5060-9436 5041-0319 5060-9436 5041-0319
184 185 186	5060-9436 5041-0319 5060-9436 5041-0310 5060-9436 5041-0319	7 7 8 7 7		PUSHBUTTON SWITCH P.C. HOUNT KEY CAP-HALF GRAY-LIT PUGHRUTTON SWITCH P.C. HOUNT KEY CAP-LOCAL PUSHBUTTON SWITCH P.C. MOUNT KEY CAP-HALF GRAY-LIT	28480 28480 28480 28480 28480 28480	5060-9436 5041-0319 5060-9436 5041-0310 5060-9436 5041-0319
157	5060-9436 5041-0319	7		PUSHBUTTON SWITCH P.C. MOUNT KEY CAP-HALF GRAY-LIT (SEE SECTION B SERVICE TOOLS FOR S1-S7)	29480 28480	5060-9436 5041-0319
<b>\2</b>	08954-60002	3	1.	INTERFACE/MICROPROCESSOR/RELAY CONTROL	28480	08954~60002
201 202 203 204 205	0140-2055 0140-2055 0140-2055 0140-2055 0140-2257	9 9 9 9 3	17	CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD .01UF +00-20% 100VDC CER CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD 10PF +85% 500VDC CER 0+-60	28480 28480 28480 28480 28480	0160-2055 0160-2055 0160-2055 0160-2055 0160-2257
206 207 208 209 2010	0160-2263 0160-2055 0180-0291 0160-2055 0160-2055	1 9 3 9 9	1	CAPACITOR-FXD 18PF +-5% 500VDC CER 0+-30 CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD 1UF+-10% 35VDC TA CAPACITOR-FXD .01UF +80-20% 100VDC CER CAPACITOR-FXD .01UF +80-20% 100VDC CER	28480 20480 56299 28480 28480	0160-2263 0160-2055 150D105X903562 0160-2055 0160-2055
2011 2012 2013 2014 2015	0160-2055 0160-2055 0160-2055 0160-2055 0160-2055	9999		CAPACITOR-FXD .010F +80-20% 108VDC CCR CAPACITOR-FXD .010F +80-20% 108VDC CER CAPACITOR-FXD .010F +80-20% 108VDC CER CAPACITOR-FXD .010F +80-20% 108VDC CER CAPACITOR-FXD .010F +80-20% 108VDC CER	20400 20400 20400 20400 20400 20480	0160-2055 0160-2055 0160-2055 0160-2055 0160-2055
2016 2017 2018 2019 2020	0160-2055 0160-2055 0180-2154 0180-2154 0180-2217/	9 9 1 1 7	2 ,	CAPACITOR-FXD .01UF +00-20% 100VDC CER CAPACITOR FXD .01UF +00-20% 100VDC CER CAPACITOR-FXD 1900UF+75-10% 15VDC AL CAPACITOR FXD 1900UF+75-10% 15VDC AL CAPACITOR FXD 350UF+75-10% 50VDC AL	20480 20400 20400 20400 56209	0160-2055 0160-2055 0100-2154 0180-2154 320357G050ULL DGB
2021 2022 2023 2024 2025	0100 2217 0160-2055 0160-2055 0100-0291 0100-2217	7 9 9 3 7		- LAPACTIOR FXD 3500€+75 10% 50VDC AI CAPACTIOR FXD .010C +80 20% 100VDC CER CAPACTIOR FXD .010E +85 20% 100VDC CER CAPACTIOR FXD 10E+~10% 35VDC TA CAPACTIOR FXD 3500E+75 10% 50VDC AI	56209 28480 28480 28480 56289 56289	39D357G050FLL DSR 0160-2055 0160-2055 150D103X903562 39D357G050FLL DSR
2C26 2C27	0180-2217 0160-2055	7 9		CAPACTION-EXD 350UE+75-10% 50VDC AL CAPACTION-EXD .01UE +80 20% 100VDC CCR	- 56289 28480	' - 39D357G050F(1 - DSB) - 0160 - 2055
2CR1 2CR2 2CR3 2CR4 2CR5	1901-0159 1901-0159 1901-0159 1901-0159 1901-0046	3 3 3 1	<b>4</b> 28	DIODE-PWP RECT 400V 750MA DO-41 DIODE-PWR RECT 400V 750MA DO-41 DIODE-PWR RECT 400V 750MA DO-41 DIODE-PWR RECT 400V 750MA DO-41 DIODE-SWITCHING 30V 50MA 2NS DO-35	26480 26480 26480 26480 26480	1901-0159 1901-0159 1901-0159 1901-0159 1901-0040
2CR6 2CR7 2CR8 2CR9 2CR10	1791 6040 1901-0040 1901-0040 1901-0040 1901-0040	1 1 1 1 1		DIODE SWITCHING 30V 50MA 2NG DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35	28480 28480 28480 28480 28480	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040
2CR11 2CR12 2CR13 2CR14 2CR15	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040	1 1 1 1 1		DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35	20480 26480 26480 26480 26480	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040

Table 6-3. Replaceable Parts (2 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A2CR16 A2CR17 A2CR18 A2CR19 A2CR20	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040	1 1 1 1 1	, ,	DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35	28480 28480 28480 28480 28480 28480	1701-0040 1701-0040 1701-0040 1701-0040 1701-0040
AZCR21 AZCR22 AZCR23 AZCR24 AZCR25	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040	1 1 1 1		DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35	28480 28480 28480 28480 28480 28480	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040
A2CR26 A2CR27 A2CR28 A2CR29 A2CR30	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040	1 1 1 1	,	DIDDE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35 DIODE-SWITCHING 30V 50MA 2NS DD-35	28480 28480 28480 28480 28480 28480	1901-0040 1901-0040 1901-0040 1901-0040 1901-0040
A2CR31 - A2CR33	1901-0040 1901-0040	1 1		DIODE-SWITCHING 30V 50MA 2NS DO-35 DIODE-SWITCHING 30V 50MA 2NS DO-35	28480 28480	1901-0040 1901-0040
ARF1 ARF2	2110-0063 2110-0269 2110-0027 2110-0269	2 0 0	1 4 2	FUSE .75A 250V NTD 1.25X.25 UL FUSEHOLDER-CLIP TYPE.25D-FUSE FUSE .125A 250V NTD 1.25X.25 UL FUSEHOLDER-CLIP TYPE.25D-FUSE	28480 28480 28480 28480	2110-0063 2110-0269 2110-0027 2110-0269
A2J1 A2J2 A2J3 A2J4 A2J5	1251-3412 1251-4969 1251-5719 1251-5720 1251-3412	8225 8	3 1 1	CONNECTOR 6-PIN M POST TYPE CONNECTOR 4-PIN M POST TYPE CONNECTOR 26-PIN M POST TYPE CONNECTOR 34-PIN M POST TYPE CONNECTOR 6-PIN M POST TYPE	28480 28480 28480 28480 28480	1251-3412 1251-4969 1251-5719 1251-5720 1251-3412
A2J6 A2J7 A2J8 A2J9 A2J10	1251-5719 1250-0257 1250-0257 1250-0257 1250-0257	2 1 1 1 1	6	CONNECTOR 26 PIN M POST TYPE CONNECTOR RE SMB M PC 50-OHM CONNECTOR-RE SMB M PC 50-OHM CONNECTOR-RE SMB M PC 50-OHM CONNECTOR-RE SMB M PC 50-OHM	28480 28480 28480 28480 28480 28480	1251-5219 1250-0252 1250-0252 1250-0252 1250-0252
A2J11 A2J12	1250~0257 1250~0257	1 1		CONNECTOR-RE SMB M PC 50-OHM CONNECTOR-RE SMB M PC 50-OHM	28480 28480	1250 <b>02</b> 57 <sup>//</sup> 1250-0257
ARK1 ARK2 ARK3	0490-0916 1200-0638 0490-0916 1200-0639 0490-0916 1200-0638	676767	16 16	RELAY-REED 1A 500MA 100VDC 5VDC-COTL SOCKET-IC 14 CONT DIP DIP-SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COTI SOCKET-IC 14-CONT DIP-DLP-SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COTL SOCKET-IC 14-CONT DIP DIP-SLDR	28480 28480 28480 28480 28480 28480	0420-0916 1700-0638 0490-0916 1200-0638 0490-0916 1200-0638
A2K4 A2K5 A2K6	0490-0916 1200-0638 0490-0916 1200-0638 0490-0916 1200-0638	676767		RELAY-REED 1A 500MA 100VDC 5VDC-COTL SDCKET-IC 14-CDNT DIP DIP SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COTL SOCKET-IC 14-CONT DIP DIP-SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COTL SOCKET-IC 14-CONT DIP DIP-GLDR	28480 28480 28480 28480 28480 28480	0490-0916 1200-0638 0490-0916 1200-0638 0490-0916 1200-0638
A2K7 A2K8 A2K9	0490 - 0916 1200 - 0638 0490 - 0638 1200 - 0638 0490 - 0916 1200 - 0638	676767		RELAY-REED 1A 500MA 100VDC 5VDC-COIL COCKET-IC 14-CONT DIP DIP-SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COII SOCKET-IC 14-CONT DIP DIP-SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COIL SOCKET IC 14-CONT DIP DIP-SLDR	28480 28480 28480 28480 28480 28480 28480	0490~0916 1200~0638 0490~0916 1200~0638 0490~0916 1200~0638
ARK 10 ARK 11	0490~0916 1200~0638 0490~0916 1200~0638 0490~0916 1200~0638	676767		RELAY-REED 1A 500MA 100VDC 5VDC-COIL SOCKET-IC 14-CONT DIP DIP SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COIL SOCKET-IC 14-CONT DIP DIP SLDR RELAY-REED 1A 500MA 100VDC 5VDC-COIL SOCKET-IC 14-CONT DIP DIP-SLDR	28480 28480 29480 29480 29480 29480	0490 0916 1200-0630 0490 0916 1200-0638 0490 0916 1200 0638
A2K 13 A2K 14 A2K 15	0490-0916 1200-0638 0490-0916 1200-0638 0490-0916 1200-0638	676767		RELAY-REED 1A 500MA 100VDC 5VDC-COTI. SOCKET-IC 14-CONT DIP DIP-SEDR RELAY-REED 1A 500MA 100VDC 5VDC-COTI. SOCKET IC 14-CONT DIP DIP-SEDR RELAY-REED 1A-500MA 100VDC 5VDC-COTI. SOCKET-IC 14-CONT DIP DIP SEDR	28480 28480 28480 28480 28480 28480 28480	0490 0916 1200 0630 0490 0916 1200-0638 0490 0916 1200-0638
A2K 16 A2K 17	0490-0916 1200-0639 0490-0766 0490-0769 0490-0771	6 7 4 7 1	1 1 1	RELAY-REED 1A 500MA 100VDC 5VDC-COTI SOCKET-IC 14-CONT DIP DIP SLDR RELAY 2C 12VDC-COTI 5A 24VDC SOCKET RLY PC RELAY RETAINER .924-IN-W 1.355-IN-OA-LG	28480 28480 28480 28480 28480 28480	0490-0916 1200-0638 0490-0766 ,0490-0769 0490-0771
A2K18 A2K19 A2K20	0490-1013 0490-1013 0490-1013	6 6 6	3	RELAY-REED 10 250MA 28VDC 5VDC-COTE 3VA RELAY-REED 10 250MA 28VDC 5VDC-COTE 3VA RELAY-REED 10.250MA 28VDC 5VDC-COTE 3VA	20400 28400 26480	0490-1013 0490-1013 0490-1013
AZL1 AZLZ AZL3	9100-1637 9100-1624 9100-1624	4 9 9	1 2	TADUCTOR RE-CH-MED 120UH 5% .166DX.385LG INDUCTOR RE-CH-MED 30UH 5% .166DX.385LG INDUCTOR RE-CH-MED 30UH 5% .166DX.385LG	28480 28480 28480	9100 1637 9100-1624 9100-1624
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Table 6-3. Replaceable Parts (3 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
A2Q1 A2Q2 A2Q3 A2Q4 A2Q5	1855-0423 1855-0423 1855-0423 1855-0423 1855-0423	55555	24	TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOP MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE	17856 17856 17856 17856 17856	UN1 0KM UN1 0KM UN1 0KM UN1 0KM UN1 0KM UN1 0KM
A296 A297 A298 A299 A2910	1855-0423 1855-0423 1855-0423 1855-0423 1855-0423	មឧបឧ		TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE	17856 17856 17856 17856 17856	UN1 0KM
A2Q11 A2Q12 A2Q13 A2Q14 A2Q15	18550423 18550423 19550423 18550423 18550423	ខេត្តមាន		TRANSISTOR MOSFET N-CHAN E-MODE	17856 17856 17856 17856 17856	UN1 0KM UN1 0KM UN1 0KM UN1 0KM UN1 0KM UN1 0KM
ARQ16 ARQ17 ARQ18 ARQ19 ARQ20	1855-0423 1855-0423 1855-0423 1853-0314 1855-0423	55555	" <b>2</b>	TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN F-MODE TRANSISTOR PNP 2N2905A SI TO-39 PD=600MW TRANSISTOR MOSFET N-CHAN E-MODE	17856 17856 17856 17856 04713 17856	UN1 0KM UN1 0KM UN1 0KM 2N2905A UN1 0KM
A2Q21 A2Q22 A2Q23 A2Q24 A2Q25	19550423 19530314 19550423 18550423 18550423	59555		TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR PNP 2N2905A SI TO-39 PD=600MW TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE TRANSISTOR MOSFET N-CHAN E-MODE	17656 04713 17656 17656 17656	UN1 8KM 2N2985A UN1 8KM UN1 8KM UN1 8KM
4282A	1855-0423	5		TRANSISTOR MOSFET N-CHAN E MODE.	17856	UN 1 OKM
A2R1 A2R2 A2R3 A2R4 A2R5	0757 - 0442 0757 - 0442 0757 - 0442 0757 - 0442 0757 - 0442	9992	, s	RESISTOR 10K 1% .125W F TC=0+-100 RESISTOR 909 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-T0-1002-F C4-1/8-T0-1002-F C4-1/8-T0-1002-F C4-1/8-T0-1002-F C4-1/8-T0-1002-F
A2R6 A2R7 A2R8 A2R9 A2R10	0757-0438 0757-0422 0757-0438 0698-8821 0698-8821	3 5 3 8 8	5	RESISTOR 5.11K 1% .125W F TC=0 >- 100 RESISTOR .909 1% .125W F TC=0 +- 100 RESISTOR 5.11K 1% .125W F TC=0 +- 100 RESISTOR 5.62 1% .125W F TC=0 +- 100 RESISTOR 5.62 1% .125W F TC=0 +- 100	24546 24546 24546 29480 28480	C4 1/8-T0-5111 F C4-1/8-T0-902R F C4-1/8-T0-5111 F 0628-8821
A2R11 A2R12 A2R13 A2R14 A2R15	0757-0401 0698-0084 0757-0279 0698-0084 0757-0466	0 9 0 9 7	1 p 1	RESISTOR 100 1% .125W F TC=0+-100 RESISTOR 2.15K 1% .125W F TC=0+-100 RESISTOR 3.16K 1% .125W F TC=0+-100 RESISTOR 2.15K 1% .125W F TC=0+-100 RESISTOR 110K 1% .125W F TC=0+-100	24546 24546 24546 24546 24546	C4-1/8-T0-101 F C4-1/8-T0-2153-F C4-1/8-T0-3161-F C4-1/8-T0-2151-F C4-1/8-T0-1103-F
ARTP1 ARTP2 ARTP3 ARTP4 ARTP5	0360-0535 0360-0535 0360-0535 0360-0535 0360-0535	0 0 0 0	16	TERMINAL TEST POYNT PCB TERMINAL TEST POINT PCB TERMINAL TEST POINT PCB TERMINAL TEST POINT PCB TERMINAL TEST POINT PCB	00000 00000 00000 00000	ORDER BY DESCRIPTION
A2TP6 A2TP7 A2TP8 A2TP9 A2TP10	0360~0535 0360~0535 0360~0535 0360~0535 0360~0535	0 0 0 0		TERMINAL TEST POINT POR	00000 00000 00000 00000	ORDER BY DESCRIPTION ORDER BY DISCRIPTION ORDER BY DESCRIPTION ORDER BY DESCRIPTION ORDER BY DESCRIPTION
ARTP11 A2TP12 ARTP13 A2TP14 ARTP15	0360-0535 0360-0535 0360-0535 0360-0535 0360-0535	0 0 0 0		TERMINAL TEST POINT PCD TERMINAL TEST POINT PCD TERMINAL TEST POINT PCD TERMINAL TEST POINT PCD TERMINAL TEST POINT PCD	00000 00000 00000 00000	ORDER BY DESCRIPTION
A2U1 A2U2 A2U3 A2U4 A2U5	1020 -2485 1020-2483 1020-1544 1020-1544 1020-1544	0 0 0	1 1 7	IC RCVR TTL LS BUS DCTL. IC RCVR TTL LS BUS DCTL. IC FF CMOS D-TYPE COM FLOCK QUAD IC FF CMOS D-TYPE COM CLOCK QUAD IC FF CMOS D-TYPE COM CLOCK QUAD IC FF CMOS D-TYPE COM CLOCK QUAD	01295 01295 30585 30585 30585	5N75168N 5N75161N CD40768F CD40768F CD40768F
1206 1207	1820-1544 1820-2551	0	,	IC FF CMOS D-TYPE COM CLOCK QUAD	31.585 28480	CD 4076BI"
A2UB A2U9	1200~0654 1820~1544 1820~1544	7 0	2	SOCKET-IC 40 CONT DIP DIP-SLDR IC FF CMOS D-TYPE COM CLOCK QUAD IC FF CMOS D-TYPE COM CLOCK QUAD	28480 31.585	1020-2551 1200-0654 CD4076EF
02010 02013 02012 02013	1820-1544 08954-80002 1200-0654 1820-2102 1820-0683	05786	1.	IC FF CMOS D-TYPE COM CLOCK QUAD PROGRAMMED-MICROPROCESSOR PROGRAMMED-MICROPROCESSOR IC LCH TIL LS D-TYPE OCIL IC INV TIL S HEX 1-INP	31.585 31.585 28480 28480 01295 01295	CD4076BF CD4076BF 08954-80002 1200-0654 SN74L5373N
2014 2015 2016	08954-80001 1200-0541	9 4 1 3	1 1 1 1	IC GATE TILLS NAND QUAD 2 INP PROGRAMMED-ROM SUCKET-IC 24-CONT DIP DIP-SLDR IC COMPARATOR PRON TO-97 PKG	01275 01275 28480 28480 01295	SNZ4LS00N 08954-80001 1200-0541 LM311L

Table 6-3. Replaceable Parts (4 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
2VR1	1902-0943	5	, 1	DIODE-ZNR 2.4V 5% DO-35 PD=.4W TC=037%	28480	1902-0943
\3	0895460003	4	1	HP-IB CONNECTOR ASSEMBLY	28490	0875460003
N3J1	1251-4040		1	CONNECTOR 24-PIN F MICRO RIBBON	28480	1251 -4040
	0380-0643 2190-0017	0 3 4	2 4	STANDOFF-HEX ,255-IN-LG 6-32THD WASHER-LK HLCL NO. 8 ,168-IN-LD-	00000 28480	ORDER BY DESCRIPTION 2190-0017
	2360-0113 2420-0003	27	16 2	SCREW-MACH 6-32 .25-IN-LG PAN-HD-POZ.C NUT-HEX-DBL-CHAM 6-32-THD .094-IN-THK	00000	ORDER BY DESCRIPTION ORDER BY DESCRIPTION
3J2	1251-5719	5		CONNECTOR 26-PIN M POST TYPE	26480	1251-5719
3MP 1	08954-00002	7	1	CONNECTOR PANEL	28480	08954-00002
351	3101-2126	1	1	SWITCH-SL 5-SPDT DTP-SLIDE-ASSY .1A	28480	3101-2126
<b>A4</b>	0960-0443	1	1	LINE MODULE-FILTERED	29480	0960-0443
	0360-0007 2590-0008 2360-0117 2420-0002	1 3 6 6	1 1 3	TERMINAL-SLOR LUG PL-MTG FOR-\$10-SCR WASHER-LK EXT T NO. 6.141-IN-ID SCREW-MACH 6-32.375-IN-LG PAN-HD-POZI NUT-HEX-DEL-CHAM 6-32-THD .109-IN-THK	28480 28480 80060 28480	0360-0007 2190-0008 ORDER BY DESCRIPTION 2420-0002
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Table 6-3. Replaceable Parts (5 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
	,			CHASSIS PARTS		
C1	0160-4065	5	1	CAPACITOR-FXD .1UF +-20% 250VAC(RMS) (ATTACHES TO LINE FILTER MODULE)	28480	0160-4065
F1 F2	2110-0043 2110-0004	ß 1	1	FUSE 1.5A 250V NTD 1.25X.25 UL FUSE .25A 250V NTD 1.25X.25 UL	28480 28480	2110-0043 2110-0004
F2	2110-0027	8	1	(FOR 100/120V OPERATION) FUSE 125A 250V NTD 1.25X.25 UL (FOR 220/240V OPERATION)	28480	2110-0027
J1	1510-0090 2190-0016 2950-0001 1510-0090 2190-0016 2950-0001	នាមានមាន	377	BINDING POST SGL SGL-TUR JGK WASHER-LK INTL T 3/B IN .377-IN-ID NUT-HEX-DDL-CHAM 3/B-32-THD .094-IN-THK BINDING POST SGL SGL-TUR JGK WASHER-LK INTL T 3/B IN .377-IN-ID NUT-HCX-DDL-CHAM 3/B-32-THD .094-IN-THK	29480 29480 00000 29480 29480 00000	1510-0090 2190-0016 ORDER BY DESCRIPTION 1510-0090 2190-0016 ORDER BY DESCRIPTION
J3	15100107 21900016 29500001 03601190 12500118 03601190 21900016 29500001	23855558	2 32	BINDING POST SGL SGL-TUR JGK CBK WASHER-LK INTL T 3/B IN .377-IN-ID NUT-HEX-DBL-CHAM 3/B-32-THD .094-IN-THK TERMINAL-SLOR LUG PL-MTG FOR-03/8-SCR CONNECTOR-RF BNC FEM SGL-HOLE-FR 50-OHM TERMINAL-SLDR LUG PL-MTG FOR-03/8-SCR WASHER-LK INTL T 3/B IN .377-IN-ID NUT-HEX-DBL-CHAM 3/B-32-THD .094-IN-THK	28480 28480 00006 28480 28480 28480 28480 00000	1510-0107 2190-0016 ORDER BY DESCRIPTION 0360-1190 1250-0118 0360-1190 2190-0016 ORDER BY DESCRIPTION
J5 J6	1250-0118 0360-1190 2190-0016 2950-0001 1510-0090 2190-0016 2950-0001	3538238		CONNECTOR-RF BNC FEM SGL-HOLE-FR 50-04M TERMINAL-SLDR LUG PL-MTG FOR-#3/8-SCR WASHER-L, INTL T 3/8 IN .377-IN-ID NUT-HEX-DBL-CHAM 3/8-32-THD .094-IN-THK BINDING POST SGL SGL-TUR JGK WASHER-LK INTL T 3/8 IN .377-IN-ID NUT-HE'-DBL-CHAM 3/8-32-THD .094-IN-THK	28480 28480 28480 00000 28480 28480 00000	1250-0118 0360-1190 2190-0016 ORDER BY DESCRIPTION 1510-0090 2190-0016 ORDER BY DESCRIPTION
J7	1510-0107 2190-0016 2950-0001 08954-60004 2190-0104 2950-0132	238506	5,	EINDING POST SGL SGL-TUR JGK CRK WASHER-LK INTL T 3/8 IN .377-IN-ID NUT-HEX-DBL-CHAM 3/8-32-THD .894-IN-THK TYPE-N CONNECTOR ASSEMBLY WASHER-LK INTL T 7/16 IN .439-IN-ID NUT-HEX-DBL-CHAM 7/16-28-THD .894-IN-THK	28480 28480 00000 28480 28480 00000	1510-0107 2190-0016 ORDER BY DESCRIPTION 08954-60009 2190-0104 ORDER BY DESCRIPTION
J9 J10	1251-1239 1251-0536 1251-2942 08954-60004 2190-0104 2950-0132	3 1 7 5 0 6	4 2 7	CONNECTOR 9-PIN F D SERIES CONTACT-CONN U/W-SUBMIN-D FEM SLDR-POT LOCK-SUBMIN D CONN TYPE-N CONNECTOR ASSEMBLY WASHER-LK INTL T 7/16 IN .439-IN-ID NUT-HEX-DBL-CHAM 7/16-28-THD .094-IN-THK	28480 28480 28480 28480 28480 00000	1251-1239 1251-0536 1251-2942 08954-60004 2190-0104 ORDER BY DESCRIPTION
J11	08954-60004 2190-0104 2950-0132	506	1	TYPE:N CONNECTOR ASSEMBLY WASHER-LK INTL T 7/16 IN .439-IN-ID NUT-HEX-DIL-CHAM 7/16-28-THD .094-IN-THK	28480 28480 8888	08954-60004 2190-0104 Order by Description
J12	12500870 12500872 12500958 12500964 21900068 29500035	46975B	4 4 5	CONNECTOR-BNC (P/O W7) CONNECTOR-RF RNC FEM SGLEHOLF-RR 50-OHM CONNECTOR-RF SMB FEM JNMTD 50-OHM BUSHING RF CONN BNC/TNC: FOR INTL NUT-RF CONN BNC/TNC: CLAMP NUT FOR WASHER-LK INTL T 1/2 IN .505-IN-ID NUT-HEX-DDL-CHAM 15/32-32-THD	28480 28480 24931 24931 28480 00000	1250-0870 1250-0872 CS 105-3 N126-2 2190-0068 ORDER BY DESCRIPTION
J13 J14	03954-60004 2190-0104 2950-0132 08954-60004 2190-0104 2950-0132	0		TYPE-N CONNECTOR ASSEMBLY WASHER-LK INTL T 7/16 IN .439-IN-ID NUT-HEX-DEL-CHAM 7/16-28-THD .094-IN-THK TYPE-N CONNECTOR ASSEMBLY WASHER-LK INTL T 7/16 IN .439-IN-ID NUT-HEX-DBL-CHAM 7/16-28-THD .094-IN-THK	28480 29480 00000 28480 28480 00000	08954-60004 2190-0104 ORDER BY DESCRIPTION 08954-60004 2190-0104 ORDER BY DESCRIPTION
J15	1250-0870 1250-0872 1250-0958 1250-0964 2190-0068 2950-0035	4 6 9 7 1 8		CONNECTOR-BNC (P/O W10) CONNECTOR-RF BNC FEM SGL-HOLE-RR 50-OHM CONNECTOR-RF SMB FEM UNMTO 50-OHM BUSHING RF CONN BNC/TNC: FOR INTL. NUT-RF CONN BNC/TNC: CLAMP NUT FOR WASHER-LK INTL T 1/2 IN .505-IN-ID NUT-HEX-DOL-CHAM 15/32-32-THD	28480 28480 24931 24931 28480 00000	1250-0870 1250-0872 CS 105-3 N126-2 2190-0068 ORDER BY DESCRIPTION
J16	1250-0970 1250-0872 1250-0958 1250-0964 2190-0068 2958-0035	469759	: g ·	CONNECTOR-BNC (P/O W11) CONNECTOR-RF BNC FEM SGL-HOLE-RR 50-0HM CONNECTOR-RF SMB FEM UNMTD 50-0HM BUSHING RF/CONN BNC/TNC: FOR INTL NUT-RF CONN BNC/TNC: CLAMP NUT FOR WASHER-LK INTL T 1/2 CN .505-IN-ID NUT-HEX-DBL-CHAM 15/32-32-THD	28480 28480 24931 24931 28480 00000	1250-0870 1250-0872 CS 105-3 N126-2 2190-0068 ORDER BY DESCRIPTION
J17	1250-0870 1250-0872 1250-0958 1250-0964 2190-0068 2950-0035	4 6 9 7 5 8		CONNECTOR-BNC (P/O W12) CONNECTOR-RF BNC FEM SGL-HOLE-RR 56-OHM CONNECTOR-RF SMB FEM UNMTD 50-OHM BUSHING RF CONN BNC/TNC: FOR INTL NUT-RF CONN BNC/TNC: CLAMP NUT FOR WASHER-LK INTL T 1/2 IN .505-IN-ID NUT-HEX-DBL-CHAM 15/32-32-THD	28480 20486 24931 24931 28480 00000	1250-0870 1250-0872 CS 105-3 N126-2 2190-0068 ORDER BY DESCRIPTION

Table 6-3. Replaceable Parts (6 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
J18	1251-0181 1251-0218 1251-0536	2 6 1	1 6	CONNECTOR 7-PIN F D SERIES LOCK-SUBMIN D CONN CONTACT-CONN U/W-SUBMIN-D FEM SIDR-POT (SEE SECTION B - SERVICE TOOLS)	28480 28480 28480	1251-0181 1251-0218 1251-0536
J19	1251-7455 1251-0218 8761A-0555	7 6 1	1 2	CONN-D-SMIN 37F (P/O W13) LOCK-SUBMIN D CONN COAX SWITCH-1E GHZ 3MM JACK	28480 28480 28480	1251-7455 1251-0218 8761A- <b>\$</b> 555
K 1 K2	2360-0199 2190-0006 87616-0555 2360-0199 2190-0006	41141	2	SCREW-MACH 6-32 .438-IN-LG PAN-HD-POZI WASHER-LK HLCL NO. 6 .141-IN-ID COAX SWITCH-18GHZ 3MM JACK SCREW-MACH 6-32 .438-IN-LG PAN-HD-POZI WASHER-LK HLCL NO. 6 .141-IN-ID	6000 28480 28480 0000 28480	ORDER BY DESCRIPTION 2190-0006 8761A-\$555 ORDER BY DESCRIPTION 2190-0006
MP1	0510-1148 1400-0017 2190-0006 2360-0121 2420-0002 3050-0227	201263	6 1 2 3	RETAINER-PUSH ON KB-TO-SHFT EXT CLAMP-CABLE .312-DIA .375-WD NYL WASHER-LK HLCL NO. 6 .141-IN-ID SCREW-MACH 6-32 .5-IN-LG PAN-HD-POZI NUT-HEX-DBL-CHAM 6-32-THD .109-IN-THK WASHER-FL MTLC NO. 6 .149-IN-ID	29490 29480 29480 0000 29480 29480	0510-1148 1400-0017 2190-0006 ORDER BY DESCRIPTION 2420-0002 3050-0227
MP3 MP4 MP5	1400-0611 1460-1345 2200-0105	0514	4 2 16	CLAMP-FL-CA 1-WD TILT STAND SST SCREW-MACH 4-40 .312-IN-LG PAN-HD-POZI (SECURE A2 TO DECK)	06915 28480 00000	CFCC-8 1460-1345 GRDER BY DESCRIPTION
MP6	2360-0113	5		SCREW-MACH 6-32 .25-IN-LG PAN-HD-POZI (ATTACH REAR PANEL TO A3 & REAR FRAME)	00000	ORDER BY DESCRIPTION
MP7 MP8 MP9	2360-0114 2360-0115 2510-0192	3 4 6	6	SCREW MACH 6-32 .25-IN-LG 82 DEG (FRONT PANEL TO FRONT FRAME) SCREW-MACH 6-32 .312-IN-LG PAN-HD-POZI (A1 TO FRONT & DECK TO SIDE STRUTS) SCREW-MACH 8-32 .25-IN-LG 100 DEG (FRONT & REAR FRAMES TO SIDE STRUTS)	00000 00000	ORDER BY DESCRIPTION ORDER BY DESCRIPTION ORDER BY DESCRIPTION
MP10 MP11 MP12 MP13 MP14	7120-1254 7120-3328 7120-4296 7120-4627 7120-5911	1 4 7 B 5	1 1 1 1	NAMEPLATE .312-IN-WD .54-IN-LG AL 'LABEL LABEL LABEL LABEL LABEL LABEL	28480, 28480 28480 28480 28480	7120 1254 7120 3320 7120-4296 7120-4627 7120-5911
MP15 MP16 MP17 MP18 MP19	7122-0097 7124-2372 5001-0438 5020-8801 5020-8802	24745	2	LABEL LABEL TRIM:SIDE FRAME, FRONT, FULL FRAME, REAR	28480 28480 28480 28480 28480	7122-0097 7124-2372 5001-0438 5026-8801 5020-8802
MP20 MP21 MP22 MP23 MP24	5020-8831 5040-7201 5040-7202 5060-9834 5060-9846	0 8 9 7 3	1 1	SIDE STRUTS FOOT(STANDARD) TRIM, TOP TOP COVER / BOTTOM COVER	28480 28480 28480 28480 28480	5020-8831 5040-7201 5040-7202 5060-9834 5060-9846
MP25 MP26 MP27 MP28 MP29	5060-9906 08954-00001 08954-00003 08954-00004 08954-00005	8 9	1 1 1	SIDE COVER REAR PANEL DECK FRONT SUB PANEL FRONT DRESS PANEL	28480 28480 28480 28480 28480	5060-9706 08754-00001 08754-00003 08754-00004 08754-00005
<b>S1</b>	3101-2080 5041-1418 2200-0165	9 6		LINE SWITCH (P/O W20) SWITCH-RKR BASIC DPDT 3A 250VAC SLDR-LUG ROCKER SCREW-MACH 4-40 ,25-IN-LG 82 DEG	28480 28480 00000	3101-2080 5041-1418 DRDCR BY DESCRIPTION
т1	9100-3963 0362-0265 1251-3275 1251-3897 2190-0019	27136	5 2 6	TRANSFORMER-FOWER 100/120/220/240V CONNECTOR-SGL CONT SKT 1,14-MM-BSC-SZ CONNECTOR 6-PIN F POST TYPE CONTACT-CONN U/W-POST-TYPE FEM CRP WASHER-LK HLCL NO. 4 ,115-IN-ID	28480 28480 28480 28480 28480	9100-3962 0362-0265 1251-3275 1251-3897 2190-0019
. •	2200-0125 2200-0001 3050-0004	8 9		SCREW-MACH 4-40 1.5-IN-LG PAN-HD-POZI SCREW-MACH 4-40 .125-IN-LG RD-HD-SLT WASHER-SHLDR NO. 4 .12-IN-TD .312-IN-OD	00000 00000 28480	ORDER BY DESCRIPTION ORDER BY DESCRIPTION 3050-0004
<b>U1</b>	1826-0181 0360-0001 2190-0006 2360-0115 2360-0121 2420-0002 3050-0227	1514263	16 2 16	IC.V RGLTR TO-3 TERMINAL-SLDR LUG LK-MTG FOR-06-SCR WASHER-LK HLCL NO. 6 .141-IN-ID SCREW-MACH 6-32 .312-IN-LG PAN-HD-POZI SCREW-MACH 6-32 .5-IN-LG PAN-HD-POZI NUT-HEX-DDL-CHAM 6-32-THD .109-IN-THK WASHER-FL MTLC NO. 6 .149 IN-ID	27014 28480 28480 00000 00000 28480 28480	LM323K 0360-0001 2190-0006 ORDER BY DESCRIPTION ORDER BY DESCRIPTION 2420-0002 3050-0227
U1 U2 U3 W4	08954-60100 08954-60101 08954-20101 08954-60102 08954-60113 08954-60114	3 9 4 7	1 1 1	CABLE "AUDIO INPUT" CABLE "AUDIO OUTPUT" SEMI-RIGID CABLE "RF POWER" CABLE ASSY "POWER SUPPLY/CONTROL" (INCLUDES J9, J18 AND HARDWARE) CABLE ASSEMBLY-COAX (RED) CABLE ASSEMBLY-COAX (ORANGE) WIRE-24 AWG (BLK) WIRE-24 AWG (RED)	28480 28480 28480 28480 28480 28480 28480	08954-60100 08954-60101 08954-20101 08954-60102 08954-60113 08954-60114

Table 6-3. Replaceable Parts (7 of 7)

Reference Designation	HP Part Number	C D	Qty	Description	Mfr Code	Mfr Part Number
u5 u6	08954-20192 08954-20103	0	1	WIRE-24 AWG (RED) WIRE-24 AWG (GRAY/WHITE) WIRE-24 AWG (GRAY) CABLE, SEMI-RIGID "MONITOR 1"	28480	08954-20102
W7 W8 W9 W10	08954-60103 08954-60104 08954-20105 08954-60104	5 2 3	1 1 1	CABLE,SEMI-RIGID "MONITOR 2"  CABLE,COAX "DEMOD" (INCLUDES J12 HDW)  CABLE,SEMI-RIGID "RF SOURCE 1"  CABLE,SEMI-RIGID "RF SOURCE 2"  CABLE ASSEMBLY-COAX "RF SOURCE-MOD 1"  (INCLUDES J15 HARDWARE)	28480 28480 28480 28480 28480	08954-20103 08954-60103 08954-20104 08954-20105 08954-60104
W11	08954-60105		1	CABLE ASSY-COAX "AUDIO SOURCE" (INCLUDES J16 HARDWARE) (INCLUDES J17 HARDWARE)	28480	08954-60105
W12	08954-60106		1	CABLE ASSY-COAX "AUDIO ANALYZER" (INCLUDES J19 AND HARDWARE)	28480	08754-60106
W13 W14 W15 W16	08954-60107 08954-60109 08954-60110 1251-3275 1251-4283	,	1 1 1 9	RIBBON CABLE "AUX RELAY" NOT ASSIGNED CABLE-RIBBON "HP-IB ADDRESS" CABLE ASSEMBLY "TRANSMIT KEY" CONNECTOR 6-PIN F POST TYPE CONTACT-CONN U/W-POST-TYPE FEM CRP	28480 28480 28480 28480 28480	08954-60107 08954-60109 08954-60110 1251-3275 1251-4283
W17 W18 W19	08954-20106 08954-60111 08954-60112	5	1 1 1	CABLE, SEMI-RIGID "RELAY TO RELAY" CABLE, RIBBON "ARJ6 TO A1J1" CABLE ASSY "A2J2 TO Q1" (INCLUDES CONNECTOR AND CONTACTS)	28480 28480 28480	08954-20106 08954-60111 08954-60112
	1251-3277 1251-4283	3	1	CONNECTOR 4-PIN F POST TYPE CONTACT-CONN U/W-POST-TYPE FEM CRP	28480 28480	1251 - 3277 1251 - 4283
W20 XF1	08954-60108 2110-0564	0 8	1	CABLE ASSY "POWER SOURCE" (INCLUDES SI) FUSFHOLDER BODY 12A MAX FOR UL	28480 H9027	09754-60109 031.1657
	2110~0565 2110~0569 2190~0068	9 3 5	1	SUSEMULDER CAP 12A MAX FOR UL FUSEMULDER COMPONENT NUT; THREAD M12.7 WASHER-LK INTL T 1/2 IN .505 IN-ID	28480 28480 28480 20480	2110-0565 2110-0569 2190-0068
Z1	0960-0459	9	1	POWER COMBINER	28480	0960 -0459
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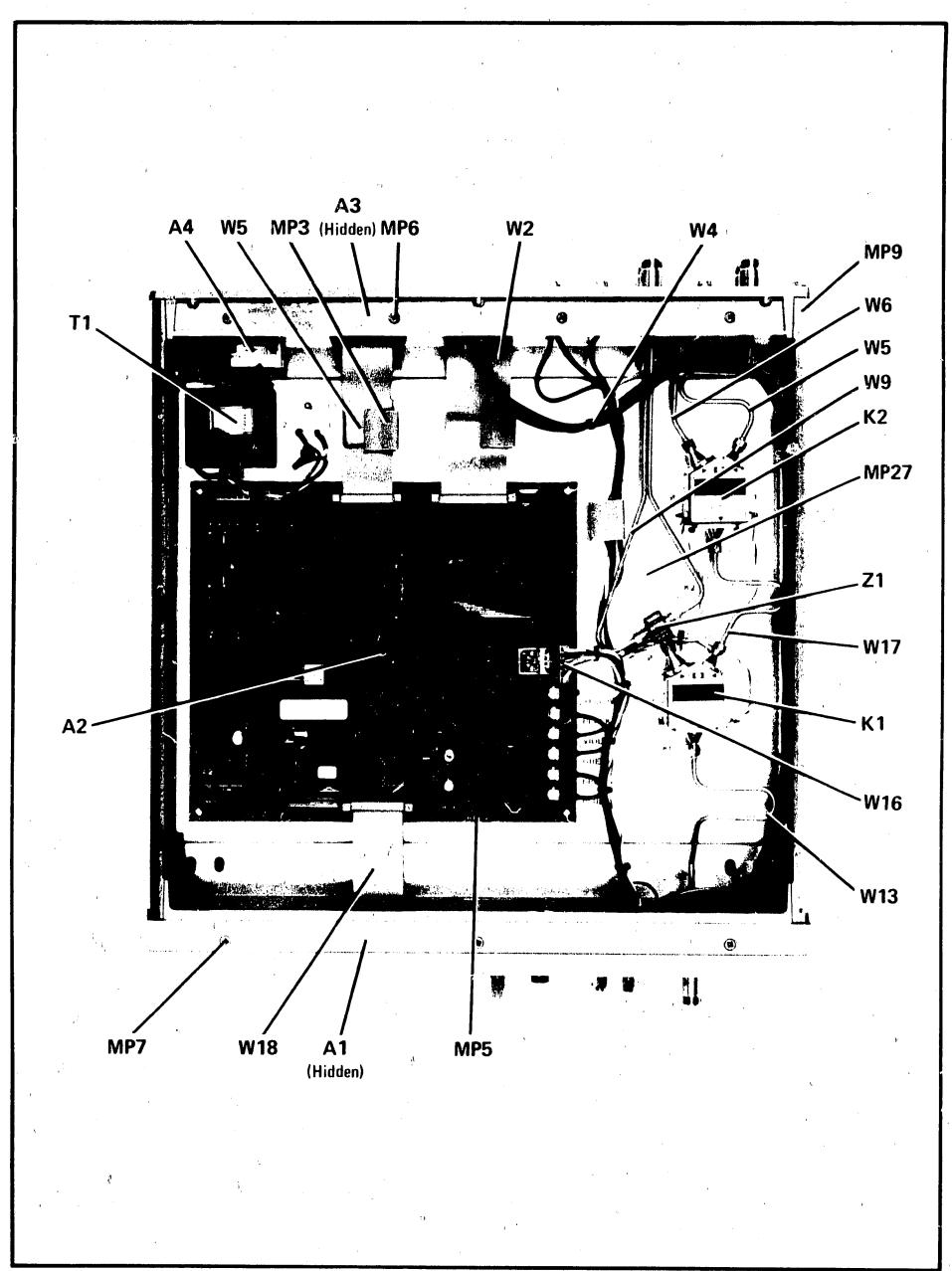


Figure 6-1. Top Chassis Parts, Mechanical Parts, Cables, and Assembly Identification

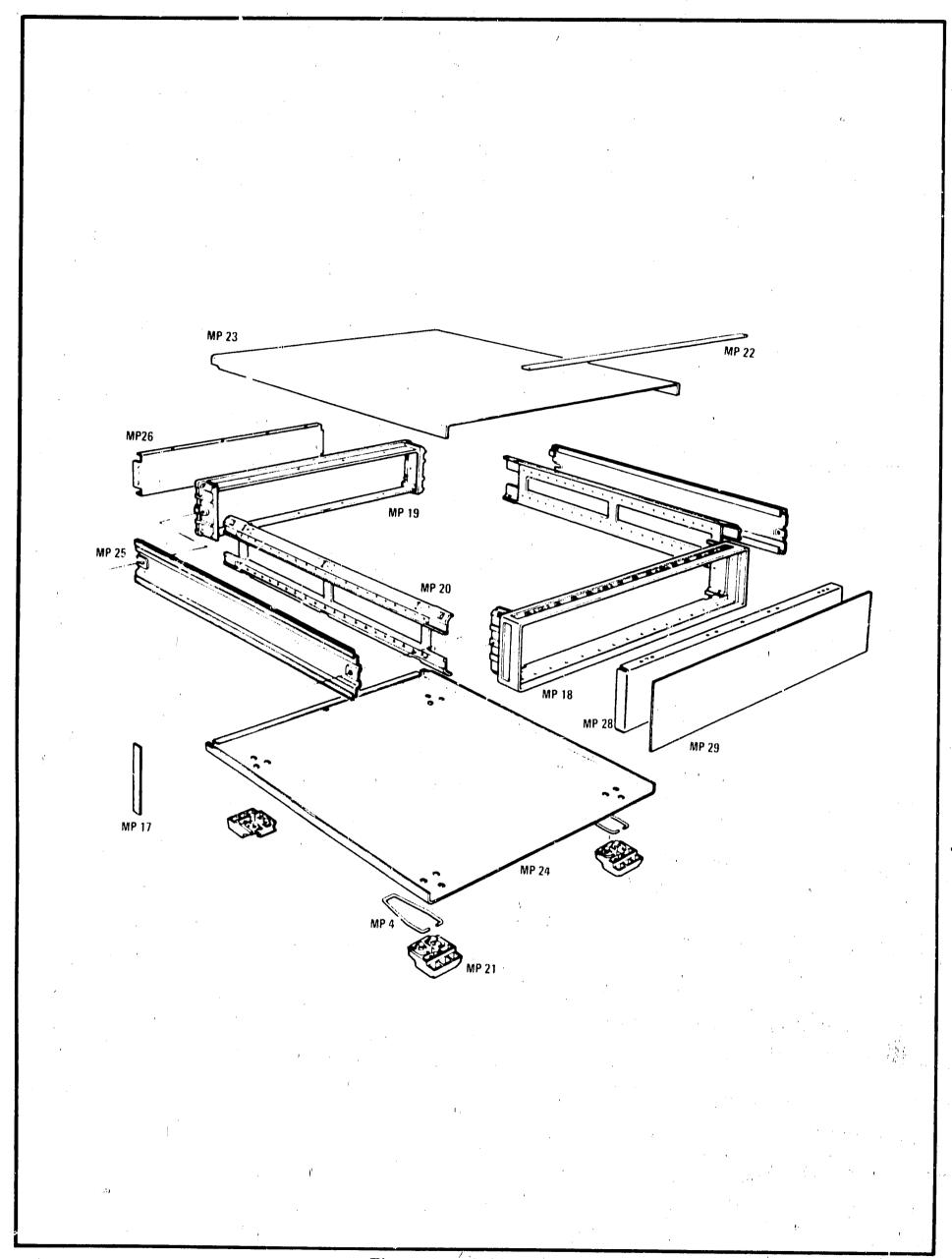


Figure 6-2. Cabinet Parts

Replaceable Parts Model 8954A

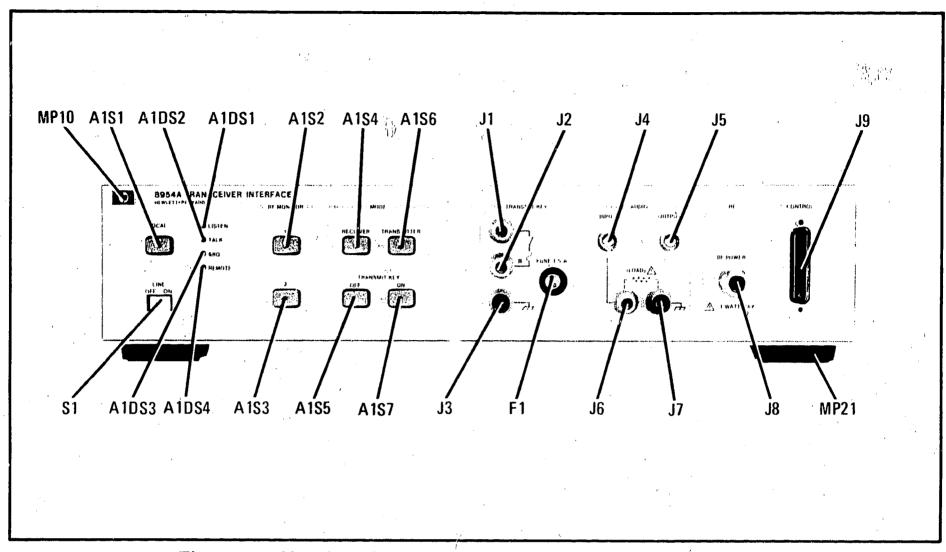


Figure 6-3. Chassis and Mechanical Parts Identification—Front Panel

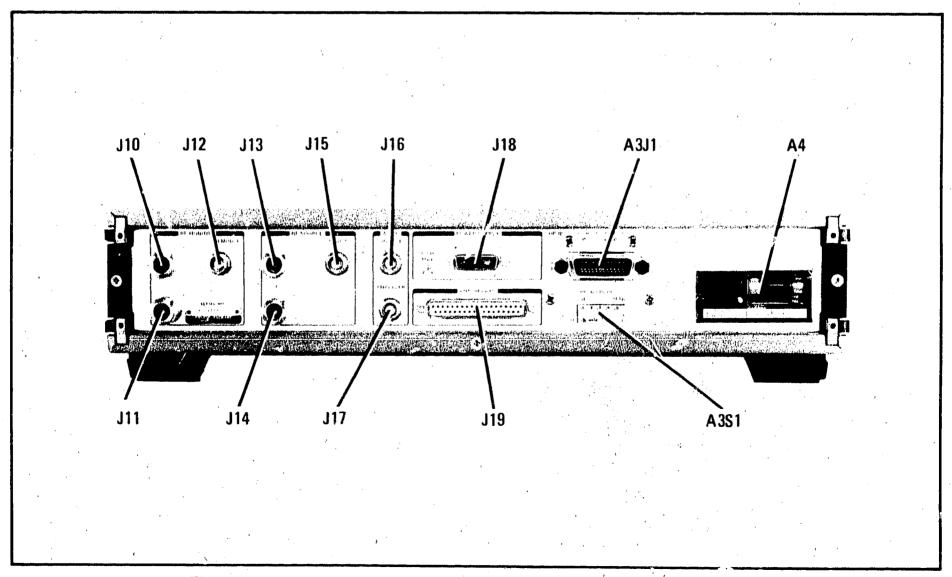


Figure 6-4. Chassis and Mechanical Parts Identification—Rear Panel

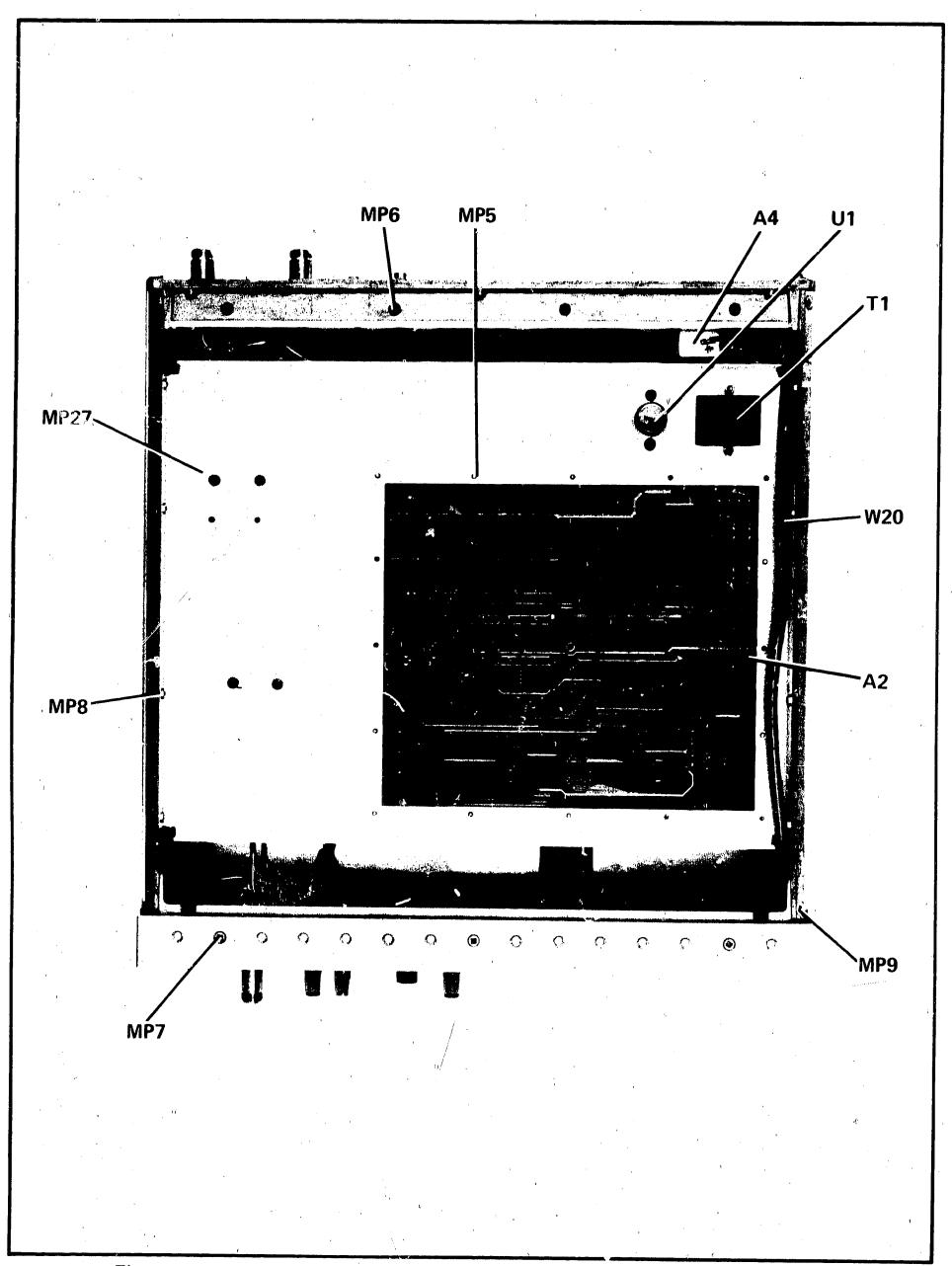


Figure 6-5. Bottom Chassis Parts, Mechanical Parts, Cable and Assembly Identification

# BACK DATING MANUAL CHANGES

# SECTION VII MANUAL CHANGES

### 7-1. INTRODUCTION

This section contains manual change instructions for adapting this manual to cover HP Model 8954A Transceiver Interfaces that have serial number prefixes which are lower than the first prefix listed on the title page.

### 7-2. MANUAL CHANGES

To adapt this manual to your instrument, refer to Table 7-1 and make all of the manual changes listed opposite your instrument's serial number or serial number se-

quence. The changes to your manual should be made in the sequence listed; for example, Change AA should be made after Change AB, Change AB should be made after Change AC, etc. Table 7-2 is a summary of changes by component.

If your instrument's serial number or prefix is not listed on the title page of this manual or in Table 7-1, it may be documented in a MANUAL CHANGES supplement. For additional information about serial number coverage, refer to INSTRUMENTS COVERED BY MANUAL in Section I.

Table 7-1. Manual Changes by Serial Number for "A" Prefix Instruments

Serial Prefix or Number	Changes to Manual	·	
2146	AA		
2000 Control of the C			

Table 7-2. Summary of Changes by Component

	Assemblies Affected											
Changes	<b>A1</b>	A2	A3	A4								
AA		CR33, K20, Q26		,								
			·									

#### **CHANGE AA**

Page 1-3, Figure 1-2:

Replace Figure 1-2. HP 8945A Transceiver In terface Test Configuration with the attached Figure 1-2.

Page 3-7, Figure 3-2:

Under (8) AUDIO ANALYZER, delete the second paragraph.

Page 3-29, Table 3-3:

Under HP-IB Programming Codes, delete the following:

Delete Delete	C1 C4	MIC. SENSE Relay ON. MIC. SENSE Relay OFF.	Activates relay A2K20.  De-activate relay A2K20.  (RECEIVER or TRANSMITTER keys will also accomplish the same function.)
Delete	<b>GF</b>	TRANSMIT KEY ON	Closes Relay A2K17 without forcing Transmitter mode.
Delete	J1	Turns On A2TP14.	
Delete	J2	Turns Off A2TP14.	
Delete	$\mathbf{J}3$	Turns On A2TP15.	
Delete	J4	Turns Off A2TP15.	

Page 6-6, Table 6-2:

In the list of **Replaceable Parts** delete the following:

Delete A2CR33 1901-0040 CD1 DIODE SWITCHING 30V 50 MA Delete A2K20 0490-1013 CD6 RELAY REED .25A1C 5VDC

Page 6-7, Table 6-2:

In the list of Replaceable Parts delete A2Q26.

Page 8-49, Service Sheet 2; Principles of Operation:

Under Relay Buffers, in the second to the last sentence, replace Q1-Q26 with Q1-Q25.

Under MOSFETS, in the first sentence replace Q23-Q26 with Q23-Q25.

Under MOSFETS, in the second sentence replace A2K1-A2K20 with A2K1-A2K19.

Under MOSFETS, in the second paragraph delete Q26 and replace CR20,CR33 with CR30.

Page 8-27, Figure 8-18, BD1 Service Sheet:

Replace the appropriate portion of the block diagram with the attached partial block diagram (P/O Figure 8-18, BD1 Service Sheet).

# **CHANGE AA (Cont'd)**

Page 8-52, Figure 8-23, Component Locations:

Replace the Interface Control Board Component Locator (A2 Assembly) with the attached figure. (Figure 8-23. Interface Control Board Component Locations).

Page 8-53, Figure 8-24, Schematic:

Replace the appropriate portion of the schematic diagram with the attached partial schematic diagram (P/O Figure 8-24. Relay Control Driver and Relays).

In the table of Reference Designations, under A2 Assembly, change the following:

Delete CR33.

Replace K1-20 with K1-19.

Replace Q1-26 with Q1-25.

Replace TP14-15 with TP14-16.

In the table of Transistor and Integrated Circuit Part Numbers, under Reference Designators, replace 623-26 with 923-25.

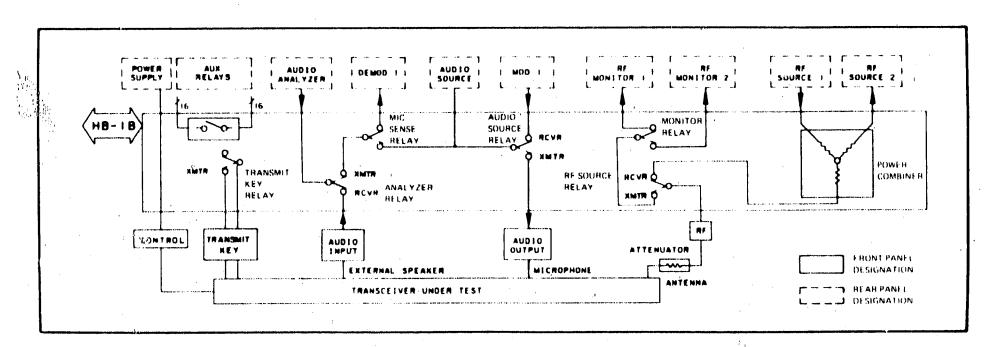
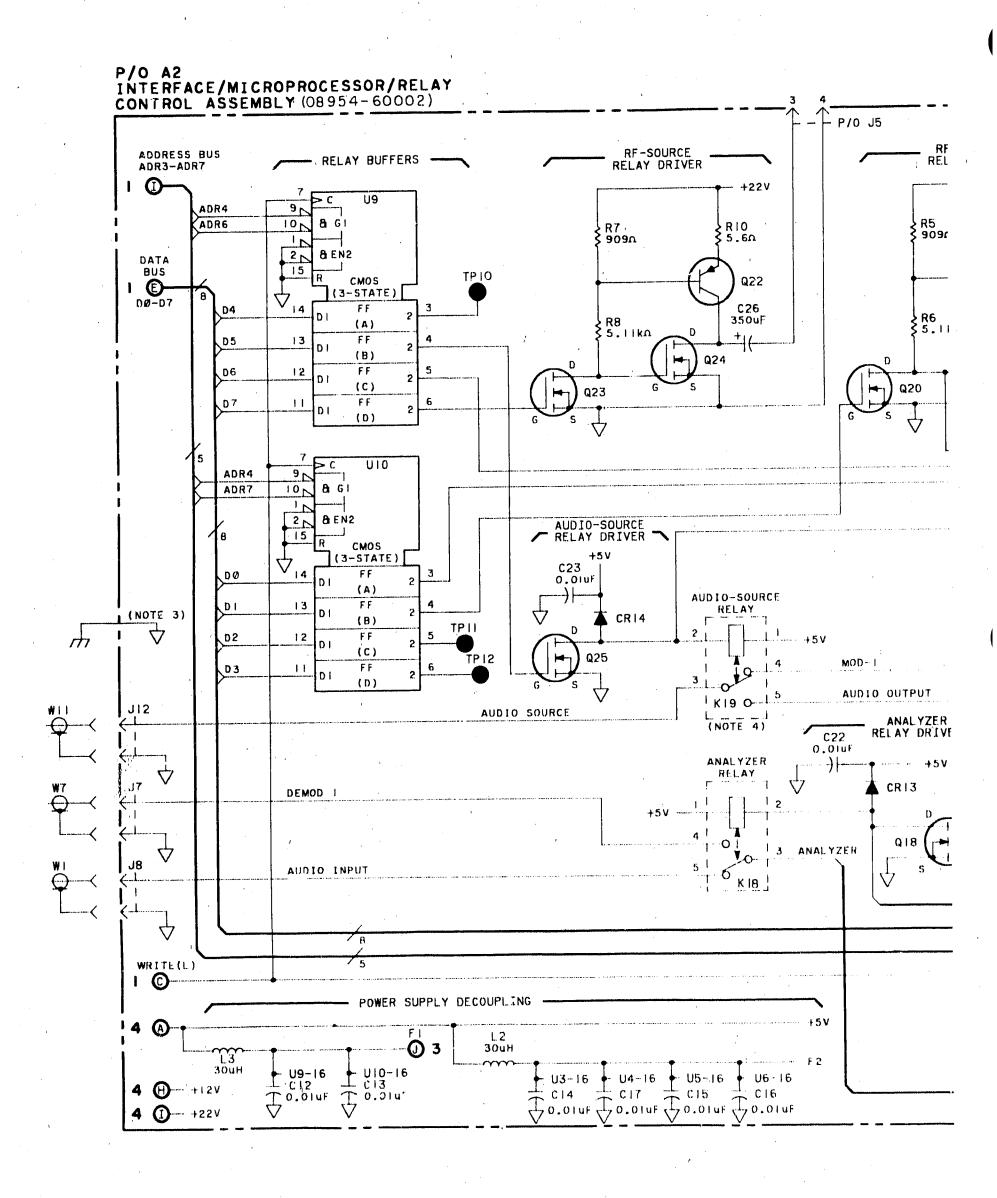
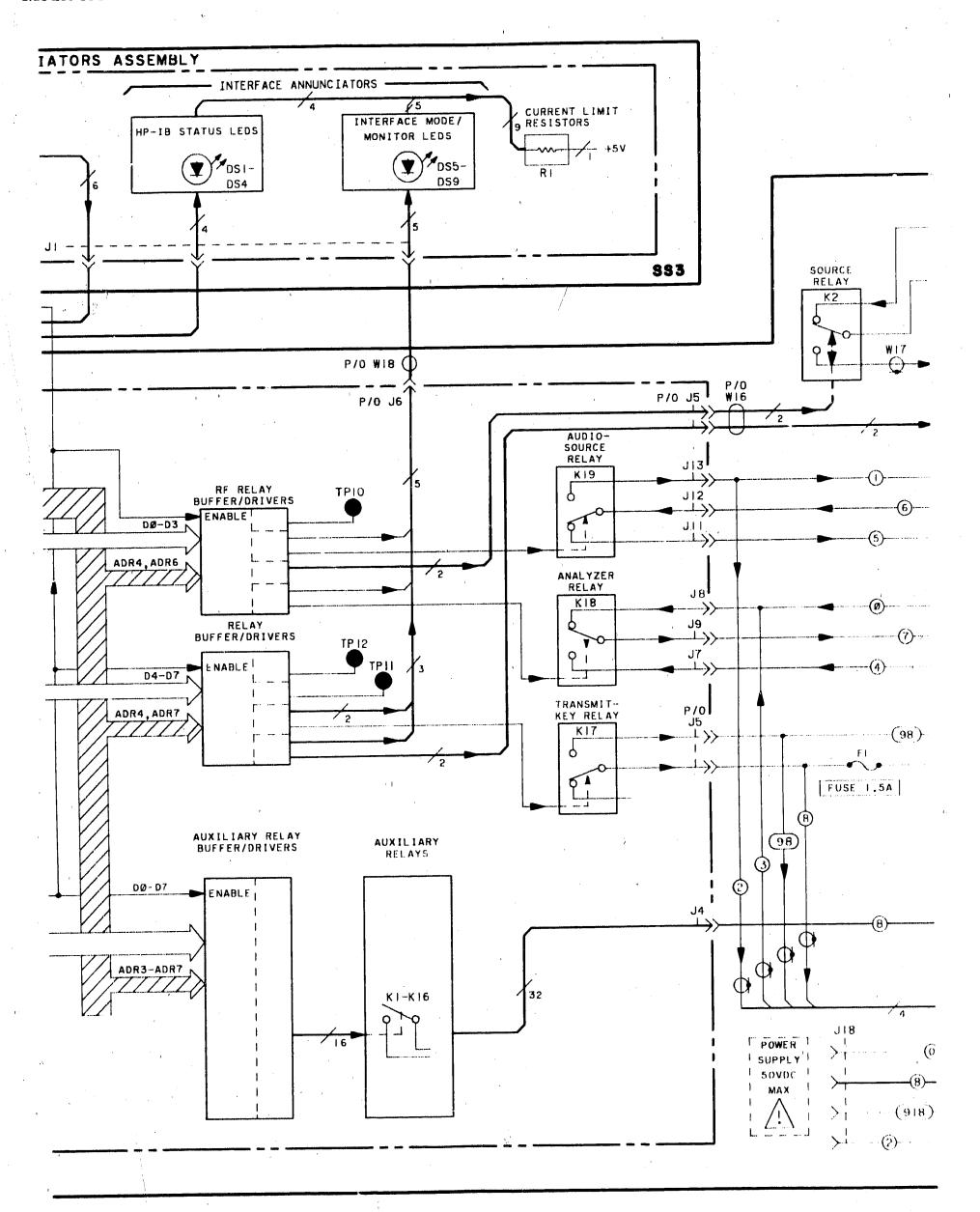


Figure 1-2. HP 8954A Transceiver Interface Test Configuration



P/O Figure 8-18 BD1 Service Sheet



P/O Figure 8-24. Service Sheet 2, Relay Control Driver and Relays

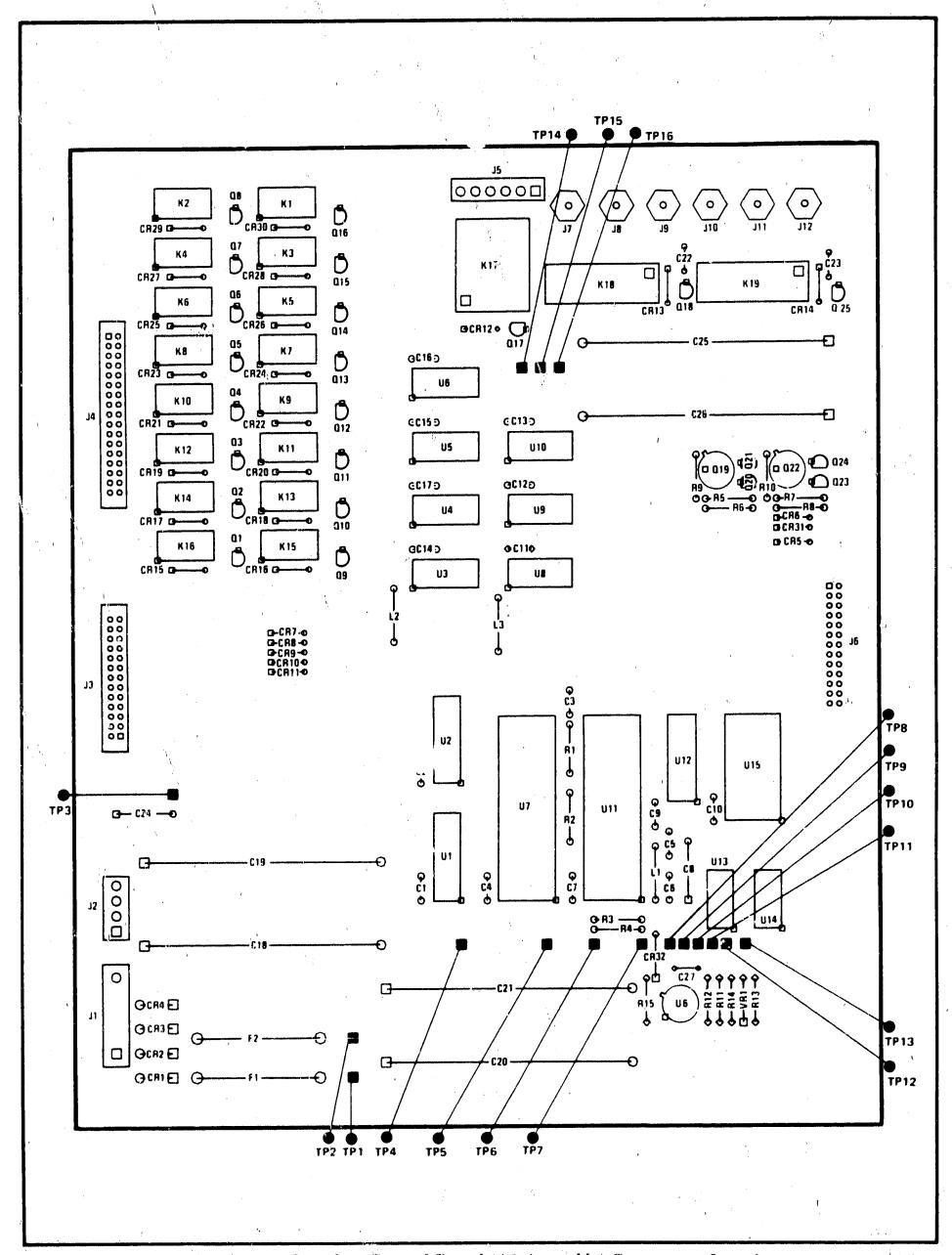


Figure 8-23. Interface Control Board (A2 Assembly) Component Locations

# SERVICE INFORMATION

# SERVICE

#### 8-1. INTRODUCTION

This section contains information for troubleshooting and repairing the Transceiver Interface. Included are block and circuit diagrams, principles of operation, troubleshooting tests, and repair procedures.

#### 8-2. SERVICE SHEETS

The foldout pages in the last part of this section are the service sheets. They consist of a block diagram, some circuit schematic diagrams, supplemental diagrams, and associated information. For more information refer to the paragraphs under the general heading of "TROUBLESHOOTING" in this section.

#### 8-3. Block Diagrams

Block Diagram BD1 shows all of the major circuits and their functional groupings. This block serves as an index to the circuit schematic diagrams.

# 8-4. Schematic Diagrams

The circuit schematic diagrams and their associated information are found on Service Sheets 1 through 4. These diagrams, in functional groupings, are aids for understanding the operation and for troubleshooting the Transceiver Interface. Refer to the paragraphs entitled "TROUBLESHOOTING..." for more information.

#### 8-5. SAFETY CONSIDERATIONS

### 8-6. Before Applying Power

The instrument must be set to match the available line voltage and have the correct fuse installed. An uninterrupted safety earth ground must be provided from the main power source to the instrument input wiring terminals, power cord, or supplied power cord set. Refer to paragraph 2-3 entitled "PREPARATION FOR USE".

# 8-7. Warnings and Cautions

WARNINGS and CAUTIONS must be followed for operator protection and to avoid damage to the equipment.

## **WARNING**

Maintenance described herein is performed with power supplied to the instrument and with the protective covers removed. Such maintenance should be performed only by service-trained personnel who are aware of the hazards involved (for example, fire and electrical shock).

# WARNING

Where maintenance can be performed without power supplied, the power should be removed. When any repair is completed, be sure that all safety features are intact and functioning and that all necessary parts are connected to their protective grounds.

Any interruption of the protective (grounding) conductor (inside or outside the instrument) or disconnection of the protective earth terminal will create a potential shock hazard that could result in personal injury. Grounding one conductor of a two conductor outlet is not sufficient. Whenever it is likely that the protection has been impaired, the instrument must be made inoperative; i.e., secured against unintended operation.

If this instrument is to be energized via an autotransformer, make sure that the autotransformer's common terminal is connected to the earth terminal of the power source.

Capacitors inside the instrument can still be charged even if the instrument is disconnected from its source of supply.

Make sure that only 250 volt fuses with the required rated current and of the specified type (normal blow, time delay, etc.) are used for replacement. Do not use repaired fuses or shortcircuited fuseholders. To do so could create a shock or fire hazard.

# CAUTION

Do not disconnect or remove any boards in the Transceiver Interface unless the instrument is unplugged. A board may contain devices which can be damaged if the board is removed when the power is on. Use conductive foam when removing MOS devices from circuit boards. Use care when unplugging ICs from high-grip sockets.

# 8-8. RECOMMENDED TEST EQUIPMENT AND ACCESSORIES

Test equipment and test accessories required to maintain the Transceiver Interface are listed in the table of "Recommended Test Equipment" in Section I. Equipment other than that listed may be used if it meets the listed critical specifications.

# 8-9. SERVICE TOOLS, AIDS, AND INFORMATION

## 8-10. Service Tools

The following paragraphs list some unique tools that make servicing of this instrument easier. Service aids (such as test points and reference designators) are provided in the instrument, and service information is provided in this manual.

Pozidriv Screwdrivers. Many screws in the Transceiver Interface appear to be Phillips type, but are not. To avoid damage to the screw slots, Pozidriv screwdrivers should be used. HP 8710-0899 is the No. 1 Pozidriv. HP 8710-0900 is the No. 2 Pozidriv.

Heat Staking Tool. The front panel pushbutton switches have small plastic pins protruding from the back. These tabs fit through holes in the printed circuit board and are melted down to hold the switch in place. This process is known as heat staking. The heat staking tool is a standard soldering iron with a special tip attached. (See Figure 8-2 and paragraphs entitled "Replacement of Key Cap and Pushbutton Switches".)

Refer to the paragraphs entitled "Replacement of Key Cap and Pushbutton Switches" under REPAIR in this section for the heat staking procedure.

Connector Insert Extraction Tool. The front-panel Control connector and the rear-panel Power Supply connector contain removable contacts. Easy removal of these contact inserts may be achieved with the following extraction tool. Cannon Electric, CET-6B Extraction Tool.

# 8-11. Assembly Locations

Assemblies in the Transceiver Interface are numbered sequentially from front to back; for example, A1 is on the front panel and A3 is on the back panel.

### 8-12. Replaceable Parts

The component location diagram is adjacent to the schematic diagram on the appropriate service sheet. The reference designator of the part is the assembly designator plus the part designator; for example, A6R9 is R9 on the A6 assembly. For specific component descriptions and ordering information, refer to Table 6-2, Replaceable Parts, in Section VI.

Major mechanical parts have reference designations that begin with the letters MP. Other mechanical parts, such as screws, are listed in the replaceable parts list below the part to which they fasten.

#### 8-13. Test Points

All test points are indicated on individual circuit board assemblies. Test points and can also be found on the component locator diagram adjacent to the assembly's schematic diagram.

# 8-14. Service Aids on Printed Circuit Boards

Service aids on printed circuit boards include test points, transistor, integrated circuit, and relay designations, and assembly part numbers.

# 8-15. Other Service Documents

Service Notes, Manual Change Supplements, and other service literature are available through Hewlett-Packard. For further information, contact your nearest Hewlett-Packard office.

#### 8-16. TROUBLESHOOTING

#### 8-17. General

Instrument problems will usually appear either as a result of an operator error or a catastrophic failure. The troubleshooting strategy is described in the following paragraphs. For more information as to the intended operation of this instrument, refer to Sections I through III of this manual.

When a catastrophic failure occurs, begin the troubleshooting procedure described in Block Diagram BD1. The troubleshooting information found on BD 1 will help isolate the problem to one of the four major sections of this instrument.

## 8-18. Strategy

Troubleshooting for the Transceiver Interface is organized into two levels. The overall troubleshooting level allows malfunctions to be identified to the circuit level, and then isolated to the component level with the aid of the circuit schematic. It is expected that effective troubleshooting, to the component level, is dependent on the skill and experience of the troubleshooter.

# 8-19. Overall Troubleshooting (Service Sheet BD1)

Overall troubleshooting begins with verifying that the power-on sequence occurs properly. At this point, power supply problems may become evident. The effect of inputs from the keyboard and an external computer are compared to indicate either a defective keyboard, a problem with the HP-IB interface, or to signify improper data processing by the instrument's control logic.

# 8-20. Circuit Troubleshooting (Service Sheets 1 through 4)

The goal of troubleshooting at the previous service sheet level is to isolate a problem to one of the four block diagrams shown in BD1. The number at the bottom right corner of each of these blocks references the user to the service sheet schematic.

## 8-21. SIGNATURE ANALYSIS

Signature analysis is a simple method of verifying the operation of digital circuitry. When properly used, signature analysis can detect extremely subtle hardware faults.

Refer to the HP 5005A Signature Multimeter Operating and Service Manual for a complete description of the instrument.

# 8-22. Signature Multimeter Features

Front Panel. Six LED seven-segment displays are on the front panel. There are two LEDs to the right of the displays. One indicates gate (measurement window) activity and the other signifies the presence of an unstable signature.

After the signature multimeter power-up sequence, all pushbutton controls automatically default into predetermined settings. The THRESHOLD and FUNCTION controls are set in the positions necessary for the measurements done in this instrument's

troubleshooting procedures. However, the POLARITY control settings must be modified to match the ones given under the multimeter POLARITY settings given in the troubleshooting section of each service sheet.

Data Probe. The Data Probe (more commonly referred to as a probe) is a handheld probe. Its main function is to accept signature information; however, it can also function as a logic probe. The lamp at the tip reacts the same as the lamp of the HP 545A Logic Probe. The lamp glows brightly for a logic high, turns off for a logic low, and glows dimly for a bad logic level, open circuit, or open state of a three-state device.

Timing Pod. The Timing Pod (more commonly referred to as a pod) houses three channels for START, STOP, and CLOCK control inputs. The input wires can be plugged directly to a 0.03-inch round pin or connected to a "grabber", which can be connected to a test point, component lead, or IC pin. It might be necessary to extend the length of the input wires of the pod. This can be accomplished by connecting wires of the desired length (with grabbers at each end) to the grabbers already present at the pod. HP part numbers for the grabbers are: red, 1400-0833; black, 1400-0832.

# 8-23. Signature Multimeter Operation

Signature Display. The signature multimeter uses a compression technique that reduces any long, complex data stream on a logic node into a four-digit signature. The digits used for this signature display are 0, 1, 2, 3, 4, 5, 6, 7, 8, 9, A, C, F, H, P, and U. The last six digits (letters) were chosen (rather than the hexadecimal A, B, C, D, E, F) to avoid confusion between letters and numbers on the seven-segment displays. For example, an 8 and a B would appear exactly the same on a seven-segment display.

Logic data is input to the signature multimeter through the probe for each and every circuit clock cycle that occurs within a circuit-controlled time window (see Figure 8-1). The signature multimeter has a 16-bit serial shift register that allows approximately 65 thousand possible signatures to be generated from a logic node.

The signature is a unique number representing timedependent logic activity during a specified measurement interval for the node being monitored. This signature will always be the same for that node, provided the circuit is functioning properly. Any change in the behavior of the node will produce a signature different from the one that appears in the signature table; thus indicating a circuit malfunction.

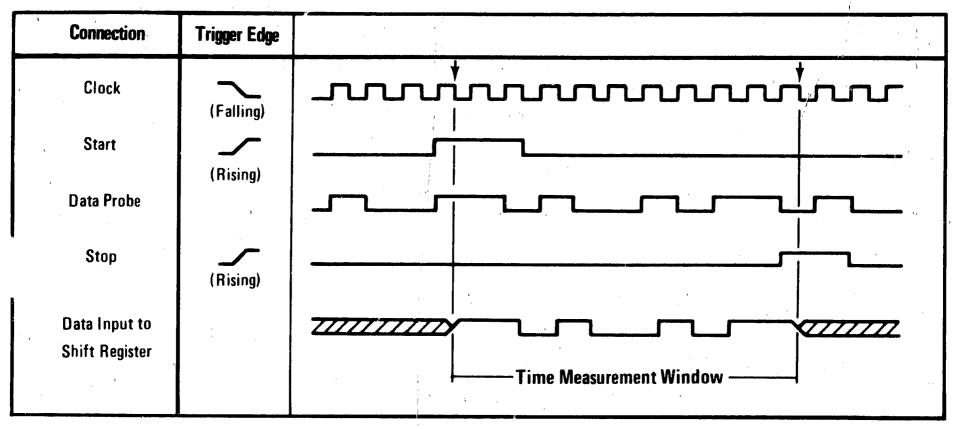


Figure 8-1. Signature Multimeter Timing Diagram

## 8-24. Unstable Signature

If there is an inconsistency in the data received during consecutive time-measurement windows, the UN-STABLE signature indicator lamp will blink. This indicates that an intermittent fault is occurring within the time-measurement window. However, the signature multimeter might not indicate an unstable signature if the measurement-window cycle time is too short.

### 8-25. Signature Analysis Considerations

To expedite signature analysis, the following steps must be observed:

- 1. Every step must be performed as described in the setup procedure. The CLOCK, START, and STOP connections, and the front-panel triggering must all be correct.
- 2. The node where the signatures are taken should be double-checked to be sure it is the correct node.
- 3. The signature multimeter probe must make good contact with the pin being checked. Oxidation on pins can cause invalid signatures due to poor contacts.
- 4. Each signature should be double-checked if it does not agree with the signature in the troubleshooting check.
- 5. When checking a node, the UNSTABLE signature indicator must not blink.

## 8-26. Additional Information

Additional troubleshooting information is found throughout the manual. References are made to this information in each troubleshooting procedure. Examples of this information are the "Power-On Procedure," the "Basic Functional Checks," and the "HP-IB Functional Checks," which are all found in Section III.

#### 8-27. REPAIR

# 8-28. Replacement of Key Cap and Pushbutton Switches

Key Cap Replacement. Removing a front-panel key cap may be easily done in one of two ways. If the front panel has been removed, use a small flat-blade screwdriver to press on the switch side of the key cap while working it from side-to-side with your fingers. Removing the key cap without opening the instrument is done as follows: Grasp the key cap firmly with pliers. Work it from side-to-side while pulling away from the panel.

#### NOTE

The pliers may damage the key cap unless the jaws are covered with a protective material.

Be sure the key cap is aligned properly before snapping into place. Note that the key cap has eight possible positions (See Figure 8-2).

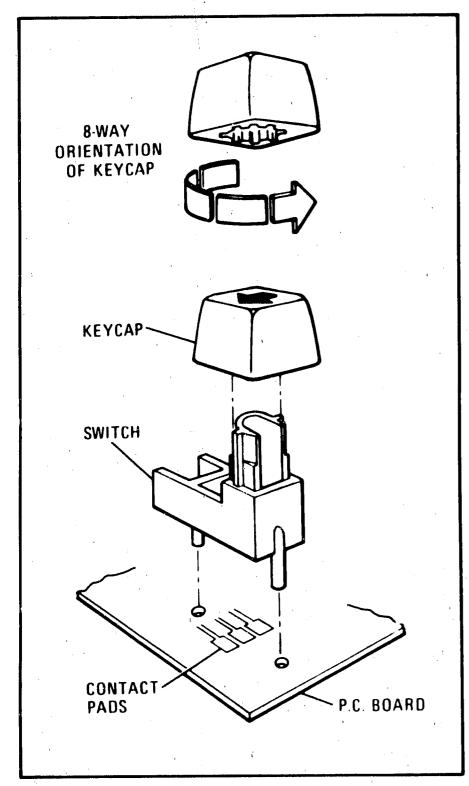


Figure 8-2. Front-Panel Pushbutton Switch Assembly

**Switch Replacement.** The front-panel switches have a very high cycle life. However, if one becomes faulty and needs replacement, follow the procedure outlined below:

- 1. Remove the front panel.
- 2. Remove the key cap as indicated in the Key Cap Replacement paragraph.
- 3. Remove the switch by chipping away the melted plastic tabs at the circuit-side of the keyboard which holds the switch in place.
- 4. To assure long life and reliable electrical performance, the circuit board contact traces (found underneath the switch) should be clean and free of surface imperfections. Clean the switch contact pads before installing a new switch.

- 5. For reliable operation, any method of assembly must assure that the switch is mounted tightly against the pc board. To facilitate the heat staking operation, specially molded support anvils (HP 5040-6881) can be ordered. (See Figure 8-3)
- 6. To assure proper switch assembly, verify that the switch is pushed firmly against the circuit board and with the hot (440°C or 825F) staking tip (see Figure 8-3), push down on both posts of the switch. With the proper cycle, the post initially turns a darker color and in about ten seconds, returns to its original bright red color. The correctly staked post should have a smooth, round, "rivet-like" top (see Figure 8-3).

#### **CAUTION**

Do not disturb the assembly for at least 10 seconds after heat staking.

If not enough heat is applied, the plastic will tend to stick to the tip of the iron.

If too much heat is applied, the plastic will fume profusely, the "rivet" will be irregularly shaped, and the plastic will be permanently discolored.

If the staking tool is worn or flaked, it will cause a misshaped rivet and/or a contamination deposit on the surface.

#### NOTE

The heat staking operation should be done in a well ventilated area. If the heat staking tip is too hot, the plastic will vaporize and emit fumes. These fumes, however, are non-toxic.

# 8-29. Manual Updating (Manual Changes Supplement)

Production changes to Transceiver Interfaces made after the publication date of this manual are indicated by a change in the serial number prefix. Changes to this manual's information are recorded by a serial prefix on the Manual Changes supplement. Errors are also noted in the ERRATA portion of the Manual Changes supplement.

Keep this manual up to date by periodically requesting the latest, complimentary supplement from your Hewlett-Packard office.

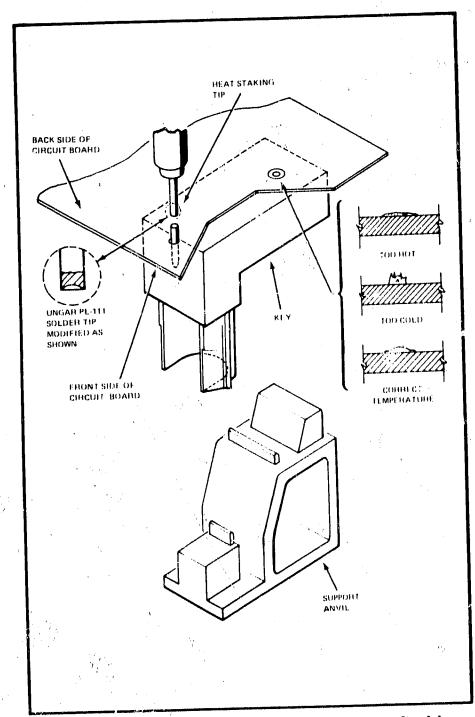


Figure 8-3. Typical Assembly for Heat Staking Operation

# 8-30. Etched Circuits (Printed Circuit Boards)

The etched circuit boards in the Transceiver Interface have plated-through holes which make a solderable path through to both sides of the insulating material. Soldering can be done from either side of the board with equally good results. When soldering to any circuit board, keep in mind the following recommendations:

1. Avoid unnecessary component substitution. Substitution can result in damage to the circuit board and/or the adjacent components.

- 2. Do not use a high-power soldering iron on etched circuit boards. Excessive heat may lift a conductor or damage the board.
- 3. Use a suction device or wooden toothpick to remove solder from component mounting holes. DO NOT USE A SHARP METAL OBJECT SUCH AS AN AWL OR TWIST DRILL FOR THIS PURPOSE. SHARP OBJECTS MAY DAMAGE THE PLATED-THROUGH CONDUCTOR.

# 8-31. MOS and CMOS Integrated Circuit Replacement

MOS and CMOS integrated circuits are used in this instrument. They are prone to damage from both static and transient voltages and require careful handling. When working on the Transciever Interface the following steps must be observed:

- 1. Do not remove any board unless the Transceiver Interface has been unplugged.
- 2. When removing a MOS or CMOS device from an assembly, precautions must be taken to avoid damage to its internal circuitry. Avoid removing devices from sockets with pullers. Instead, use a small screwdriver to pry the device up at one end, slowly pulling it up, one pair of pins at a time.
- 3. Once a MOS or CMOS device has been removed from an assembly, immediately place it in a pad of conductive foam or any other suitable holding medium.
- 4. When replacing a MOS or CMOS device, ground the foam on which it resides to the instrument before removing it. If a device requires soldering, the assembly must be lying on a sheet of conductive foam. The foam and soldering iron tip must be grounded to the assembly under repair. Apply as little heat as possible.
- 5. Before turning the instrument off, remove any large ac sources which may be driving MOS switches.

Table 8-1. Etched Circuit Soldering Equipment

ITEM	USE	SPECIFICATIONS	ITEM RECOMMENDED	HP PART NO.
Soldering Tool	Soldering Heat Staking	Wattage: 35W Tip Temp.: 390C-440C (735F-825F)	Ungar No. 135 Ungar Division Eldon Ind. Corp. Compton, CA 90220	8690-0167
Soldering Tip	Soldering, Unsoldering	*Shape: Chisel	*Ungar PL113	8690-0007
Soldering Tip	Heat Staking	Shape: Cupped	HP 5020-8160 or modified Ungar PL111 (see Fig. 8-2)	5020-8160
Support Anvil	Heat Staking	Support key during heat staking	HP 5020-8160	5020-8160
De-Soldering Aid	To remove molten solder from connection	Suction Device	Soldapulit by Edsyn Co., Van Nuys, CA 91406	8690-0060
Rosin (flux) Solvent	To remove excess flux from soldered area before application of protective coating	Must not dissolve etched circuit base board	Freon	8500-0232
Solder	Component replacement	Rosin (flux) core, high tin content. (63/37, tin/lead)		8090-0607
	Circuit board repair wiring	18 gauge (SWG) 0.048 in. diam. preferred.		

<sup>\*</sup>For working on circuit boards; for general purpose work, use No. 555 Handle (8690-0261) and No. 4037 Heating Unit 47½ 56½ W (8690-0006); tip temperature of 850-900F, and Ungar No. PL113 1/8" chisel tip.

# 8-32. SCHEMATIC SYMBOLOGY AND OPERATING PRINCIPLES

## 8-33. Schematic Diagram Notes

Table 8-2, which just precedes BD1, summarizes the symbology used in the schematics of the Transceiver Interface.

# 8-34. Basic Logic Symbology

The logic symbols used in this manual are based on the American National Standards Institute (ANSI) Y32.14-1973, "Graphic Symbols for Logic Diagrams

(Two State Devices)". These logic symbols are summarized in the following paragraphs, which include a brief description of the basic logic symbols, a summary of indicator symbols, a discussion of contiguous blocks, control blocks, and dependency notation, and a summary of symbology for some of the more complex devices.

Gates and Qualifiers. Qualifiers are that portion of a device symbol that denote the logic function; for examle, "&" denotes the AND function. (See Figure 8-4 for a summary of the basic logic symbols and their qualifiers.) Power supply and ground connections are not shown on the symbols. This information is tabulated under "NOTES" in the right margins of the service sheets.

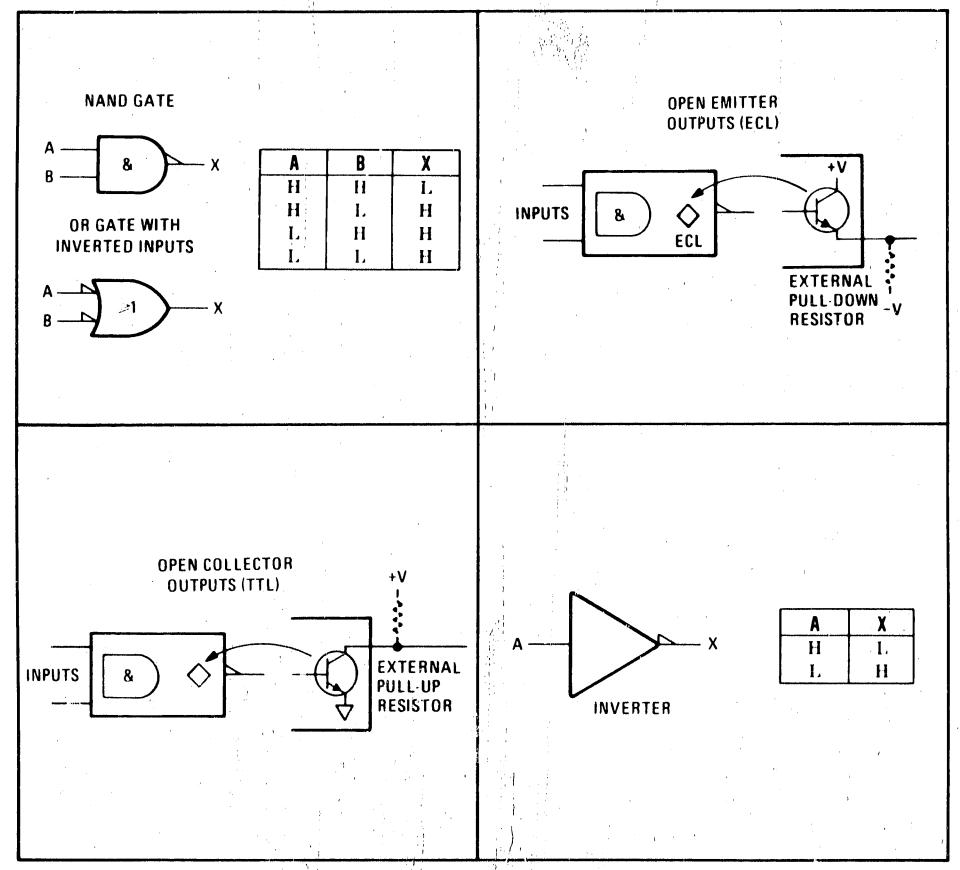


Figure 8-4. Basic Logic Symbols and Qualifiers

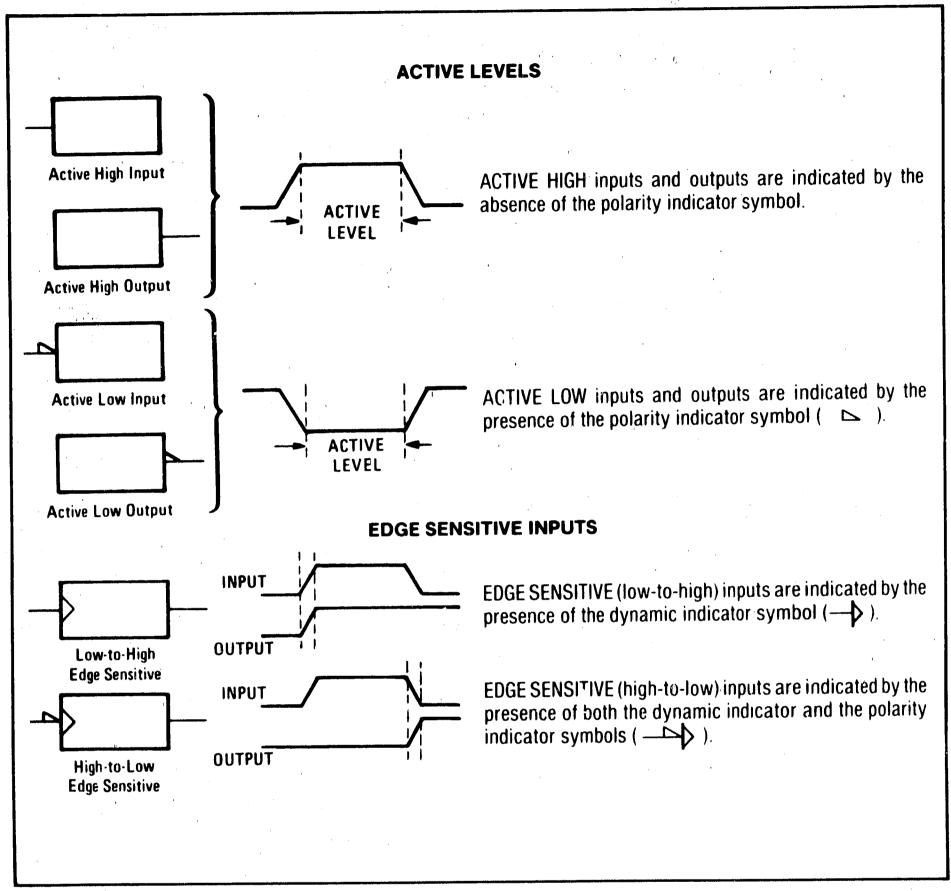


Figure 8-5. Indicator Symbols

Indicator Symbols: Indicator symbols identify the active state of a device's input or output as shown in Figure 8-5.

Common Control Block. The control block is used in conjunction with an array of related symbols to group common logic lines. Figure 8-6 shows how the control block is usually represented. Figure 8-10 shows a quad, D-type flip-flop with reset (redrawn in Figure 8-11). The more complex representation shown in Figure 8-10 is used when the flip-flops are functionally scattered around the schematic; that is when they are not used as a quad unit.

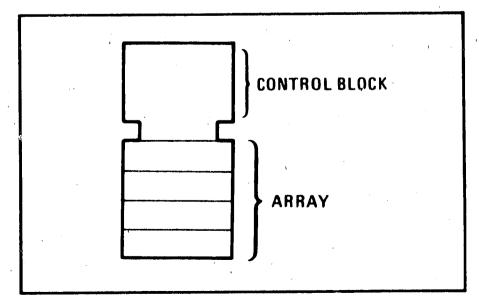


Figure 8-6. Control Block

Dependency Notation. Dependency notation simplifies symbols for complex integrated circuit elements by defining the interdependencies of inputs or outputs without actually showing all the elements and interconnections involved. Letters or symbols are used as abbreviations for these interdependencies: Figures 8-7 through 8-13 use A for address, C for control, G for AND, > for OR, and EN for output enable. A number prefix on an input or output denotes its dependency on the letter or symbol with the same number as a suffix (see Figure 8-7 and 8-8).

Contiguous Blocks. Two symbols may share a common boundary parallel or perpendicular to the direction of the signal flow. Note that in the examples shown in Figure 8-9, portions of the symbol that are separated by a horizontal line have no logic connection, but there is always an implied logic connection between portions of the symbol that are separated by a vertical line. Exceptions to this rule are the horizontal lines beneath control blocks and between sections of shift registers and counters (dividers).

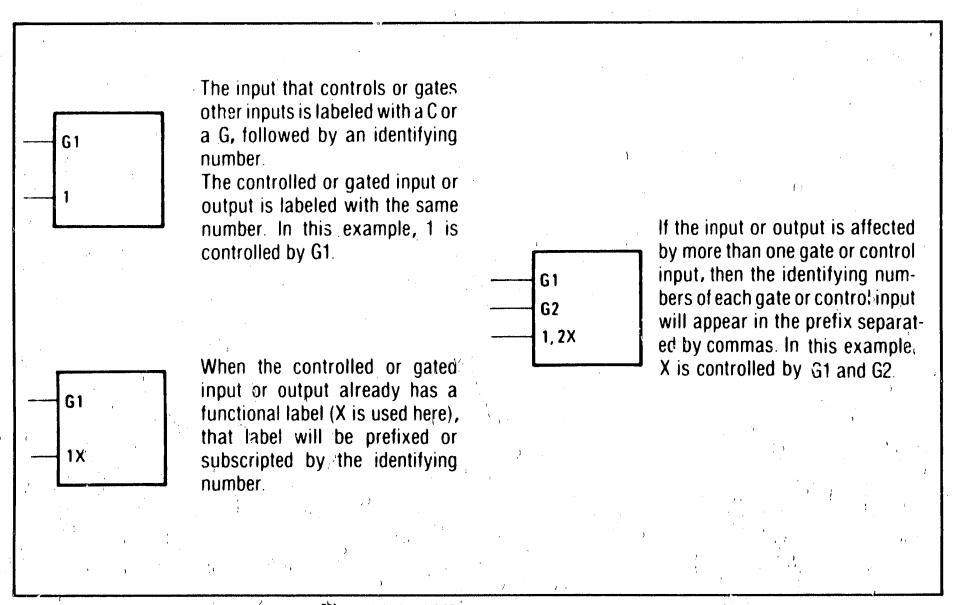


Figure 8-7. AND Dependency Notation

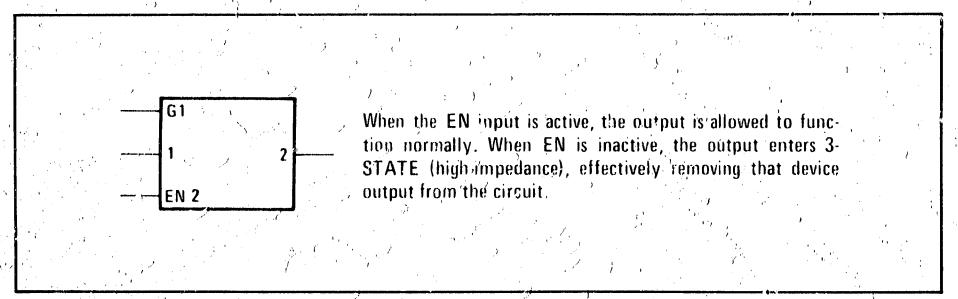


Figure 8-8. Free Dependency Notation

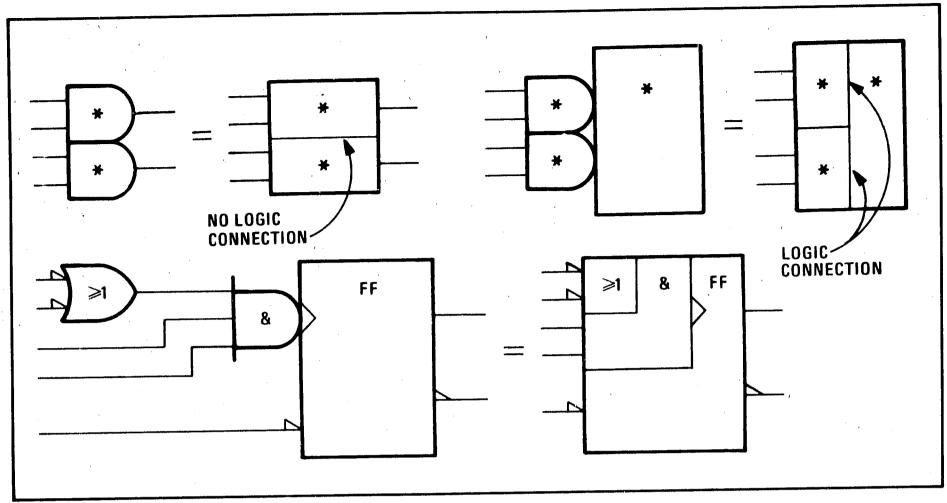


Figure 8-9. Contiguous Blocks

Quad, D-Type Latch. The Register control block is used to illustrate a quad, type latch. A common, active-low reset (R), and a common, edge-triggered

control input (C) are used to control the latch. Since there is only one dependency relationship, the controlling input is not numbered.

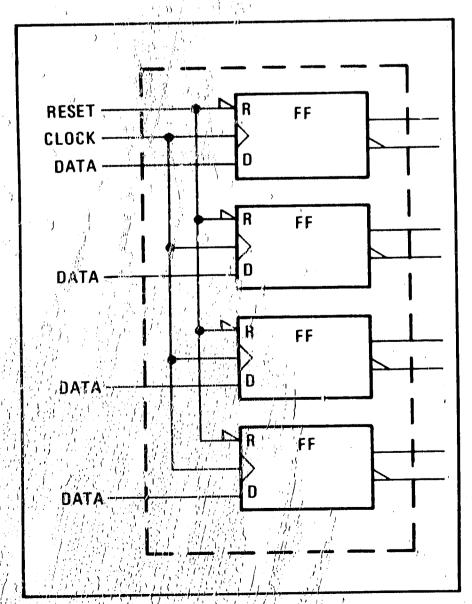


Figure 8-10. Quad D. Type Latch (Individual)

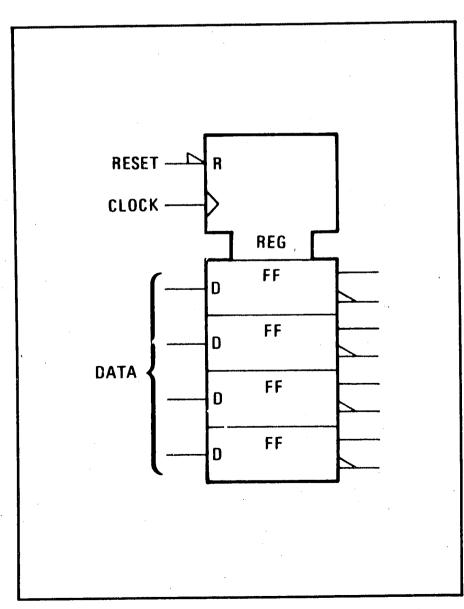


Figure 8-11. Quad D-Type Latch (Combined)

# 8-35. Complex Logic Symbology and Operating Principles

Microprocessor. For information regarding this device, refer to the principles of operation on Service Sheet 1.

Read Only Memory (ROM). The ROM in Figure 8-12 provides permanent storage for up to 2048 eight-bit words. Memory words are addressed by the address bus. When all control inputs are active, the output of the ROM is enabled. When any one of the EN inputs are inactive, the output is forced into an inactive (high impedance) state.

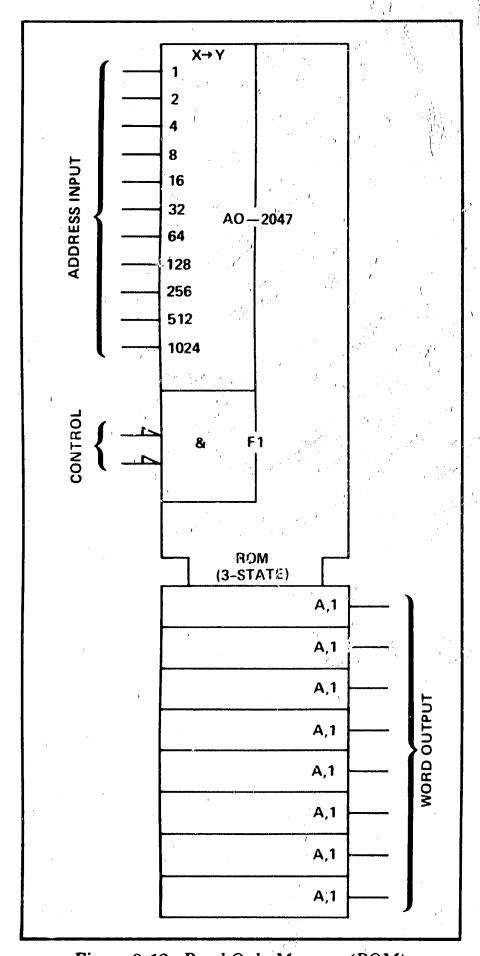


Figure 8-12. Read Only Memory (ROM)

Multiple Bus Transceivers. The data bus buffer in Figure 8-13 is used as a buffer between the Transceiver Interface's interface adapter (GPIA) and the external HP-IB data bus. This buffer allows bidirectional data transfer controlled by the talk enable (TE) and pull-up enable (PE) inputs.

The handshake and control buffer in Figure 8-14 is used as a buffer between the Transceiver Interface's interface adapter (GPIA) and the external HP-IB handshake and control lines.

The management of bidirectional Figure 8-12. Read Only Memory data flow is provided by the (ROM) Talk Enable (TE) and Astention (ATN) inputs.

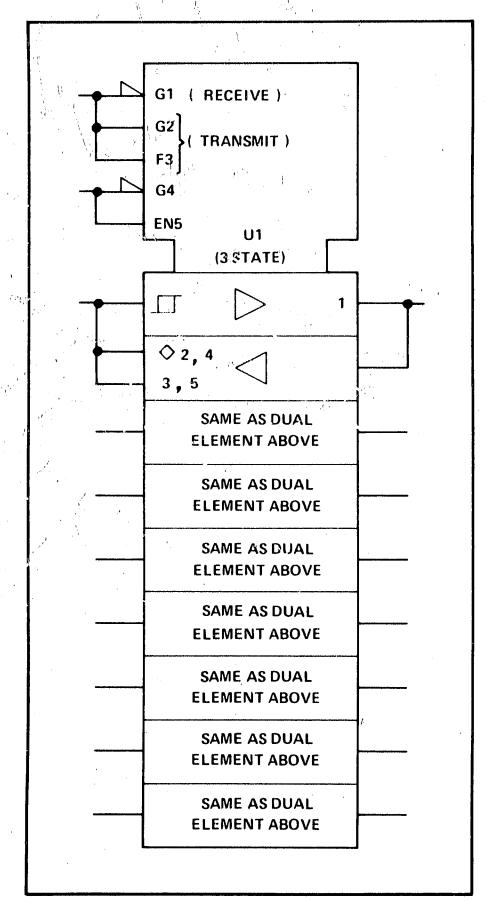


Figure 8-13. HP-IB Data Bus Buffer

Service Sheet 1 contains more detailed information regarding these bus transceivers.

## NOTE

The illustrated configuration in Figure 8-14 represents the device operation as determined by pin 11 tied high.

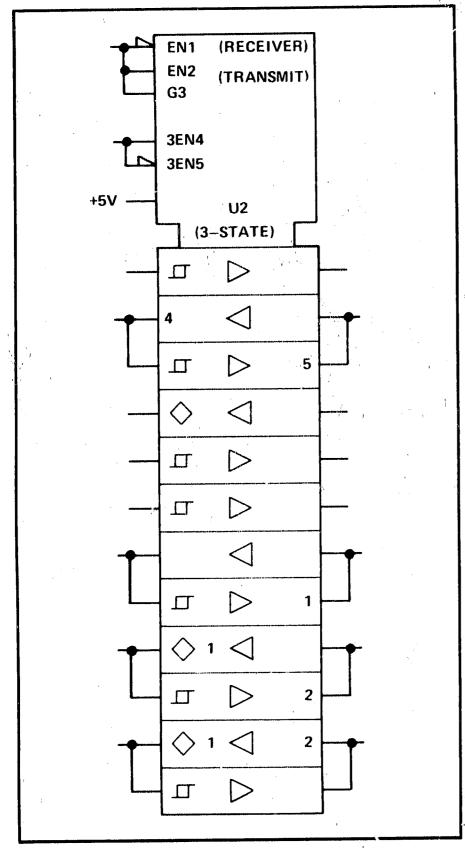


Figure 8-14. HP-IB Handshake and Control Buffer

General Purpose Interface Adapter (GPIA). The GPIA in Figure 8-15 interfaces the microprocessor in the instrument to the Hewlett-Packard Interface Bus (HP-IB). The GPIA is assigned to automatically handle HP-IB protocol. More detailed information regarding the operation and description of the General Purpose Interface Adapter can be found on Service Sheet 1.

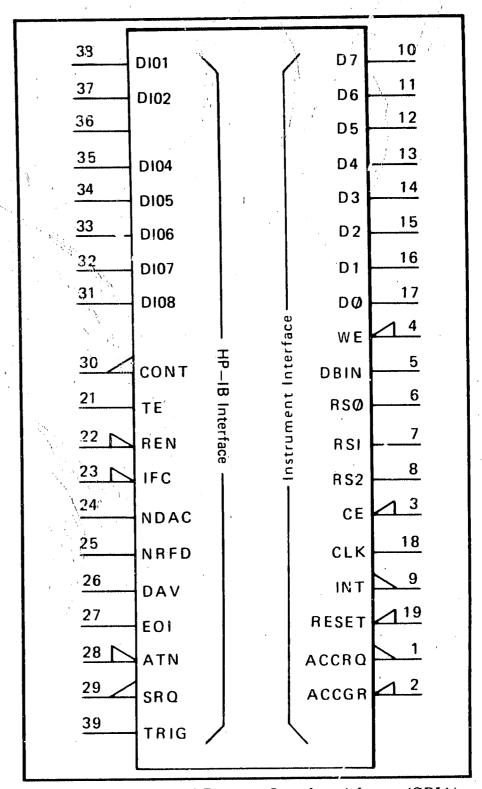


Figure 8-15. General Purpose Interface Adapter (GPIA)

Non-inverting Comparator. The non-inverting comparator is used as a level-sense amplifier. A voltage reference is connected to the inverting input as shown in Figure 8-16. When the voltage level on the non-inverting input crosses the reference, the output voltage is switched to the opposite polarity until the input signal recrosses the reference voltage level.

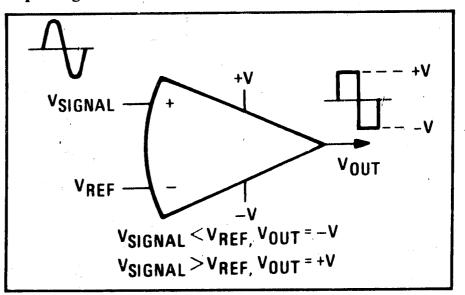


Figure 8-16. Non-inverting Comparator

Table 8-2. Schematic Diagram Notes (1 of 3)

R, L, C Resistance is in ohms, inductance is in micro-henries, capacitance is in microfarads, unless otherwise noted.  henries, capacitance is in microfarads, unless otherwise noted.  P/ID Part of.  Indicates a factory selected component.  Indicates a plug-in connection.  Indicates a soldered or mechanical connection.  Indicates a plug-in connection.  Indicates plug-in connection.  Indicates plug-in connection.  Indicates plug-in connection.  In	COMPONENT SYMBOLOGY	
otherwise noted.  Prof.   Part of.   Indicates base color, second and third numbers indicate colored stripes.   Indicates a factory selected component.   Ordered stripes.   Indicates shielding conductor for cables.   Ordered stripes.   Order	color code. Color code sistor (N	-channel).
Indicates a factory selected component.  OP Panel Control.  Indicates a plug-in connection.  Screwdriver arijustment.  Encloses front panel designation.  Encloses rear panel designation.  Ci. cuit assembly borderline.  Other assembly borderline.  Heavy line with arrows indicates path and direction of main signal.  Indicates path and direction of main feedback.  Earth ground symbol.  Assembly ground, May be accompanied by a number or letter to specify a particular ground.  Represents a number of transmission paths.  Test Point: Terminal provided for test probe.  Indicates a plug-in connection.  Indicates a plug-in connection.  Connection symbol indicating a male connection.  Connection symbol indicating a female connection.  Connection symbol indicating a female connection.  Pushbutton Swi on the female connection of main feedback.  Earth ground symbol.  Assembly ground, May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents a number of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  AND Gate  Buffler/Amplifier	indicates base color, second and third Effect	nductor Field ransistor.
ected component.  Panel Control.  Screwdriver ardjustment.  Encloses front panel designation.  Encloses rear panel designation.  C. cuit assembly border-line.  Other assembly border-line.  Heavy line with arrows indicates path and direction of main signal.  Indicates path and direction of main signal.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Papersents n number of transmission paths.  Congress on the second of the specified particular ground.  Chassis ground.  Papersents n number of transmission paths.  Consection of main signal.  Variable Resistor.  Fuse  Connection.  Connection symbol indicating a female connection.  Connection of main signal.  Variable Resistor.  Fuse  Connection of main signal.  Variable Resistor.  Fuse  Congent of transmission paths.  Connection of main feed-back.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Chassis ground.  Chassis ground.  Consection of main signal.  Connection symbol indicating a female connection.  Fuse  Connection symbol indicating a female connection.  Connection symbol indicating a female connection.  Fuse  Connection symbol indicating a female connection.  Conne	and a wall a turing a	
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designation.  Circuit assembly border- line.  Other assembly border- line.  Heavy line with arrows indicates path and direction of main signal.  Indicates path and direction of main feed- back.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  Circuit assembly border- line.  Connection symbol in- dicating a male con- nection.  Connection symbol in- dicating a female con- nection.  Connection symbol in- dicating a female con- nection.  Fuse  Fuse  Pushbutton Swi  Pushbutton Swi  Capper Switch.  Scr. (Silicon Controlled Rectifier).  Connection symbol in- dicating a male con- nection.  Toroid: Magneti inductor.  Operational Am  Fuse  Fuse  Fuse  Fuse  Connection symbol in- dicating a female con- nection.  Fuse  Fuse  Fuse  Fuse  Connection symbol in- dicating a female con- nection.  Fuse  Fuse  Fuse  Connection symbol in- dicating a female con- nection.  Fuse  Fuse  Fuse  Fuse  Fuse  Fuse  Fuse  Connection symbol in- dicating a female con- nection.  Fuse  F	machanical connection	or PNP
C. cuit assembly border- line.  Other assembly border- line.  Heavy line with arrows indicates path and direction of main feed- back.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  COnnection symbol indicating a female connection.  Resistor.  Operational Am  Variable Resistor.  Fuse  Pushbutton Swi  Breakdown Diode: Zener  Light-Emitting Diode.  SCR (Silicon Controlled Rectifier).  LOGIC SYMBOLOGY  AND Gate  Buffer/Amplifier	dicating a male con-	itic Canacitor
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Heavy line with arrows indicates path and direction of main signal.  Indicates path and direction of main feedback.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  Represents n NOR Gate  Resistor.  Fuse  Pushbutton Swi  Pushbutton Swi  Pushbutton Swi  Pushbutton Swi  Scr (Silicon Controlled Rectifier).  Description of transmission paths.  LOGIC SYMBOLOGY  Represents n More and the substitute of transmission paths.  Description of the substitute of	nection.	
Variable Resistor.  Variable Resistor.  Fuse    Indicates path and direction of main feedback.   General purpose diode.   Pushbutton Swide	Resistor. Operation	onal Amplifier.
ection of main feedback.  Earth ground symbol.  Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  COGIC SYMBOLOGY  Represents now Buffer/Amplifier  OR Gate  Pushbutton Switch.  Pushbutton Switch.  Seneral purpose diode.  Cogic Pushbutton Switch.  Pushbutton Switch.  Pushbutton Switch.  Seneral purpose diode.  Cogic Pushbutton Switch.	Variable Resistor. Fuse	
Assembly ground. May be accompanied by a number or letter to specify a particular ground.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  AND Gate  Breakdown Diode: Zener  Light-Emitting Diode.  SCR (Silicon Controlled Rectifier).  BUTHER POINT: Terminal Provided for test probe.  Buffer/Amplifier  Buffer/Amplifier	Conord round divide	ton Switch.
be accompanied by a number or letter to specify a particular ground.  Light-Emitting Diode.  Chassis ground.  SCR (Silicon Controlled Rectifier).  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  AND Gate  Buffer/Amplifier  Full with CR Cate	Toggle 9	witch.
Light-Emitting Diede.  Chassis ground.  Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  AND Gate  Description of transmission paths.  LOGIC SYMBOLOGY  Buffer/Amplifier	Breakdown Diode: Zener	
Represents n number of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  AND Gate  NOR Gate  Buffer/Amplifier	Light-Emitting Diode.	·
of transmission paths.  Test Point: Terminal provided for test probe.  LOGIC SYMBOLOGY  8 AND Gate Buffer/Amplifier  OR Gate Furthering OR Cotte		
LOGIC SYMBOLOGY  AND Gate  NOR Gate  Buffer/Amplifier  Telephone OR Code	•	•
AND Gate  NOR Gate  Buffer/Amplifier  To OR Gate		
OR Cate  Description OR Cate  Table 1	OGIC SYMBOLOGY	
OR Cate	NOR Gate Buffer/A	nplifier
A Secretary of the Control of the Co	Exclusive OR Gate Inverter	v.
NAND Gate	. Let	

Table 8-2. Schematic Diagram Notes (2 of 3)

	F	UNCTIO	N LABEL ABBREVIATIO	NS	
Σ	Adder	<b>\ \ \</b>	Open Collector	LED	Light-Emitting Diode
1>	Amplifier/Buffer	) , <u> </u>	Monostable Multivibrator	MUX	
	Schmitt Trigger	BCD			Multiplexer
 &	AND		Binary Coded Decimal	RAM	Random-Access Memory
		CTR	Counter	REG	Register
_ ≥1	OR	DAC	Digital-to-Analog Converter	ROM	Read Only Memory
=1	Exclusive OR	FF.	Flip-Flop	RPG	Rotary Pulse Generator
X→Y	Encoder, Decoder	1/0	Input/Output		
		İ			
					•
		·		,	
		LINE L	ABEL ABBREVIATIONS		
CK, C	Clock Input	Q	Output	WR	Write
D	Data or Delay Input (Flip-Flop)	ā	Not G (Complement of Q)	+1	Count Up
EN	Enable	R	Reset or Clear Input	-1	Count Down
EN G	Enable Gating Input	R RD			Count Down
			Reset or Clear Input	-1	
G	Gating Input	RD	Reset or Clear Input  Read  Set Input	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input Read	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input  Read  Set Input	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input  Read  Set Input	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input  Read  Set Input	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input  Read  Set Input	-1	Count Down
G LSB	Gating Input Least Significant Bit	RD S	Reset or Clear Input  Read  Set Input	-1	Count Down

Table 8-2. Schematic Diagram Notes (3 of 3)

# DIGITAL SYMBOLOGY REFERENCE INFORMATION **Input and Output Indicators** Implied Indicator—Absence of polarity indicator (see below) implies that the active state is a relative high voltage level. Absence of negation indicator (see below) implies that the active state is a relative high voltage level at the input or output. Polarity Indicator—The active state is a relatively low voltage level. Dynamic Indicator—The active state is a transition from a relative low to a relative high voltage level. Inhibit Input—Input that, when active, inhibits (blocks) the active state outputs of a digital device. Analog Input—Input that is a continuous signal function (e.g., a sine wave). Polarity Indicator used with Inhibit Indicator—Indicates that the relatively low level signal inhibits (blocks) the active state outputs of a digital device. m Output Delay-Binary output changes state only after the referenced input (m) returns to its inactive state (m should be replaced by appropriate dependency or function symbols). Open Collector or Open Emitter Output-Output that must form part of a distributed connection.

# SERVICE SHEET BD1 MODEL 8954A TRANSCEIVER INTERFACE TROUBLESHOOTING HELP

- Line Voltage and Fuse Selection . . . . . . . . . . Section II
- Operators Checks and Power On Sequence ..... Section III

## **PRINCIPLES OF OPERATION**

The Transceiver Interface is divided into four subsections; each represented by the following service sheets:

Service Sheet 1 HP-IB Interface/Microprocessor/Relay Control

Service Sheet 2 Relays and Relay Drivers

Service Sheet 3 Interface Keyboard and Annunciators

Service Sheet 4 Power Supply

The Transceiver Interface uses relays to establish the instrument's signal through-paths. These relays are switched into user defined configurations via the instrument's microprocessor and associated control circuitry. The microprocessor performs relay switching functions after it receives and interprets data from either a local or remote source.

In the Local mode, the microprocessor accepts data from the Transceiver Interface keyboard; located on the instrument's front panel. In the Remote mode, the microprocessor receives data from the HP-IB controller via the HP-IB Interface.

Figure 8-17 is a simplified, functional illustration of the Transceiver Interface circuitry. This diagram may be helpful in gaining an overview of the instrument's Block Diagram BD1.

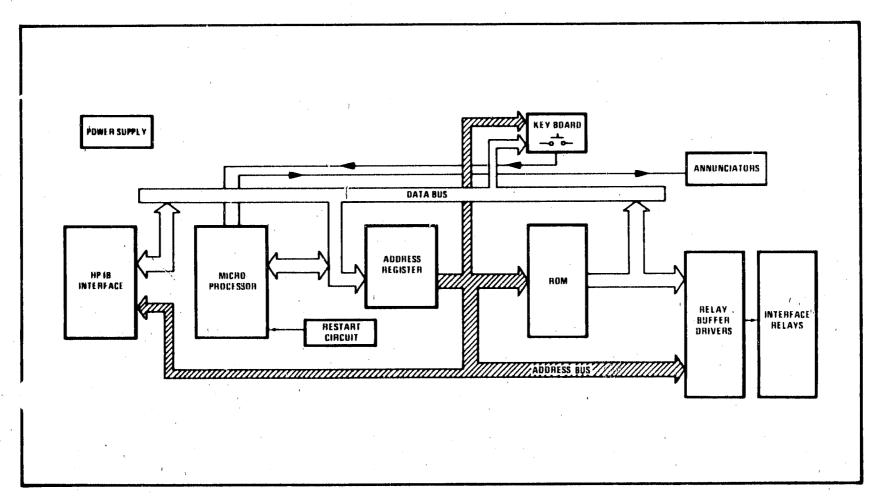
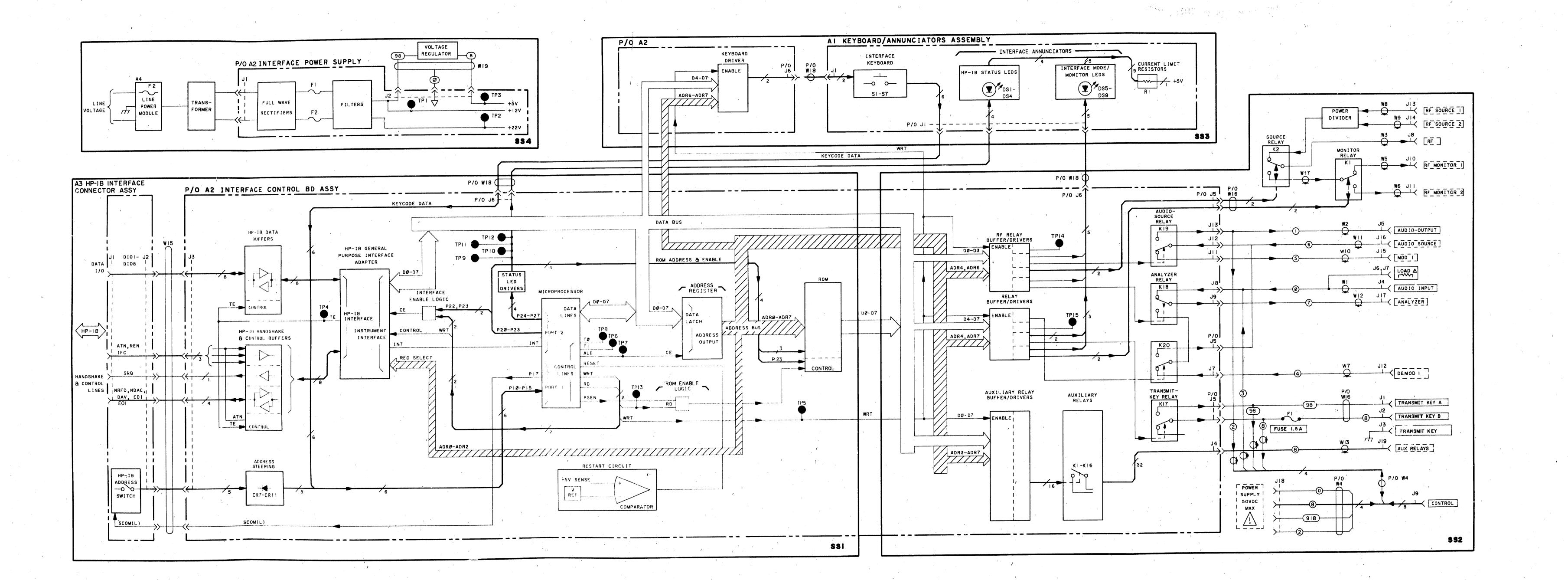


Figure 8-17. Simplified Block Diagram



8-19/8-20

# SERVICE SHEET 1 INTERFACE/MICHOPROCESSOR/RELAY CONTROL (P/0 A2) TROUBLESHOOTING HELP

Block Diagram
 Service Sheet BD1

# PRINCIPLES OF OPERATION

### Microprocessor

Microprocessor U11 serves as the internal controller for the Transceiver Interface. U11 implements its control over the instrument via the Address Register U12 and the Read Only Memory (ROM) U15.

The microprocessor, upon power-up, executes a monitor program (stored in its on-chip memory) for instrument-function initialization.

Local Mode. The monitor program configures the Transciever Interface in the Local operating mode by enabling the keyboard; this mode allows full, front-panel control of the instrument. Following the keyboard enable, the microprocessor scans Port 1 (P10-P15) for any data output on the Keycode Data lines. When a key is pressed, the microprocessor receives and internally interprets the keyed command and forms an address that is input to ROM U15. This address dictates the switch position of a specific relay within the Transceiver Interface. (The instrument will remain functioning in the Local mode unless it is interruped by a remote source; that is, an HP-IB instrument controller.)

Remote Mode. The HP-IB instrument controller sends a remote-mode command that is received by the instrument's HP-IB General Purpose Interface Adapter (GPIA) U7. The GPIA, upon receipt of this remote mode command, interrupts the microprocessor, causing it to disable the keyboard and only receive ASCII (American Standard for Information Interchange) encoded data from the GPIA. This ASCII encoded data from the GPIA is interpreted by the microprocessor to perform either HP-IB protocol functions or activation of the instrument's relay switches.

#### NOTE

The Transceiver Interface's LOCAL key is the only key not disabled in Remote operation, unless a "Local Lockout" command has been sent by the instrument controller.

The Transceiver Interface's Remote-mode status is indicated by the HP-IB status LEDs on the front panel.

Microprocessor Reset. The microprocessor is initialized, upon power-up, by a momentary low at its Reset input, U11 pin 4. This momentary low is caused by the charging of C8 through a resistor (internal to the microprocessor at pin 4). The Reset input is disabled when C8 is sufficiently charged.

# **Microprocessor Restart Circuit**

The Restart Circuit re-initializes the microprocessor in the event of a power supply glitch. VR1 serves as a voltage reference for the comparator U16. When the comparator senses a power supply interruption at the node of its non-inverting input, its output grounds the U11 Reset pin, Pin 4. The Reset input is held low preventing C8 from charging until the supply voltage reaches the level necessary for correct instrument operation.

## **Address Register**

The Address Register U12 is a D-type flip-flop which functions as a data latch. The address data written to the Register is latched at the address inputs of the ROM U15. This address data represents the eight, least-significant bits of the ROM's 11-bit address.

## Read Only Memory (ROM)

The ROM U15 is the device that contains the data necessary for relay switch positioning. The ROM receives address information through 11 address inputs (ADR0-ADR10): The eight, least-significant, address bits (ADR0-ADR7) are received from the Address Register. The three, most-significant, address bits are received from the microprocessor's Port 2 (P20-P23). The ROM, upon receipt of an address and enable pulse, outputs data on the data bus for relay-switch control.

## Hewlett-Packard Interface Bus (HP-IB) Address

The HP-IB address is established by the HP-IB Address Switch S1 on the rear panel. S1 places its set address on the I/O lines (Port 1) of the microprocessor by momentarily enabling the switch-common line SCOM (P17, low enable). The microprocessor reads these I/O lines and stores the address in the address register of the HP-IB General Purpose Interface Adapter U7 at power-up. The Transceiver Interface can then respond to its address when the controller places it on the HP-IB Data I/O lines.

To change the address, the switch must be changed to the new address and then the LINE OFF/ON switch must be cycled OFF, then ON.

#### **HP-IB Handshake and Control Buffer**

The Handshake and Control Buffer U2 transfers control and handshake information between the HP-IB controller and the Transceiver Interface's GPIA U7. The Talk Enable (TE) line determines the direction of data transfer. The Talk Enable line allows the instrument to be a receiver (listener) when TE is low. When TE is high, the instrument may serve as a transmitter (talker). The Attention (ATN) line, when true, allows the GPIA to be polled by the controller. When false, the Transceiver Interface is allowed to signify to the controller the end of a multi-byte information string.

#### **HP-IB Data Bus Buffer**

The Data Bus Buffer U1, allows bidirectional data transfer via the data lines DIO1-DIO8 between the HP-IB controller and the Transceiver Interface's GPIA U7. The Talk Enable (TE) line determines the direction of data flow. When the instrument is a listener (receiver), TE is low. With TE low, the receive buffer's outputs are enabled out of three-state. The receive buffers, with the exception of their Schmitt Trigger inputs, do not change the incoming data.

#### **HP-IB General Purpose Interface Adapter**

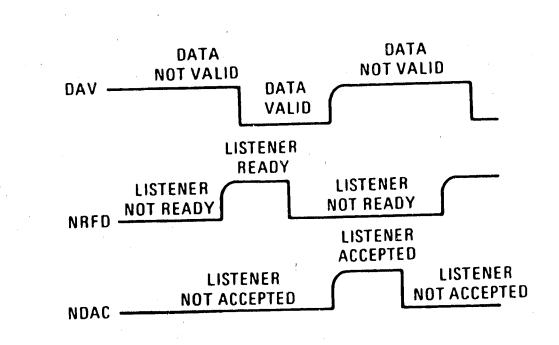
The General Purpose Interface Adapter (GPIA) U7, interfaces the microprocessor in the Transceiver Interface with the controller via the Hewlett-Packard Interface Bus.

The Transceiver Interface GPIA U7, becomes active when the instrument is turned on. At power-up, the GPIA's initialization is insured by the RC network at its Reset pin, pin 19. The GPIA also receives its clock, derived from the microprocessor system clock at this time.

The Transceiver Interface Remote operation is initiated by the HF-IB controller. When the controller addresses the instrument, the GPIA sends an interrupt to the microprocessor. The microprocessor interrupt-service routine enables the GPIA Register Select lines ADR0-ADR2 by way of the Interface interrupt-service (U14 A, B, and D and U13 B). The ability to select the GPIA registers allows the microprocessor to talk and listen to the HP-IB controller via the Data Bus.

The GPIA has five "control" lines: REN (L), IFC (L), ATN (L), EOI (L), and SRQ (L). These lines provide the Transceiver Interface with the ability to properly handle HP-IB protocol.

The GPIA has three "handshake" lines: NDAC (L), NRFD (L), and DAV (L). The handshake lines allow the Transceiver Interface to transfer data in an asynchronous, bidirectional mode with the HP-IB controller. The handshake occurs when the listener first indicates when it is ready to listen (receive data). The talker responds by indicating when the data that appears on the data lines (DIO1-DIO8) is valid. The listener then informs the talker when the data has been accepted, thus completing a data transfer. See Figure 8-19 for the handshake-timing diagram.



Start with the talker waiting for the listener to release NRFD (not ready for data) indicating it is ready.

When the listener is ready, NRFD goes high (false). The talker then places valid data on DIO1 through DIO8 and sets DAV (data valid) low (true).

NRFD then goes low (true) and the talker waits for the listener to indicate it has accepted the data (or ignored it) by releasing the NDAC (not data accepted) to a high (false, i.e., data is accepted).

The talker sets DAV high (false) and again waits for the listener to release NRFD.

(NOTE that if ATN is true, all instruments on the bus must handshake regardless of whether they are talkers, listeners, or bystanders. Being in remote or local has noting to do with handshaking. if ATN is false, they only handshake if addressed.)

Figure 8-19. Simplified HP-IB Handshake Between a Talker (Computer Controller) and One Listener (Transceiver Interface)

#### **TROUBLESHOOTING**

# Diagnostic Program (Using an HP-IB Controller)

OM (Output Memory) Command. This command is a useful service diagnostic which verifies the integrity of the HP-IB Interface and Control Circuitry; namely the Microprocessor (U11), Address Register (U12), and ROM (U15) as well as associated circuitry. This is accomplished by summing each byte contained in ROM U15, then adding 255 to this sum. The resultant value, which indicates correct circuit operation, is equal to zero. Since this command is executed by an HP-IB controller, internal access to the Transceiver Interface for the performance of this test is unnecessary.

The following programs depict typical usage of the "OM" command using the HP 9825, HP 85F, and HP 9845 Desktop Computers.

## HP 9825 (hpl)

# 0: wrt 703,"0M" 1: 255+J 2: for I=1 to 2048;J+rdb(703) " +J;dsp I,J;next I

#### 3: dsp Jmod256, I-1 \*4007

# HP 85F/ 9845 (BASIC)

10	OUTP	UT	703;
" MO"			
20	J=25	5	
30	FOR	]:=1	TO
2048			
40	J == J +	REA	DBIN
(703)			
50	PRIN	TI	, J.
60	NEXT	· ][	
70	PRIN	T L	INC2
0);J	MOD 2	!56;	<u>, II</u> 1
80	END	·	

The correct display output is:

0.00

2048.00

The first number is the check sum, while the second is the last memory location read.

Should this confidence test fail, it will be necessary to troubleshoot the instrument using signature analysis.

#### Signature Analysis

Digital troubleshooting of the Transceiver Interface circuitry is accomplished by the use of signature analysis. The instrument's signature analysis test program is stored in the on-chip ROM of the microprocesor U11.

The HP 5005A Signature Multimeter is a node-level troubleshooting tool. The Transceiver Interface has specified logic nodes with unique signatures; specific nodes and signatures listed in Tables 8-3 through 8-14. Refer to paragraph 8-21 for more information regarding digital signature analysis.

The Transceiver Interface has single nodes with multiple integrated circuits (IC's) connected to them. This configuration is a characteristic of bus structured instruments and can complicate troubleshooting since any one of the IC's that are connected to that node can cause a bad signature. The signature multimeter will not locate defective components or circuit traces; however, it will isolate the problem to a specific node.

The HP 546A Logic Pulser and the HP 547A Current Tracer can then be used to isolate the problem to an IC or to a specific point on a circuit trace. (References to block diagram BD1 and schematics SS1-SS4 are necessary to follow bus lines throughout the instrument.) Information on the use of the 546A and the 547A is in Application Note 163-2, which is available from any Hewlett-Packard sales or service office.

Grounding of A2TP6 turns on the test program. For each test program, a characteristic +5 VDC signature is given. With the exception of the Control Circuit Test, a correct +5 VDC signature does not indicate that a test has completely passed. It merely indicates that the test program is cycling properly and that the signature analyzer pod has been connected correctly. Many IC failures cause a node to be stuck either high (+5 VDC signature) or low (0 VDC signature).

Refer to Section I, "Service Accessories" for accessories listed as troubleshooting aids for the HP-IB Interface.

# TROUBLESHOOTING USING SIGNATURE ANALYSIS

#### NOTE

The HP 5005A Signature Multimeter is recommended for troubleshooting the Transceiver Interface. If the HP 5004A Signature Multimeter is used, note the following signature changes.

Table 8-3	Signature	Changes	for	the	HP	5004A	Signature	Multimeter
I WOLE O'O.	DIETIULUIC	Chullingeo	101			000111	~ 55,10000.0	112 0000011100001

TEST	NO	DE	SIGNATURE
Test 3. Address Test	U11#12	D0	4AF6
Table 8-6	U11#13	D1	INVALID
	U11#14	D2	PPCU
·	U11#15	D3	85F6
	U11#16	D4	C06F
•	U11#17	D5	INVALID
	U11#18	D6	C24P
,	U11#19	D7	OP7C
Test 4. Interface Test			
Table 8-9	U14#13	Write (I)	нн9А
Table 8-10	U2#9	SRQ(L)	INVALID (A2TP4 (TE) Grounded)

#### Test 1. Control-Circuit Test.

**Purpose.** Verify the correct operation of the Control Circuit; namely the Microprocessor, Address Register, and ROM circuitry.

#### **NOTE**

This test should be performed when any repairs to the Control Circuit have been made; insuring that the suspected malfunction has been corrected.

Setup. Connect the signature multimeter TIMING POD as follows:

1)	START	to	A2TP12 - LISTEN.
2)	STOP	to	A2TP12 - LISTEN.
3)	CLOCK	to	A2TP7 - SA CLOCK.
4)	GROUND	to	A2 Ground.

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Trailing Edge.

#### NOTE

The ground connection on the pod of the signature analyzer should be as close as possible to the circuitry being checked. (Poor grounding can cause unstable signatures.)

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Cycle the LINE OFF/ON switch OFF and then ON.

Tuble 8-4. Control Circuit Signatures

NODE	SIGNATURES
U15#21 +5VDC	2C15
U15#24 +5VDC	2C15

If the Control Circuit signatures are incorrect, continue with the following steps (1-6):

- 1. Check power supply voltages and re-check signature multimeter connections.
- 2. Check the microprocessor system clock, (U11 pins 2 and 3) for a 3 MHz signal (distorted sine wave) with an oscilloscope.
- 3. Use the signature multimeter Data Probe as a logic probe to test TP7 and TP12 for logic activity. No activity on these test points may indicate a defective microprocessor.
- 4. Check that the microprocessor's Reset line RESET (L), pin 4 is high.
- 5. Check that the microprocessor's Interrupt line INT (L), pin 6 is high.
- 6. If the Transceiver Interface still does not pass the Control Circuit Test, perform the following tests in order to isolate the defective node(s) within the Control Circuit:
  - Test 2. Data Bus Test (SS1).
  - Test 3. Address Bus Test (SS1).
- 7. If the Control Circuit Test passes (correct signatures) and the instrument is still inoperable, perform the following tests to help isolate the defective node(s) not within the Control Circuit:

- Test 4. Interface Test (SS1).
- Test 5. Relay Driver Test (SS2).
- Test 6. Keyboard Test (SS3).

#### **Test 2. Data Bus Test**

Purpose. Isolate and identify defective Data Bus line(s) as well as any devices which may be associated with the malfunction of the Data Bus.

The Data Bus signatures used in this test are generated solely by the microprocessor. Any Address Register and ROM logic activity on the Data Bus is transparent to the signature multimeter because of the strategic placement and length of the gate (measurement window) used to produce the signatures in this test.

Setup. Connect the signature multimeter TIMING POD as follows:

1) START A2TP11 - TALK.to' 2) **STOP** A2TP11 - TALK.to 3) **CLOCK** to A2TP5 - WRITE (L). 4) **GROUND** A2 Ground. to

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Leading Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Cycle the LINE OFF/ON switch OFF and then ON.

Table 8-5. Data Bus Signatures

NO	DE	SIGNATURES
U15#21	+5VDC	НН9А
U15#24	+5VDC	НН9А
U15#9	D7	96PF
U15#10	D6	725C
U15#11	D5	P5PH
U15#13	D4	5CP0
U15#14	D3	7P25
U15#15	D2	85PA
U15#16	D1	77F7
U15#17	D0	6PCP

If any of the Data Bus signatures are incorrect (e.g., HH9A or 0000), use the logic pulser and current tracer to determine which component is "hung up" on the Data Bus. However, if by using the pulser/tracer combination, the Data Bus does not appear defective, then replace the Microprocessor A2U11.

#### **Test 3. Address Test**

**Purpose.** Isolate and identify defective Address Bus line(s) as well as components that may be associated with the malfunction of the Address Bus.

Set up the signature multimeter TIMING POD connections as follows:

1)	START	to	A2TP12 - LISTEN.
2)	STOP	to	A2TP12 - LISTEN.
3)	CLOCK	to	A2TP13 - READ (L).
4)	GROUND	to	A2 Ground.

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Trailing Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Cycle the LINE OFF/ON switch OFF and then ON.

Table 8-6. Address Signatures

NOD	E	SIGNATURE
U15#21	+5VDC	0P7C
J15#24	+5VDC	0P7C
J15#1	A7	PPC2
J15#2	A6	C24P
U15#3	A5	22HF
J15#4	A4	C06F
U15#5	A3	85F6
U15#6	A2	PPCU
U15#7	A1	4176
U15#8	Α0	4AF6
J11#12-19	D0D7	0P7C

If any of the Address Signatures are incorrect (assuming the instrument passed the Data Bus Test, Test 2) troubleshoot the Address Bus in order to locate the failure. If the Address Signatures were correct, continue with the following signatures which test the most significant address bits and the enable lines for ROM U15.

Table 8-7. MSB Signatures

NODE		SIGNATURE	
U15#19	P22	5484	
U15#22	P21	UU <b>7</b> 7	
U15#23	P20	787U	
U15#18	P23	0001	
U15#20	PSEN*RD(L)	0P7C	

The signatures P20-P22 test the ROM's most-significant address bits. If any of the signatures (P20-P22) are incorrect, use the logic pulser and current tracer to troubleshoot these lines. However, if the pulser/tracer combination fails to locate a defective line or component and the signatures are still incorrect, then replace Microprocessor A2U11.

P23 and PSEN\*RD(L) are the ROM enable lines. If the PSEN\*RD(L) signature is incorrect, continue with the following signatures which test the ROM Enable logic.

Table 8-8. ROM Enable Signatures

NODE		SIGNATURE
U14#8	PSEN*RD	0000
U14#9	READ	0P7C
U14#10	PSEN	0P7C

#### Test 4. Interface Test

Interface Tests A, B, C, and D test the Transceiver Interfaces HP-IB capabilities only. The devices under test are: the General Purpose Interface Adapter and its associated enable logic, Data Bus Buffer, Handshake & Control Buffer, and the HP-IB Address Switch.

Before performing the Interface Test, verify the following:

- 1. That the Transceiver Interface passes the Control Circuit Test (Test 1).
- 2. That the GPIA Interrupt line, lNT (L) is high.
- 3. That the GPIA Reset line, RESET (L) is high.

# A. GPIA Enable Logic.

Purpose. Verify the correct operation of the GPIA Enable Logic.

Setup. Connect the signature multimeter TIMING POD as follows:

1)	START	to	A2TP11 – TALK.
2)	STOP	to	A2TP11 - TALK.
3)	CLOCK	to	A2TP5 - WRITE (L).
4)	CPOLIND	' to	A2 Ground

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Leading Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Cycle the LINE OFF/ON switch OFF and then ON.

NODE **SIGNATURES** HH9A U14#14 +5VDC CE(L) 13A6 U14#6 FP3F U14#5 HH9A U14#4 13A6 U14#3 **2HU0** U14#2 U14#1 **U2U6** READ(L) нн9а U14#12 U14#13 0000 WRITE(L)

Table 8-9. Control Circuit Signatures

# **B. HP-IB Transmit Test**

Purpose. Verify the correct operation of the HP-IB General Purpose Interface Adapter, HP-IB Handshake & Control buffers, Data Bus transmit buffers as well as associated circuit traces.

**Setup.** Connect the signature multimeter TIMING POD as follows:

1)	START	to	A2TP11 – TALK.
2)	STOP	to	A2TP11 – TALK.
3)	CLOCK	to	A2TP5 - WRITE (L).
4)	GROUND	to	A2 Ground.

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Leading Edge.

Set up the Transceiver Interface as follows:

- 1) Remove U7 from its socket (ensure that the Transceiver Interface line switch is in the OFF position).
- 2) Insert Test 1 jumper (HP part number 85650-60052) into U7 socket.
- 3) Jumper A2TP6 to A2 Ground.
- 4) Disconnect the HP-IB ribbon cable W15 from the A3J2 connector on the rear panel.
- 5) Turn the Transceiver Interface LINE OFF/ON switch to the ON position.

Test 1 jumper is used to connect the Data Bus lines D0-D7 to the DIO8-DIO1 lines (respectively). The jumper also connects five of the D0-D7 lines to the Handshake/Control transmit buffers: SRQ (L), EOI (L), DAV (L), NRFD (L), and NDAC (L).

A jumper cable for A2TP4 is necessary for the performance of this signature test.

ODE	SIGNATURE A2TP4 (TE) TIED HIGH	SIGNATURE A2TP4 (TE) GROUNDED	
+5VDC	HH9A	HH9A	
DIO1	96PF	HH9A	
DIO2	725C	НН9А	
DIO3	P5PH	нн9а	
DIO4	5CP0	нн9А	
DIO5	7P25	нн9а	
DIO6	85PA	НН9А	
DIO7	77F7	НН9А	
DIO8	6PCP	нн9А	
+5VDC	НН9А	НН9А	
NDAC(L)	НН9А	85PA	
NRFD(L)	НН9А	7 <b>P2</b> 5	
DAV(L)	5CPO	HH9A	
EOI(L)	P5PH	HH9A	
SRQ(L)	96PF	96PF	
	+5VDC  DIO1 DIO2 DIO3 DIO4 DIO5 DIO6 DIO7 DIO8  +5VDC  NDAC(L) NRFD(L) DAV(L) EOI(L)	### A2TP4 (TE) TIED HIGH  ##################################	

Table 8-10. HP-IB Signatures

Troubleshoot any lines that have incorrect signatures. If the devices and circuit traces under test do not appear defective, perform the HP-IB Receive Test.

#### C. HP-IB Receive Test

Purpose. Verify the correct operation of the HP-IB Data Bus and Handshake & Control receive buffers (U1 and U2), as well as associated circuit traces.

**Setup.** Connect the signature multimeter TIMING POD as follows:

A2TP11 - TALK.START 1) to A2TP11 - TALK.**STOP** 2) to **CLOCK** A2TP5 - WRITE (L).3) to A2 Ground. 4) GROUND to

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Leading Edge.

Set up Transceiver Interface as follows:

- 1) Remove U7 from its socket (ensure that the Transceiver Interface line switch is in the OFF position).
- 2) Insert Test 2 jumper (HP part number 08954-60005) into U7 socket.
- 3) Jumper A2TP6 to A2 GROUND.
- 4) Disconnect the HP-IB ribbon cable W15 from the A3J2 connector and attach it to the connector on the Test 2 jumper.
- 5) Turn the Transceiver Interface LINE OFF/ON switch to the ON position.

Test 2 jumper is used to connect the Data Bus lines D0-D7 (via ribbon cable W15) to the receiver side of the Data Bus Buffer U1, DIO1-DIO8 (respectively). The jumper also connects D0-D6 to the receive side of the U2 Handshake & Control Buffer lines: REN (L), IFC (L), NDAC (L), NRFD (L), DAV (L), EOI (L), and ATN (L) respectively.

A jumper cable for A2TP4 is necessary for the performance of this signature test.

If any of the HP-IB Receive Signatures are incorrect, verify that continuity exists (in ribbon cable W15) from each pin on the A3J2 side of the cable to the corresponding pin on the A2J3 connector. If continuity is verified and the signatures are still incorrect, replace the Handshake & Control Buffer U2.

Table 8-11. HP-IB Receive Signatures

NODE		SIGNATURE A2TP4 (TE) TIED HIGH +5 VDC A2TP4 (TE) TIED HIGH	SIGNATURE A2TP4 (TE) GROUNDED A2TP4 (TE) GROUNDED
U1#20	+5VDC	НН9А	нн9А
U1#12	DIO8	INVALID*	96PF
U1#13	DIO7	INVALID	725C
U1#14	DIO6	INVALID	P5PH
U1#15	DIO5	INVALID	5CPO
U1#16	DIO4	INVALID	7P25
U1#17	DIO3	INVALID	85PA
U1#18	DIO2	INVALID	77F7 ·
U1#19	DIO1	INVALID	6PCP
U2#20	+5VDC	нн9А	нн9А
U2#13	ATN (L)	725C	725C
U2#14	EOI (L)	P5PH	Р5РН
U2#15	DAV (L)	INVALID*	5CP0
U2#16	NRFD (L)	7P25	y INVALID*
U2#17	NDAC (L)	85PA	INVALID*
U2#18	IFC (L)	77 <b>F</b> 7	77F.7
U2#19	REN (L)	6PCP	6PCP

<sup>\*</sup>This invalid state is a result of U2 register's three-state output. Grounding the signature multimeter Data Probe will give a 0000 signature; this signature will not change when an invalid voltage level is measured. Also, the probe lamp will glow dimly, indicating an invalid logic level.

### D. HP-IB Address Switch Test.

Purpose. Verify the correct operation of the HP-IB Address Switch and its associated circuitry.

Setup. Connect the signature multimeter TIMING POD as follows:

1) START to A2TP11 - TALK.
2) STOP to A2TP11 - TALK.
3) CLOCK to A2TP5 - WRITE (L).
4) GROUND to A2 Ground.

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Leading Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Disconnect ribbon cable W18 from the A1 Keyboard Annunciator Assembly which removes the instrument's keyboard from the lines shared with the Address Switch.
- 3) Ensure that the HP-IB ribbon cable, W15 is connected from the A2 assembly to the A3 assembly.
- 4) Cycle the Transceiver Interface LINE OFF/ON switch OFF, then ON.

Table 8-12. Address Switch Signatures

NODE		SIGNATURE Address = 31*	SIGNATURE Address = 00*	
U11#40	+5VDC	нн9А	НН9А	
CR7 Anode	P14	3U12	48P5	
CR7 Cathode	S1-A5	НН9А	C75U	
CR8 Anode	P13	2HU0	AH1A	
CP8 Cathode	S1-A4	HH9A	C75U	
CR9 Anode	P12	U2U6	7FCP	
CR9 Cathode	S1-A3	НН9А	C75U	
CR10 Anode	P11	392H	8P46	
CR10 Cathode	S1-A2	НН9А	C75U	
CR11 Anode	P10	4C76	92FA	
CR11 Cathode	S1-A1	нн9а	C75U	

The column with Address = 31, lists signatures as they appear when the Address Switch contacts are open. The column with Address = 00, lists signatures as they appear when the Address Switch contacts are closed.

If the Transceiver Interface passes the Interface Test (A, B, C, and D) but fails to perform the "HP-IB Functional Checks" found in paragraph 3-12, replace the HP-IB General Purpose Interface Adapter U7.

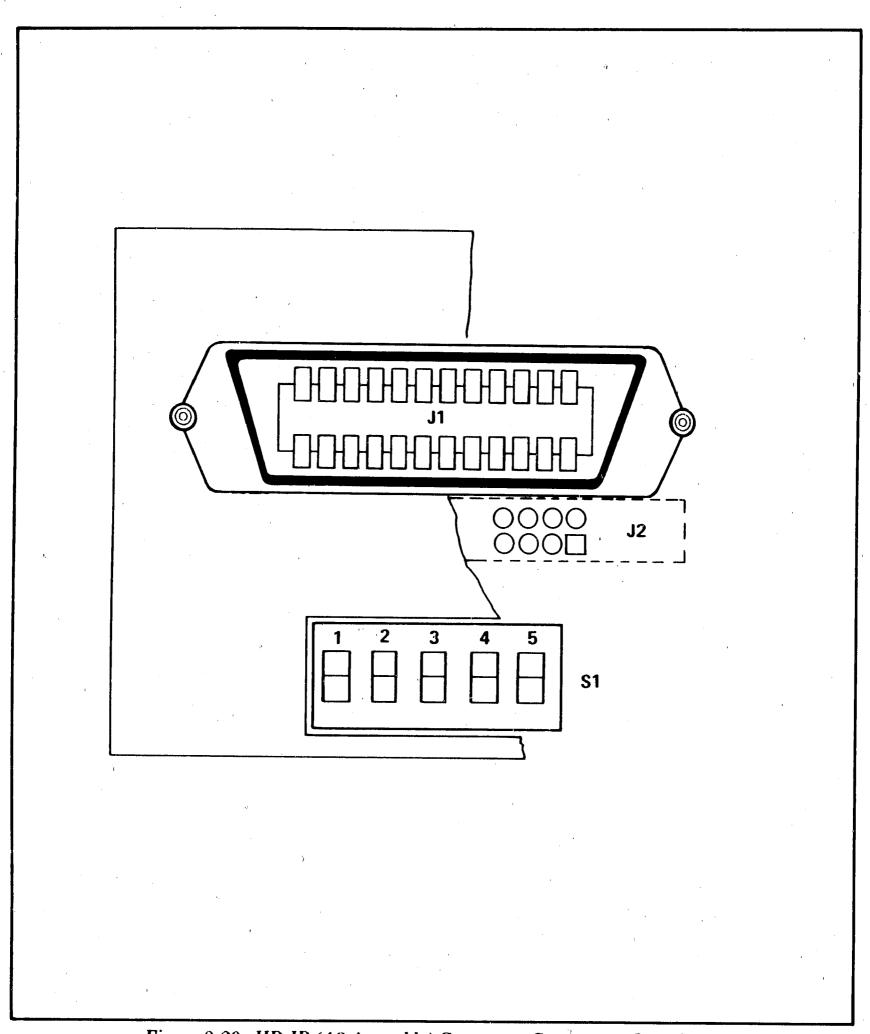


Figure 8-20. HP-IB (A3 Assembly) Connector Component Locations

Model 8954A

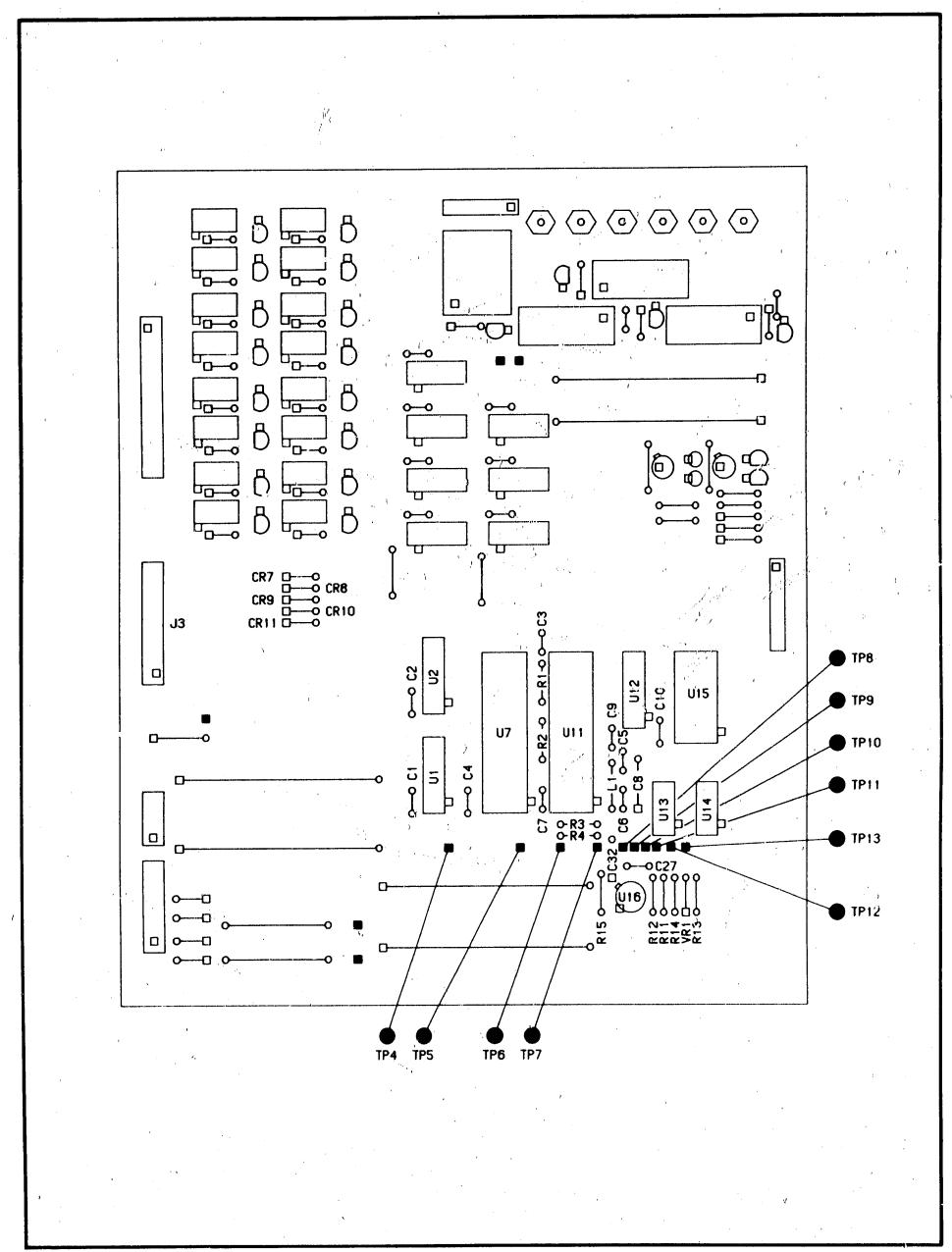
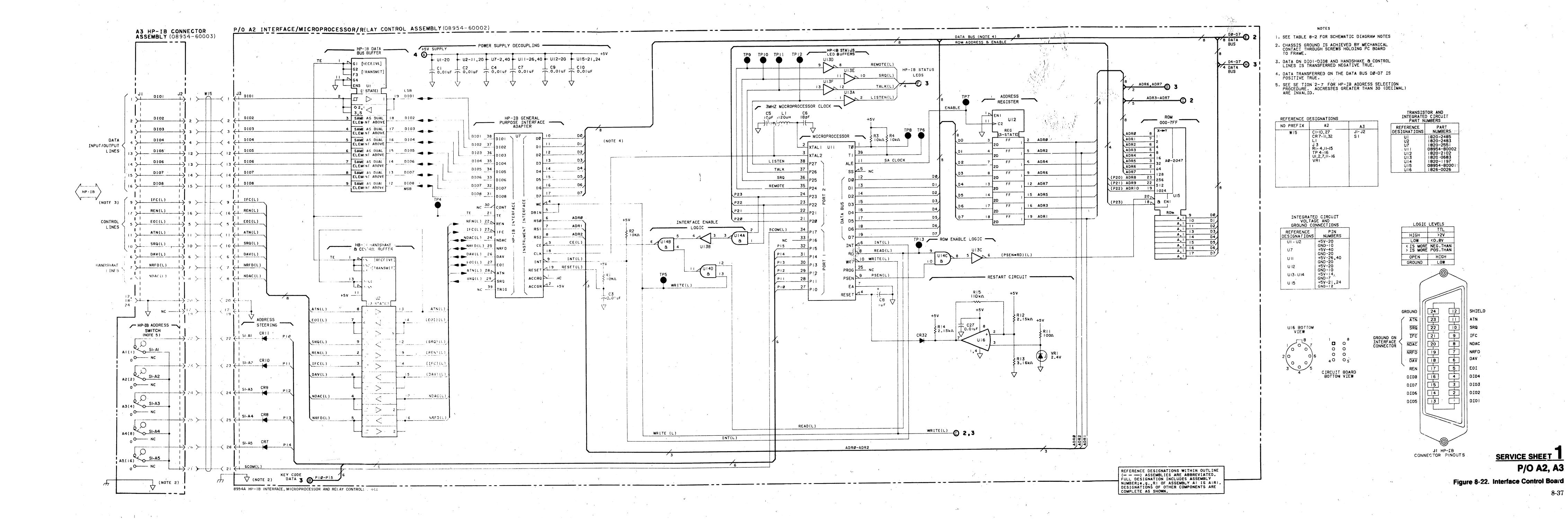


Figure 8-21. Interface Control Board (A2 Assembly) Component Locations



### SERVICE SHEET 2 P/O A2 INTERFACE/MICROPROCESSOR/RELAY CONTROL ASSEMBLY

• Block Diagram ..... Service Sheet BD1

## PRINCIPLES OF OPERATION

Relay Buffers. Relay Buffers U3-U6, U9 and U10 are CMOS, D-type, FF-registers. The registers (A through D), receive their input data from the microprocessor A2U11, via the Data Bus. The register inputs are enabled by the appropriate data sent on the Address Bus. The FF-register outputs respond to the data at the register inputs when the clock input receives the Write(L) clock pulse. The FF-register outputs are used to energize or de-energize the relay-driver transistors Q1-Q26. Refer to following NOTE.

MOSFETS. The transistors Q1-Q18, Q20-Q21, and Q23-Q26 are N-channel, enhancement mode MOSFETS. These transistors are used for the Transceiver Interface relay drivers for relays K1, K2, and A2K1-A2K20. A positive gate voltage (+5V) causes the transistor to turn on, permitting drain current to flow; grounding the gate, causes the transistor to turn off.

MOSFETs Q1-Q18 and Q25-26 are protected from reverse-voltage transients by diodes CR12-CR30 and CR33. Refer to following NOTE.

### NOTE

MOS and CMOS devices used in the Transcewer Interface are prone to damage when improperly handled. Further information regarding the treatment of these devices is found in paragraph 8-31 of this section, entitled "MOS and CMOS Integrated Circuit Replacement".

## RF Source and RF Monitor Relays and Drivers

Relays. The RF Source and RF Monitor relays (K1 and K2 respectively) are single-pole, double-throw, latching-type relays. The latching function of the relay is accomplished with permanent magnets. These magnets will hold the relay switch in the set position after current flow through the relay inductor has stopped. The direction of current flow necessary to switch the relay, from position 1 to position 2, is opposite the direction required to switch the relay from position 2 to position 1.

**Drivers.** A positive gate voltage (+5V), from the relay buffer, turns on FET Q23; FET Q24 turns off. This causes Q22 to turn on, charging C26. The K1 relay coil is in series with the C26 charge path, which causes the relay to switch from position 1 to position 2.

C26 will remain charged and K1 will remain latched in position 2, until FET Q23 is turned off by the relay buffer. With FET Q23 turned off, PNP transistor Q22 is off and FET Q24 is on; discharging C26 through the K1 relay coil. The direction of current flow, caused by the discharging of capacitor C26, switches the relay from position 2 to position 1.

### TROUBLESHOOTING USING SIGNATURE ANALYSIS

### **Test 5. Relay Driver Test**

Purpose. Verify the correct operation of the Transceiver Interface Relay Buffers, as well as associated circuit traces.

Setup. Connect the signature multimeter TIMING POD as follows:

1)	START	to	A2TP11 - TALK.
2)	STOP	to	A2TP11 - TALK.
3)	CLOCK	to	A2TP7 - SA CLOCK.
4)	GROUND	to	A2 Ground.

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Trailing Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 Ground.
- 2) Cycle the LINE OFF/ON switch OFF, then ON.

U5. U6. U10#4

U5, U6, U10#5

U5, U6, U10#6

The validity of this test is dependent upon the correct operation of the Control circuitry; more specifically, the Address Bus and Data Bus. (Refer to Test 1. Control Circuit Test.)

· No	SIGNATURE	
U3#16	+5 VDC	P882
A2TP5	WRITE (L)	P882
U3, U4, U9#3	FF (A)	76U8
U3, U4, U9#4	FF (B)	HU14
U3, U4, U9#5	FF (C)	C38U
U3, U4\ U9#6	FF (D)	10HP
U5, U6, U10#3	FF (A)	058C

FF (B)

FF (D)

U801

P985

2533

Table 8-13. Relay Driver Signatures

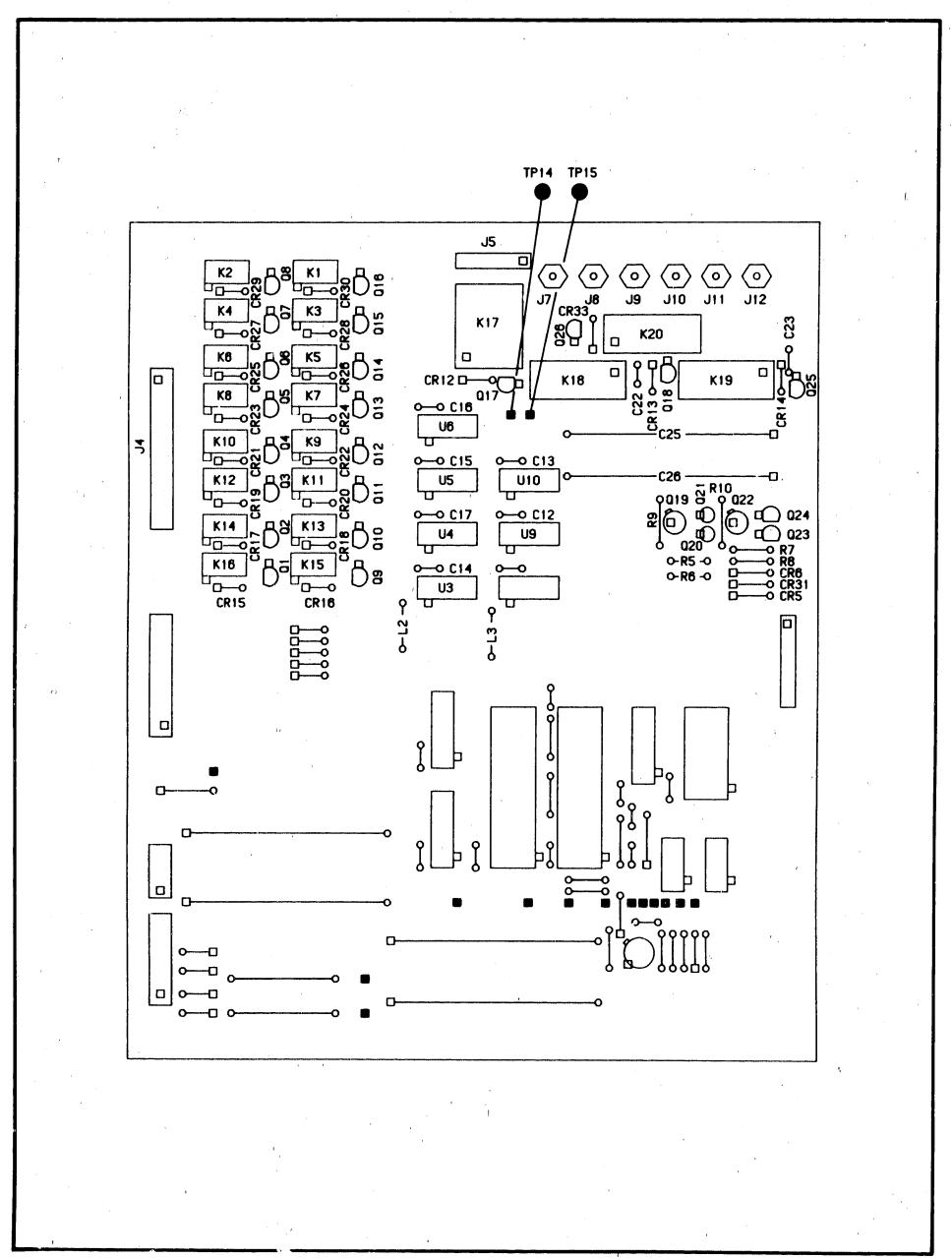
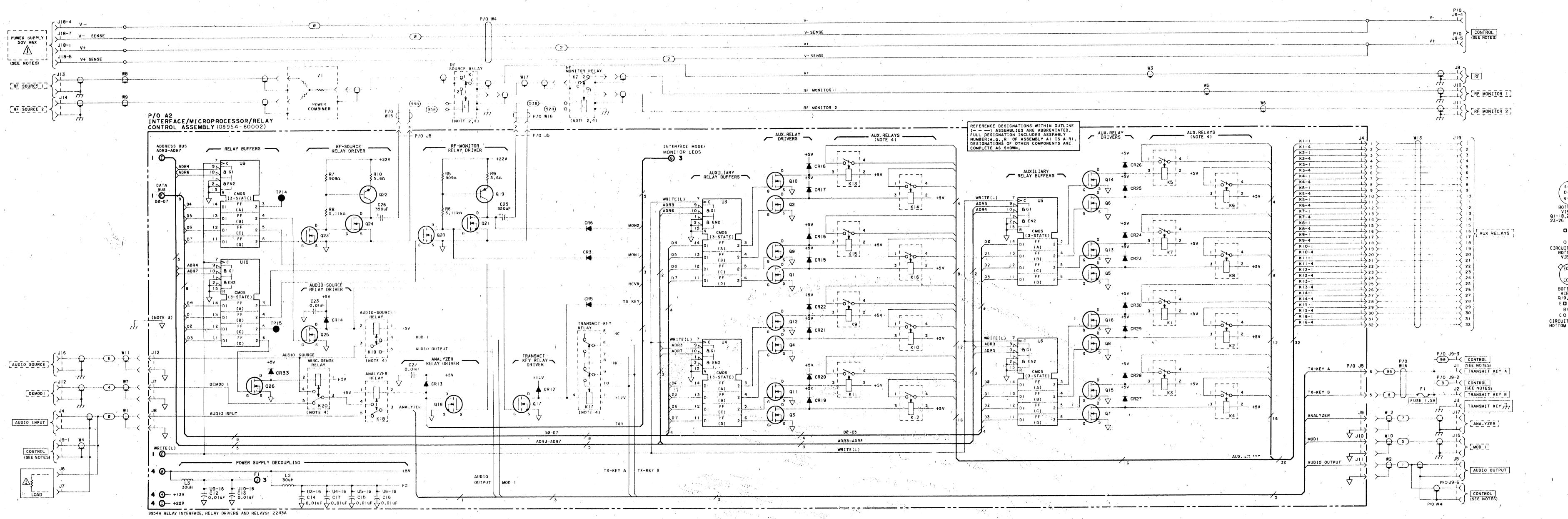


Figure 8-23. Interface Control Board (A2 Assembly) Component Locations



C12-17,22,23 25,26 CR5,6,12-31,33 J4,5,7-12 K 1-20 L 2 Q1-26 R5-10 TP 14-15 U3-6,9,10 Q1-Q18, Q20-Q21, JI- 19 KI,2 WI-13,16,17 Q23-Q26 Q19,Q22 U3-U6 U9,U10 O GATE
O DRAIN

SERVICE SHEET 2

P/O A2

Figure 8-24. Relay Control Driver and Relays

## SERVICE SHEET 3 A1 KEYBOARD AND INTERFACE ANNUNCIATOR ASSEMBLY

### PRINCIPLES OF OPERATION

**Keyboard.** The Transceiver Interface keyboard is comprised of seven momentary-pushbutton switches, S1-S7. The switches are driven by a D-type, FF register A2U8. The microprocessor A2U11, Port 1 (P10-P15) receives its inputs from the keyboard via the A2 Keycode Data lines.

The A2 microprocessor (after power-up initialization), enables the keyboard by placing a low on the outputs of U8, FF registers C and D. A key closure prompts the microprocessor to read the Keycode Data lines; once, after enabling register C (disabling D) and a second time, after enabling register D (disabling C). This routine allows the microprocessor to differentiate between a closure of either the TRANSMIT KEY ON or TRANSMIT KEY OFF key. This process is necessary because of the hard-wired OR configuration of those two transmit keys.

### **Interface Annunciators**

HP-IB Status LEDS. The HP-IB Status LEDs (DS1-DS4) are driven by buffers U13 (A, D, E, and F) on the A2 assembly. The buffers receive their status information from the microprocessor A2U11.

Interface Mode/Monitor LEDs. The Interface Mode/Monitor LEDs (DS5-DS9) are driven by the A2 audio- and RF-relay driver transistors (Q17, Q20, Q21, and Q25).

### TROUBLESHOOTING USING SIGNATURE ANALYSIS

### Test 6. Keyboard Test

Purpose. Verify the correct operation of the keyboard switches and keyboard circuitry.

Setup. Connect the signature multimeter TIMING POD as follows:

A2TP11 - TALK.START 1) to A2TP11 - TALK.2) STOP to A2TP7 - SA CLOCK. **CLOCK** 3) to A2 Ground. **GROUND** 4) to

Set the signature multimeter POLARITY controls as follows:

- 1) START Leading Edge.
- 2) STOP Trailing Edge.
- 3) CLOCK Trailing Edge.

Set up the Transceiver Interface as follows:

- 1) Jumper A2TP6 to A2 GROUND.
- 2) Disconnect all HP-IB cables from A3J1 on the rear panel; this removes the Address Switch from the Keycode Data lines.
- 3) Cycle the LINE OFF/ON switch OFF, then ON.

Table 8-14. Keycode Signatures

NODE		PORT SIGNATURE	KEY SIGNATURE (Specified key held in "on" position)		
U11#40	+5 VDC	P882	******		
U11#27	P10	4162	CAPA TRANSMIT KEY OFF key		
U11#27	P10	4162	0FP9 TRANSMIT KEY ON key		
U11#28	P11	<b>7P00</b>	A9PA TRANSMITTER key		
U11#29	P12	UA61	F470 RECEIVER key		
U11#30	P13	894F	71UF RF MONITOR 2 key		
U11#31	P14	9НСР	P104 RF MONITOR 1 key		
U11#32	P15	U7F5	396F LOCAL key		

The PORT SIGNATURE column, lists the signatures that relate to the microprocessor port (P10-P15) which verify the integrity of the Keycode Data lines. The KEY SIGNATURE column lists signatures which are a result of a depression of the specified key. Valid signatures on these lines indicate the correct operation of the A2U8 Keyboard Driver and Interface Keyboard keys.

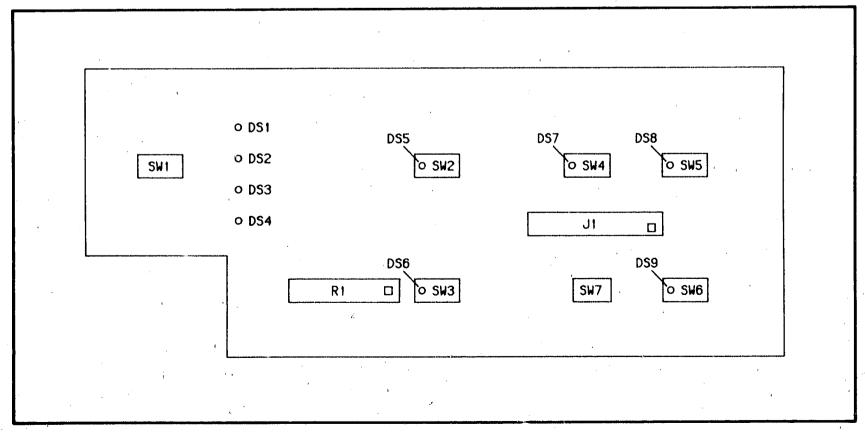


Figure 8-25. Keyboard and Annunciators (A1 Assembly) Component Locations

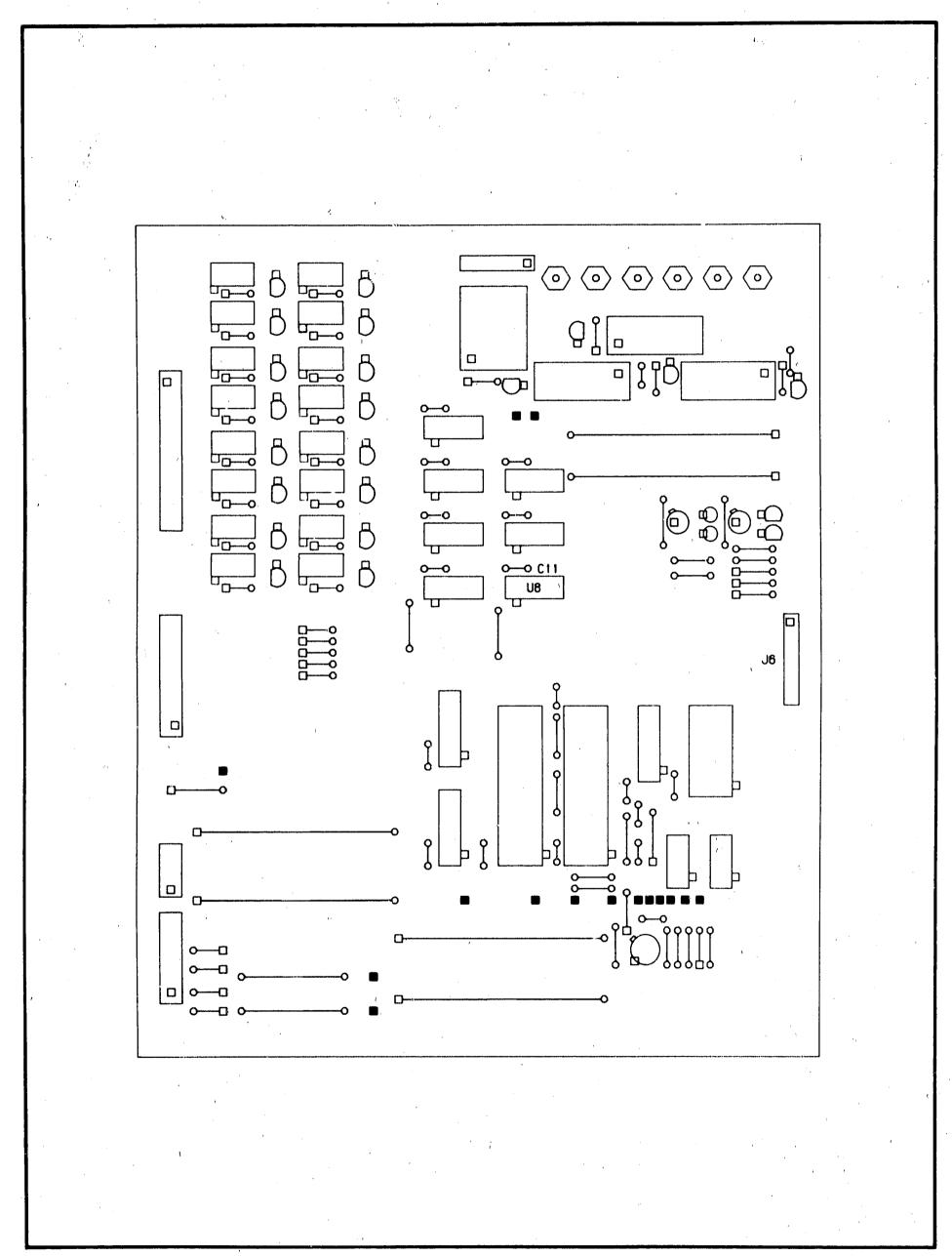
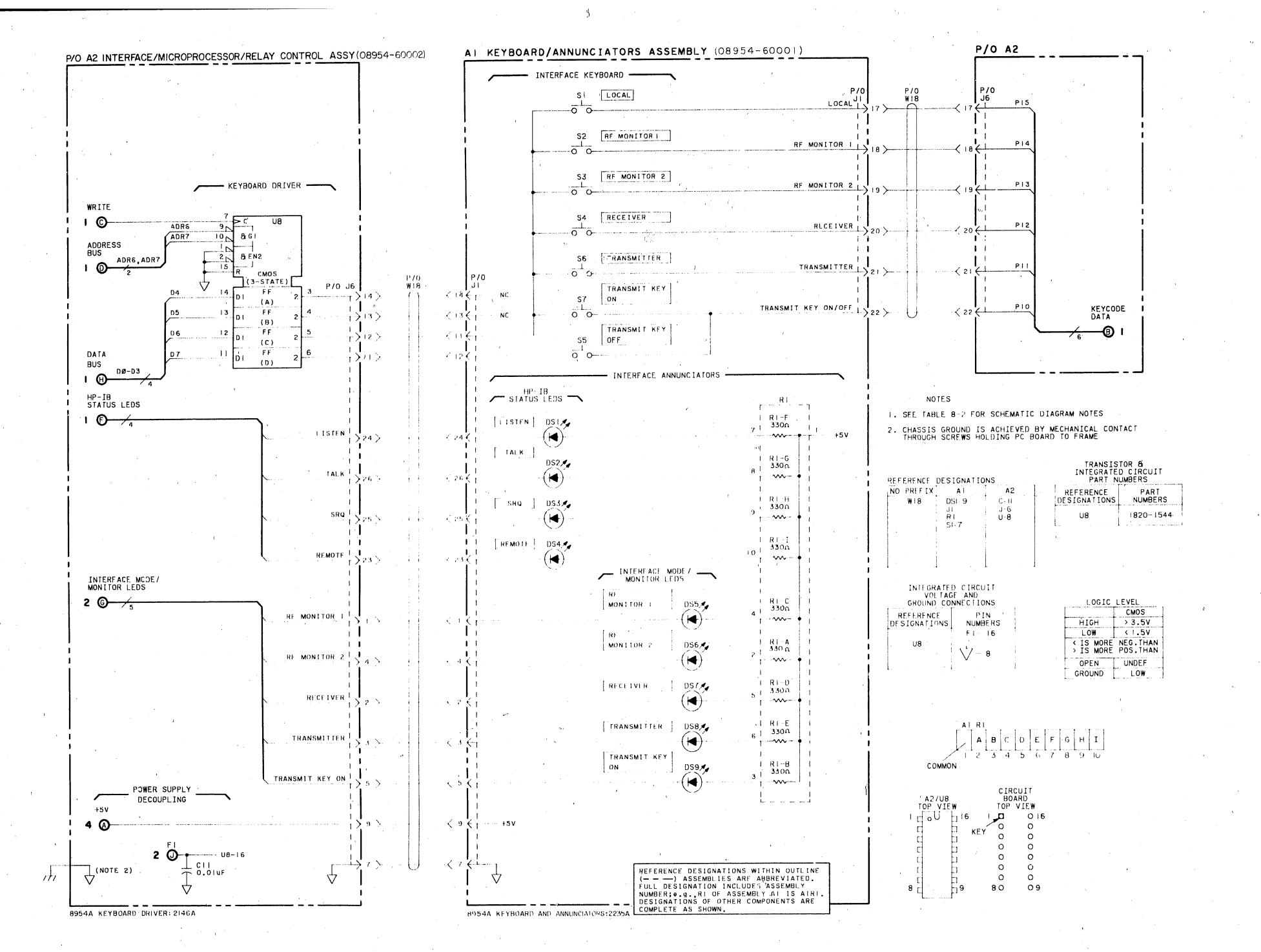


Figure 8-26. Interface Control Board (A2 Assembly) Component Locations



SERVICE SHEET 3
P/O A2, A1

Figure 8-27. Keyboard and Annunciator Assembly

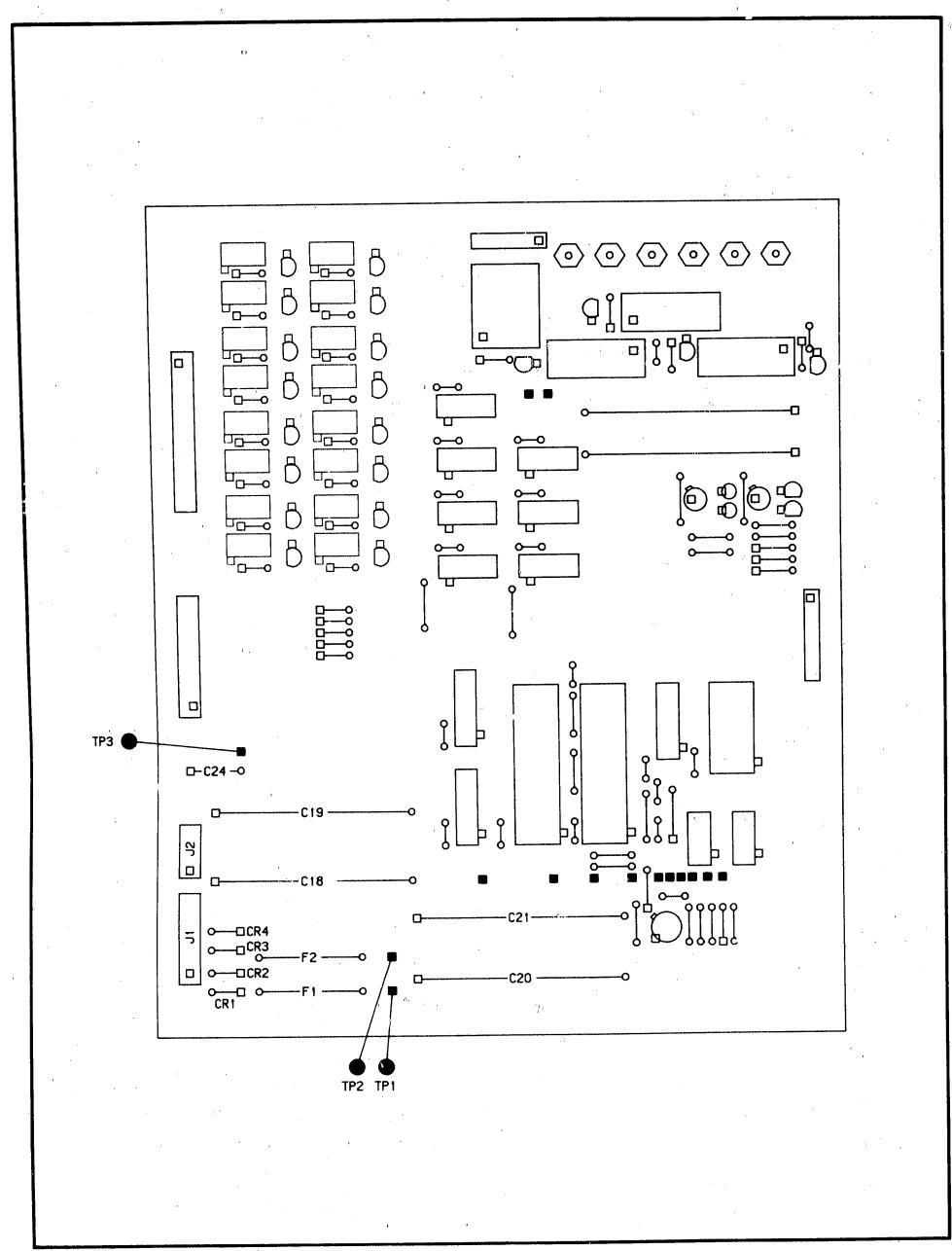
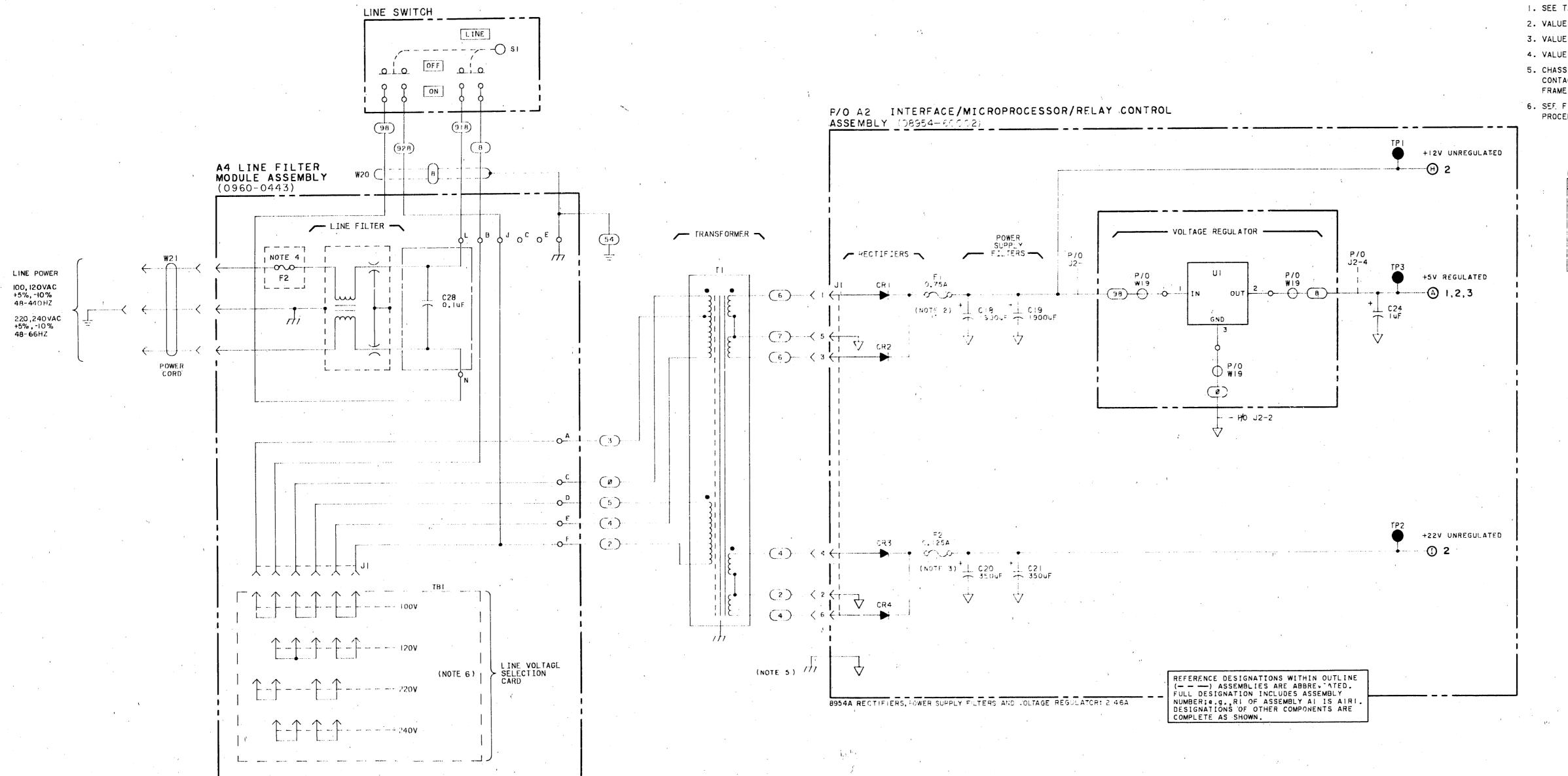


Figure 8-28. Interface Control Board (A2 Assembly) Component Locations



1. SEE TABLE 8-2 FOR SCHEMATIC DIAGRAM NOTES

3. VALUE OF A2F2 IS 0.125A (250V).

4. VALUE OF A4 FI IS 0.125A FOR 250V OPERATION & 0.250A FOR 120V.

5. CHASSIS GROUND IS ACHIEVED BY MECHANICAL CONTACT THROUGH SCREWS HOLDING PC BOARD TO

6. SEF FIG 2-1 FOR LINE VOLTAGE SELECTION PROCEDURE.

REFERENCE DESIGNATIONS

NO PREFIX A2

SI CIB-21, F
TI 24

UI CRI-4 P
WI9-2I F1,2

J1,2

TPI-3 , FI J I P I S I T I U i W19-21

TRANSISTOR &
INTEGRATED CIRCUIT
PART NUMBERS REFERENCE PART DESIGNATION NUMBER 1826-0181

> BOTTOM VIEW O/3 (CASE)

> > SERVICE SHEET 4 P/O A2, A4

Figure 8-29. Interface Power Supply 8-47/8-48

## 

# CHANGES

## TRANSCEIVER INTERFACE OPERATING AND SERVICE MANUAL

MANUAL IDENTIFICATION

Model Number: 8954A

Date Printed: Feb. 1983

Part Number: 08954-90010

This supplement contains important information for correcting manual errors and for adapting the manual to instruments containing improvements made after printing the manual.

To use this supplement, first, make all ERRATA corrections and then all appropriate serial number related changes indicated in the tables below.

SERIAL PREFIX OR NUMBER	MAKE MANUAL CHANGES
2429A	1
2516A	1-2
2525A	1-3
>> 2612A	1-4
·	
,	
,	

SERIAL PREFIX OR NUMBER	MAKE MANUAL CHANGES
	,
en e	
•	
·	
•	
)	

>> NEW ITEM

NOTE:

Manual change supplements are revised as often as necessary to keep manuals as current and accurate as possible. Hewlett-PackarJ recommends that you periodically request the latest edition of this supplement. Free copies are available from all HP offices. When requesting copies, quote the manual identification information from your supplement or the model number and print date from the title page of the manual.

Printed in U.S.A.



<sup>4</sup> Pages Text

<sup>4</sup> Pages Illustrations

### **ERRATA**

Page 2-1, paragraph 2-5:
After the "CAUTION" information insert the following text:

Two fuses are supplied with each instrument. One fuse has the proper rating for 110/120 Vac line operation; the other fuse is rated for 200/220 Vac operation.

One fuse is installed in the instrument at the time of shipment. The rating of the installed fuse is selected according to the line voltage specified by the customer. If the voltage is not specified, the rating of the installed fuse will be selected according to the country of destination.

>> Page 2-3, Figure 2-3:
Replace Figure 2-3 with the attached "Figure 2-3. Power Cable HP Part Numbers (P/O ERRATA)."

Page 3-7 and 3-8, Transmitter Mode Checks:
In steps 6, 8, and 11, replace "+5 dB" with "+/-5 dB."

Page 6-1, paragraph 6-1:

In paragraph 6-1 Introduction, second sentence, change "Table 6-1" to "Table 6-2."

Page 6-9, Table 6-3:
Under A4C1, add HP Part Number 0890-0052 CD9 TUBING-HS 1-D/.5-RCVD .035-WALL POLYO.

Page 8-24, TROUBLESHOOTING:
Under "Diagnostic Program (using an HP-IB Controller)" delete the "HP 85F/" from the title of the program listing on the right side of page and add the third listing, "HP 85B (BASIC) (P/O ERRATA)", attached in this supplement.

>> Page 8-41, Service Sheet 2 (NOTES):
On the pin configuration diagram labeled "A2/K18, K19 BOTTOM VIEW", change pin number 2 to 3 and pin number 3 to 2.

Page 8-47, Service Sheet 4 (schematic):
In the A4 LINE FILTER MODULE ASSEMBLY SCHEMATIC, change C28 to C1.
In the table of REFERENCE DESIGNATIONS, under A4, add C1.

### CHANGE 1 - Serial Prefix 2429A

Page 6-6, Table 6-3:
Change A2F1 to 2110-0360 CD2 FUSE .75A 250V TD 1.25X.25 UL.
Change A2F2 to 2110-0318 CD0 FUSE .125A 250V TD 1.25X.25 UL.

### CHANGE 2 - Serial Prefix 2516A

Page 6-6, Table 6-3:
Change A2K18-K20 to 0490-1423 CD6 RELAY-REED IC 250MA 28VDC 5VDC-COIL 3VA.

### CHANGE 3 - Serial Prefix 2525A

### NOTE

The following change information documents the conversion to metric cabinet hardware in the HP 8954A.

Page 1-3, paragraph 1-9:
Change the part numbers shown for the following options to:

Option 907	5061-9688
Option 908	5061-9674
Option 909	5061-9675

### Page 6-10, Table 6-3:

Change the following cabinet part numbers:

MP9	0515-1331	CD5	SCREW-MACH M4X0.7 6MM-LG
MP18	5021-5801	CDO	FRAME, FRONT, FULL
MP19	5021-5802	CD1	FRAME, REAR
MP20	5021-5831	CD6	SIDE STRUTS
MP23	5061-9434	CD7	TOP COVER
MP24	5061-9446	CD1	BOTTOM COVER
MP25	5061-9506	CD4	SIDE COVER

### >> CHANGE 4

Page 6-5, Table 6-3: Change A2 to 08954-60007 CD8 INTERFACE/MICROPROCESSOR/RELAY CONTROL.

Page 6-6, Table 6-3:
Add A2K21 0490-1423 CD2 RELAY-REED 1C 250MA 28VDC 5VDC-COIL 3VA.

Page 6-7, Table 6-3:
Add A2R16 0757-0438 CD3 RESISTOR 5.11K 1% .125W F TC=0+-100.
Change A2U16 to 1826-0412 CD1 IC COMPARATOR PRCN DUAL 8-DIP-P PKG 27014 LM393N.

Page 6-9, Table 6-3:
Under J4 and J5 add, 5040-0345 CD7 INSULATOR: CONNECTOR.
Under J12, 15, 16, and 17 add 00310-48801 CD0 INSULATOR: CONNECTOR.

Page 6-10, Table 6-3:
Change MP26 to 08954-00007 CD2.
Change MP28 to 08954-00008 CD3.
Change MP29 to 08954-00009 CD4.

Page 6-11, Table 6-3:

Change W7 to 08954-60116 CD0.

Change W10 to 08954-60117 CD1.

Change W11 to 08954-60118 CD2.

Change W12 to 08954-60119 CD3.

Page 8-36, Figure 8-21 (component locator):
Change reference designator R14 to R15, and change R15 to R14. Add R16 between U13 and C8.

Page 8-37, Service Sheet 1 (schematic):

Replace the appropriate portion of Figure 8-22 with the attached,

"P/O Figure 8-22. Interface Control Board (P/O CHANGE 4)."

Page 8-40, Figure 8-23 (component locator):

Replace the appropriate portion of Figure 8-23 with the attached "P/O Figure 8-23. Interface Control Board (A2 Assembly) Component Locations (P/O CHANGE 4)."

Page 8-41, Service Sheet 2:

Replace Figure 8-24 with the attached "Figure 8-24. Relay Control Driver and Relays (P/O CHANGE 4)."

Page 8-45, Service Sheet 3:

Replace the appropriate portion of Figure 8-27 with the attached "P/O Figure 8-27. Keyboard and Annunciator Assembly (P/O CHANGE 4)."

HP 85B (BASIC) (P/O ERRATA)

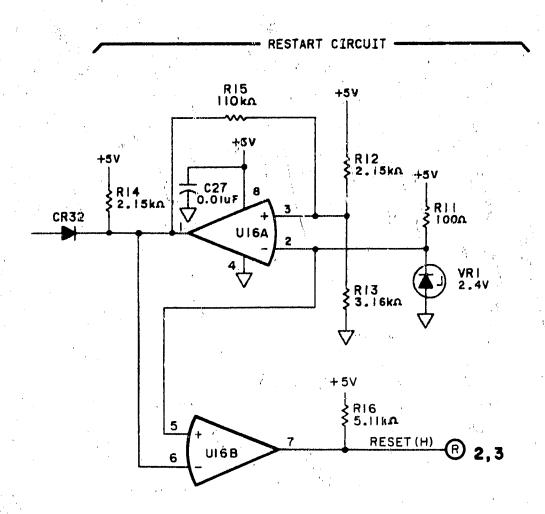
Plug Type	Cable HP Part Number	CD	Plug Description	Cable Length (inches)	Cable Color	For Use In Country
250V E []	8120-1351 8120-1703	0 4	Straight*BS1363A 90°	90 90	Mint Gray Mint Gray	United Kingdom, Cyprus, Nigeria, Rhodesia, Singapore
250V	8120-1369 8120-0606	0 4	Straight*NZSS198/ASC112 90°	79 <b>8</b> 7	Gray Gray	Austrailia, New Zealand
250V	8120-1689 8120-1692	7 2	Straight*CEE7-Y11 90°	79 79	Mint Gray Mint Gray	East and West Europe, Saudi Arabia, Egypt, (unpolarized in many nations)
125V	8120-1378 8120-1398 8120-1754 8120-1378 8120-1521 8120-1676	5 5 7 1 6 2	Straight*NEMA5-15P 90° Straight*NEMA5-15P Straight*NEMA5-15P 90° Straight*NEMA5-15P	80 80 36 80 80 36	Black Black Black Jade Gray Jade Gray Jade Gray	United States, Canada, Mexico, Japan (100V or 200V), Philippines, Taiwan
250 V	8120-2104	3	Straight*SEV1011 1959-24507 Type 12	79	Gray	Switzerland
250V	8120-0698	6	Straight*NEMA6-15P	·		United States, Canada
220V	8120-1957 8120-2956	2 3	Straight*DHCK107 90°	79 79	Gray Gray	Denmark
250V	8120-421,1	7	Straight*IEC83-B1	79	Black	South Africa, India
250V	8120-1860	6	Straight*CEE22-VI (Systems Cabinet Use)			

<sup>\*</sup>Part number shown for plug is industry identifier for plug only. Number shown for cable is HP Part Number for complete cable including plug.

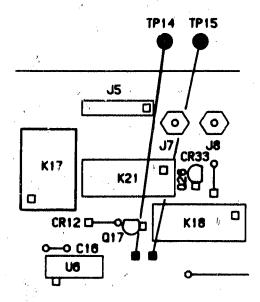
E = Earth Ground; L = Line; N = Neutral

Figure 2-3. Power Cable HP Part Numbers (P/O ERRATA).

Model 8954A 08954-90010

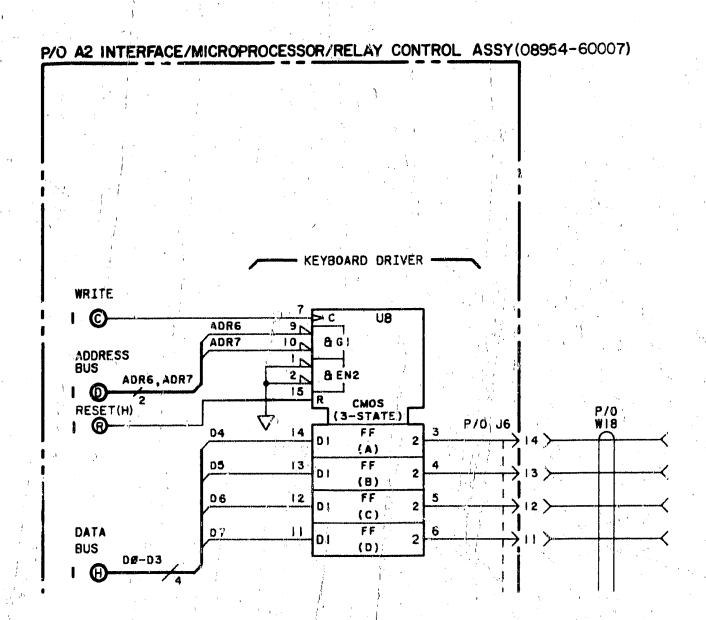


P/O Figure 8-22. Interface Control Board (P/O CHANGE 4).



P/O Figure 8-23. Interface Control Board (A2 Assembly) Component Locations (P/O CHANGE 4).

Model 8954A 28954-90010



P/O Figure 8-27. Keyboard and Annunciator Assembly (P/C CHANGE 4).

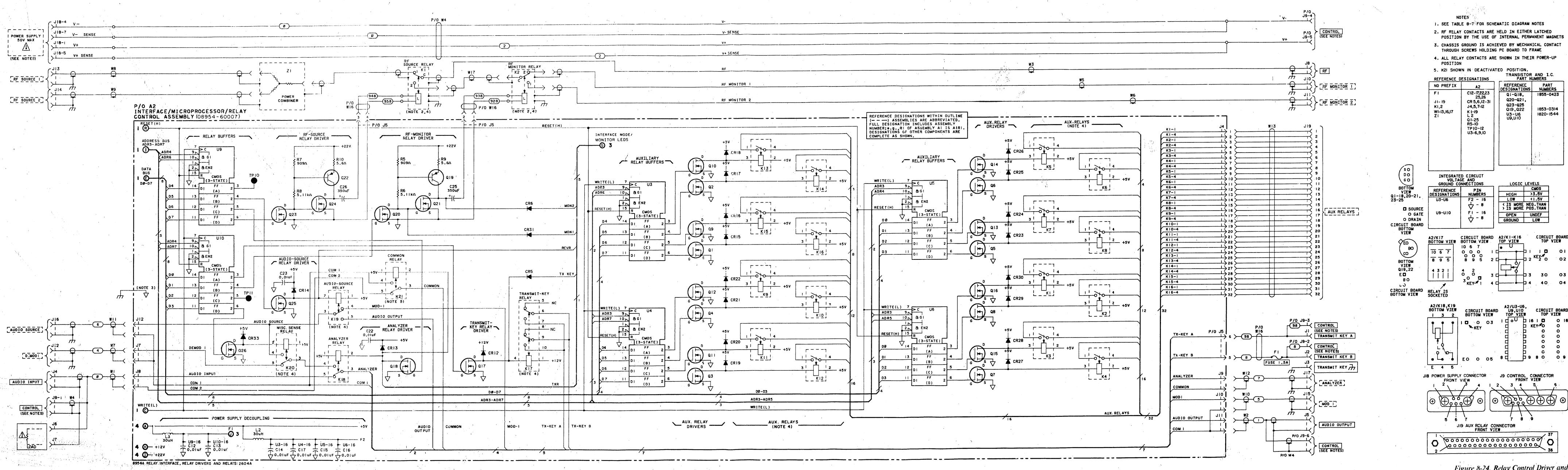


Figure 8-24. Relay Control Driver and Relays (P/O CHANGE 4).

1820-1544

P/O A2